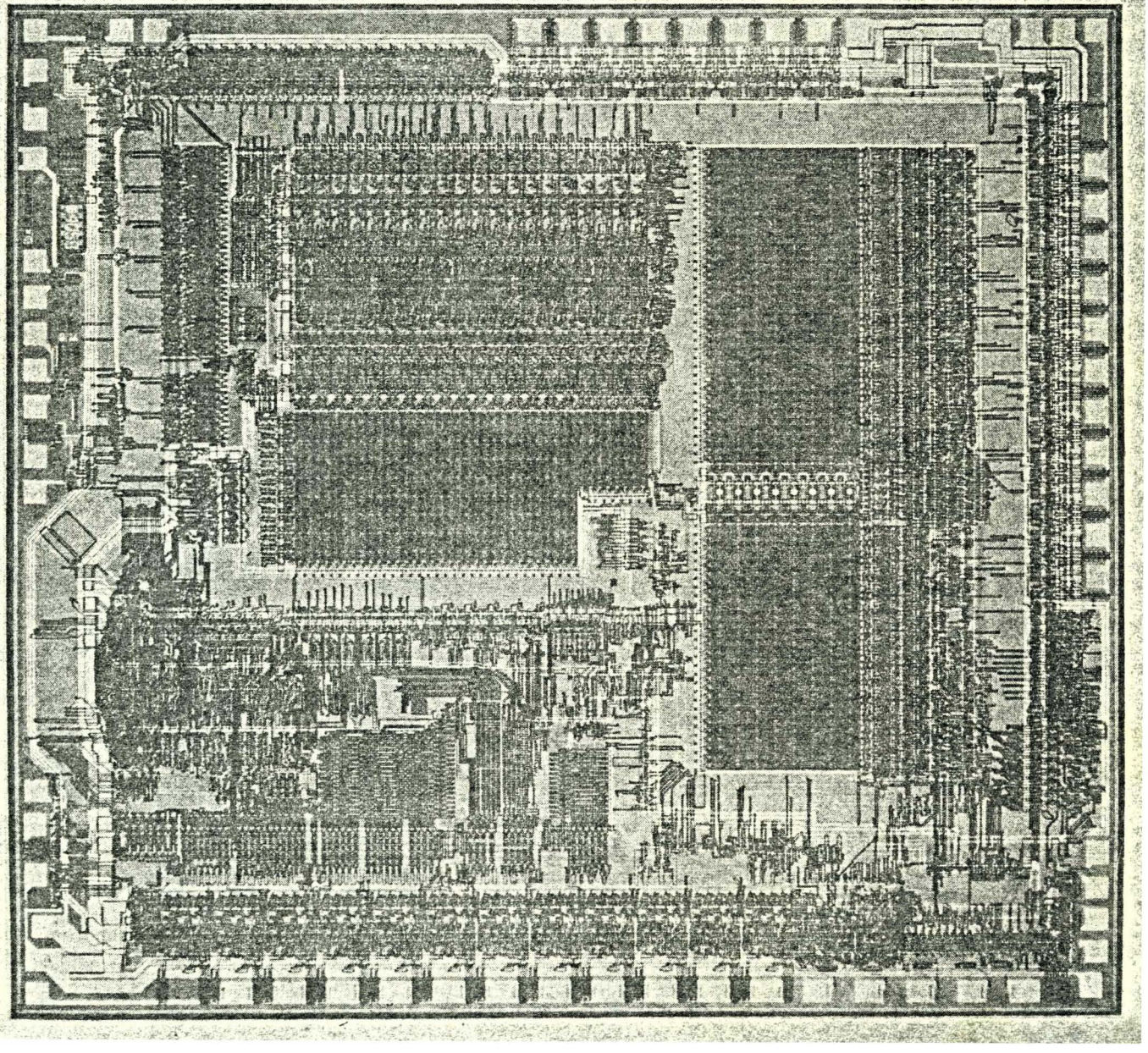
Honeywell

LSI-6 User's Manual



LSI-6 USER'S MANUAL

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Section 1
INTRODUCTION

The LSI-6 microprocessor is an NMOS, 16-bit chip capable of arithmetic, logic, and control operations, driven by a 48-bit external control mechanism Read Only Storage (ROS). The LSI-6 is a sophisticated processor whose design permits the execution of the Level 6 instruction repertoire (full software compatibility with Model 6/43), and allows for new architectural identities (emulation of foreign instruction sets). The LSI-6 is designed to directly control I/O and memory operations for ease in integrated system designs. The unique features available in the LSI-6 design that allow greater control and integration are:

A 48-bit external ROS that provides true horizontal microprogramming allowing up to 12 simultaneous micro-operations per 48-bit word

Eight external hardware interrupts that generate vectors to ROS microprogram routines (six of which can be user specified)

Five external software interrupts that are handled by firmware control (two can be specified by user)

Ten external monitor bits that are sensed and controlled by sophisticated test branch and major branch operations within the firmware.

1.1 SYSTEM FEATURES

- System Processor Bus

  20 address/data lines
  4 control lines

- External ROS

  Includes 1.5K words for Model 6/43 functionality (excludes I/O and control panel operation)

  Allows user 2.5K words for system integration

- Software Interrupt Capability

  Real-time clock
  Three levels of I/O interrupt
  Power failure interrupt

- Hardware Interrupts

  Nonexistent resource trap

  Memory access violation Memory Management Unit (MMU) (internal hardware interrupt)

  Uncorrectable memory error

  Memory refresh request

  Five levels of data transfer requests

- Monitor Inputs

  External events may be individually monitored and tested under firmware control

- Options

  Memory management with Model 6/43 functional MMU hardware resident on chip

  Level 6 Long Address Form (LAF) or Short Address Form (SAF) (20 bit/16 bit) address

  Level 6 CIP address syllable resolution

  Two additional user-definable options

1.2 HARDWARE FEATURES

- 16- and 20-Bit Arithmetic Logic Unit (ALU) With A- and B-Port Inputs

  A-port sourced by a 32-location register file with:

  16 data registers by 16 bits wide
  16 address registers by 20 bits wide

  B-port sourced by two hardware registers with:

  Q-register (7, 8, or 16 bit--right justified)
  G-register (20 bits)

- Full 16- or 32-Bit Shifting Capability

  16-bit register file
  16-bit Q-register
  32-bit register file, Q-register

- Program Counter With a 20-bit Increment/Decrement Feature

- Byte Swap Mechanism With Byte Manipulation

- Hardware Mask Generation

- Constant Generation to Internal Bus With Two Independent Sources to the Bus

- Level 6 7-Bit Indicator Register

- Mode Registers Using an 8 by 8 Register File

- MMU Hardware (Model 6/43 Functionality)

  31 by 32 register file (segment descriptors)
  12-bit relocation adder
  9-bit block size comparator
  Three 2-bit ring comparators
  Four memory violation flip-flops

- Next ROS Address Generation

  12-bit ROS address register
  Major branch matrixes
  Test branch matrixes
  4 by 12 push/pop stack
  Hardware interrupt priority network (Prinet)
  Software interrupt priority network (Prinet)

- 16-Bit Functional Register

  Software instruction register

- Various Storage Elements

  Monitor inputs
  Software/hardware interrupt lines

1.3 FIRMWARE FEATURES

- Horizontal Microprogramming With:

  48-bit firmware word allowing up to 12 simultaneous micro-commands and internal/external simultaneous control operations

  4K word addressability for ROS generated internally; delivered to external hardware

- Subroutine Capability

  Push/pop micro-ops together with 4 by 12 stack allows up to four levels of subroutine

- Five ROS Address Generation Methods

  Jump (to absolute address)

  Test branch with:

  64 test conditions
  Two-way branch

  Major Branch with:

  15 test condition sets
  16-way branch

  Increment

  Return (Pop)

- Vectored Hardware Interrupt

1.4 PHYSICAL CHARACTERISTICS

68 pin--leadless package

1.5 ELECTRICAL CHARACTERISTICS

- Power

  VCC = +5V $\pm$ 5%
  VSS = 0V
  VBB = -5V $\pm$ 10%

- Temperature Range

  -10°C to +85°C

- Clock (two phase)

  Cycle Time: DC to 250 nanoseconds (refer to Appendix B for timing specifications).

- All Input/Output Signals are TTL Compatible

Section 2
INTERFACE AND SIGNAL DESCRIPTIONS

This section defines the LSI-6 interface and provides a description of the interface signals. The interface signals are divided into four groups according to pin assignment and phase relationship of the clock.

2.1 LSI-6 CLOCK

The LSI-6 clock is the primary element of the interface and it is composed of Phase A and Phase B as shown in Figure 2-1.

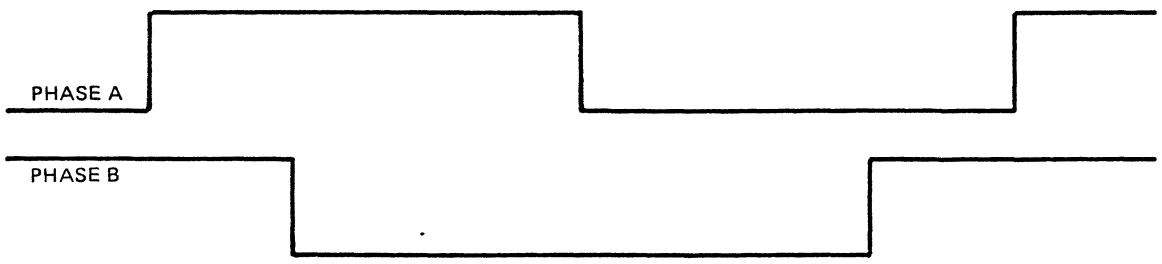


Figure 2-1. LSI-6 Clock Phase Relationship

The phase relationship between Phase A and Phase B determines the functions of the interface lines because there are 129 signals (excluding power, ground, and clock timing) shared among 57 input/output pins.

Phase A signal is used by the LSI-6 and the system to reverse the direction of the I/O bus drivers. When Phase A is true, the 48 ROS data lines and the five option lines are inputs to the LSI-6. When Phase A is false, all other shared signals are either inputs or outputs to the LSI-6.

Phase B signal is used to latch the signals that were gated with Phase A. When Phase B is going false, the ROS data and options are latched internal to the LSI-6. When Phase B is going true, all other shared signals are latched internal to the LSI-6. For detailed timing, refer to Appendix B.

2.2 SIGNAL GROUPS

There are four signal groups defined by the LSI-6 interface. Each group, except group 1, consists of signals that have common pin assignments and clock phase relationship as shown in Figures 2-2 and 2-3.

Group 1 consists of nine interface lines that have unshared signals. They are: three voltage, two ground, and four timing signals.

Group 2 consists of 23 interface lines which control 69 signals, five of which are unused. During Phase A true, the 23 lines represent 21 ROS input data bits and two input option bits. During Phase A false, the 23 lines are bidirectional representing inputs of 16 data bus bits, 3 control signals, and 4 unused signals; or outputs of 20 address/data bus bits and 3 control signals.

Group 3 consists of 19 interface lines which control 38 input signals. During Phase A false, the 19 lines represent 4 software interrupt signals, 8 hardware interrupt signals, and 7 monitor bits. During Phase A true, the 19 lines represent 14 ROS input data bits, 3 input option bits, and 2 unused signals.

Group 4 consists of 13 interface lines which control 26 signals. During Phase A false, the 13 lines represent 12 ROS output address bits and an error signal (MEMKIL). During Phase A true, the 13 lines represent 13 ROS input data bits.

2.2.1 Group 1 Signals

Group 1 (unshared pins) consists of nine unshared interface lines. Table 2-1 lists the interface lines and the associated signal name. Table 2-2 provides a definition of group 1 signals.

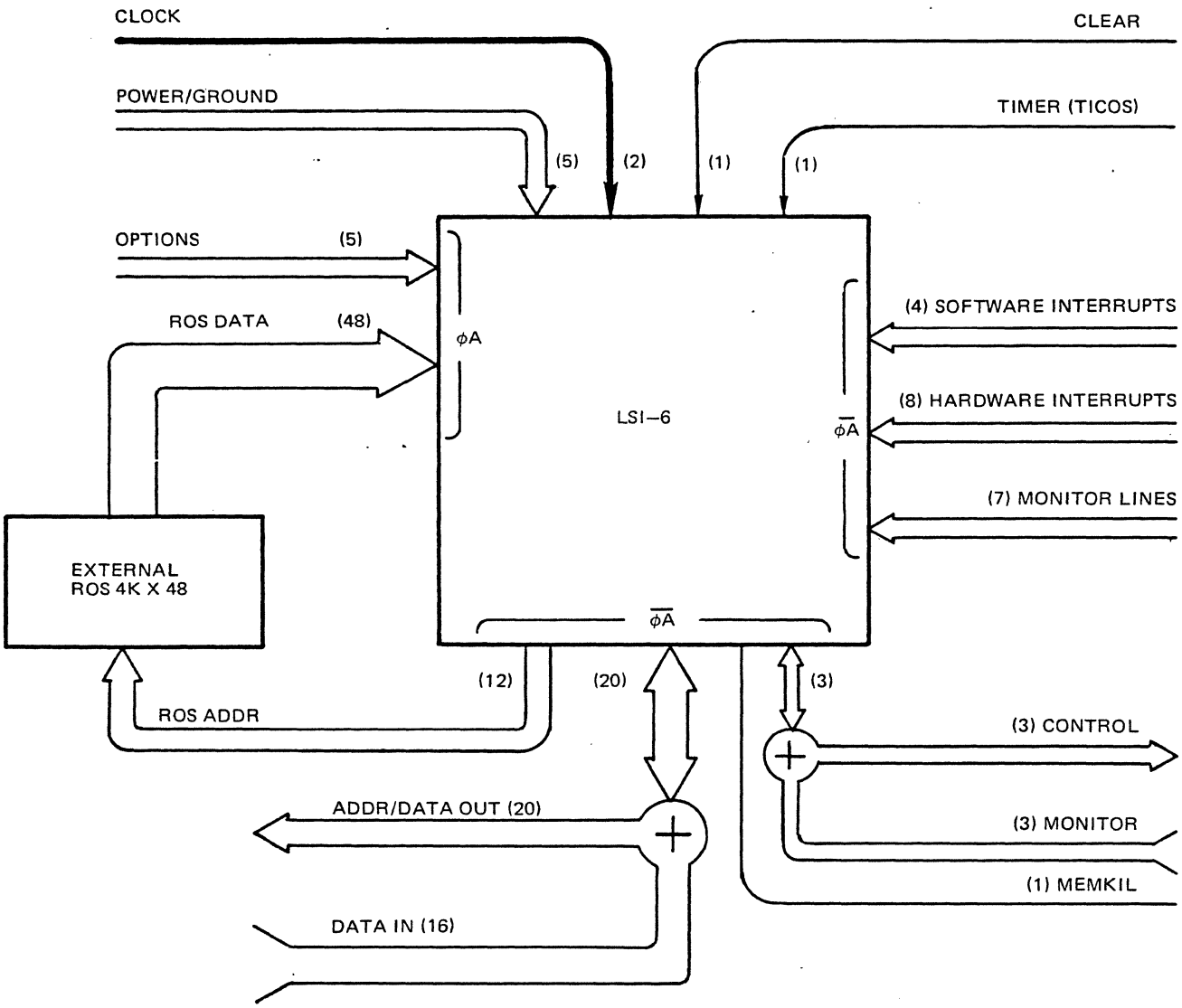


Figure 2-2. Interface Signals and Phase A Polarity

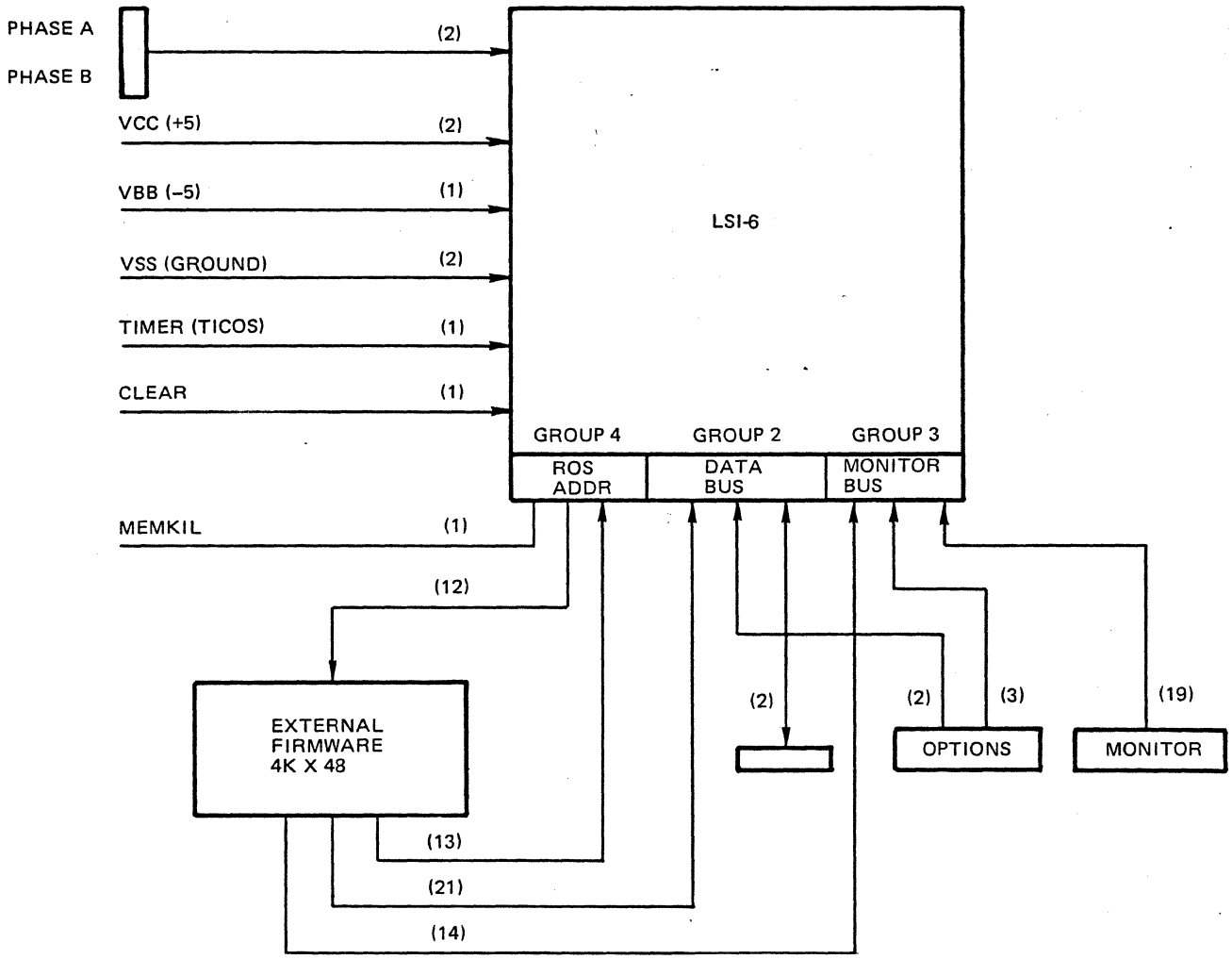


Figure 2-3. Basic LSI-6 With Interface Buffer

Table 2-1. Unshared Pins Interface/ Function Names

Interface Name	Function (Signal Name)
VOLTA1	VCC (+5V)
VOLTA2	VCC (+5V)
VOLTA3	VBB (-5V)
GRND01	VSS (GND)
GRND02	VSS (GND)
T1CK0S+0A	T1COS (Timer)
0A	Clock Phase A
0B	Clock Phase B
CLEARX-0A	Clear

Table 2-2. Unshared Pins Signal Definitions

Signal Name	Description
VCC (+5V)	+5 Volt Power Supply
VBB (-5V)	-5 Volt Power Supply
VSS	Ground
T1COS (Timer)	T1COS is a square wave input. The leading and trailing edges are detected on the chip and cause a software interrupt. It is during this interrupt that firmware updates the watchdog timer, the real-time clock, and the maintenance panel (assuming all are present). (This is a 60 hertz square wave--8.33 milliseconds between leading and trailing edges.)
CLOCK (Phase A) (Phase B)	Phase A and Phase B is the two-phase clocking system for sequencing the processor chip. Voltage amplitudes are non-TTL levels.
CLEAR	CLEAR is a signal active low for a minimum of 10 microseconds. It forces the ROS address lines to location 0 and resets the following flip-flops: watchdog timer, real-time clock, MMU flip-flops 1, 2, 3, and 4. It also places 001 in all four stack locations.

2.2.2 Group 2 Signals

Group 2 (processor bus) consists of 23 shared interface lines. Table 2-3 lists the interface lines and the associated signals. Table 2-4 provides a definition of group 2 signals.

Table 2-3. Processor Bus Interface/Function Names

Interface Name	Function (Signal Name)		
	$\bar{\phi}$A Input	$\bar{\phi}$A Output	ϕA Input
DABS0D+18	Unused	ADDR BUS 0D	ROS DATA 18
DABS0C+19	Unused	ADDR BUS 0C	ROS DATA 19
DABS0B+20	Unused	ADDR BUS 0B	ROS DATA 20
DABS0A+21	Unused	ADDR BUS 0A	ROS DATA 21
DABS00+23	DATA BUS 00	ADDR/DATA BUS 00	ROS DATA 23
DABS00+24	DATA BUS 01	ADDR/DATA BUS 01	ROS DATA 24
DABS02+24	DATA BUS 02	ADDR/DATA BUS 02	ROS DATA 25
DABS03+35	DATA BUS 03	ADDR/DATA BUS 03	ROS DATA 35
DABS04+36	DATA BUS 04	ADDR/DATA BUS 04	ROS DATA 36
DABS05+37	DATA BUS 05	ADDR/DATA BUS 05	ROS DATA 37
DABS06+38	DATA BUS 06	ADDR/DATA BUS 06	ROS DATA 38
DABS07+39	DATA BUS 07	ADDR/DATA BUS 07	ROS DATA 39
DABS08+40	DATA BUS 08	ADDR/DATA BUS 08	ROS DATA 40
DABS09+41	DATA BUS 09	ADDR/DATA BUS 09	ROS DATA 41
DABS10+42	DATA BUS 10	ADDR/DATA BUS 10	ROS DATA 42
DABS11+43	DATA BUS 11	ADDR/DATA BUS 11	ROS DATA 43
DABS12+44	DATA BUS 12	ADDR/DATA BUS 12	ROS DATA 44
DABS13+45	DATA BUS 13	ADDR/DATA BUS 13	ROS DATA 45
DABS14+46	DATA BUS 14	ADDR/DATA BUS 14	ROS DATA 46
DABS15+47	DATA BUS 15	ADDR/DATA BUS 15	ROS DATA 47
CF1TA2-00	MTESTA02	CONTFP 01	ROS DATA 00
CF3TA0-P2	MTESTA00	CONTFP 03	SIPE(OPT 2)
CF4TA1-P1	MTESTA01	CONTFP 04	CIPE(OPT 1)

Table 2-4. Processor Bus Signal Definitions

Signal Name	Description
ADDR BUS (0D-0A)	Four high-order address lines gated out during Phase A low under control of bus control field (all bus output cycles).
ADDR/DATA OUT (00-15)	16 lines (low order) used for address/data gated out during Phase A low under control of bus control field (all bus output cycles).
ADDR/DATA IN (00-15)	16 data lines gated in during Phase A low under control of bus control field (DIN micro-op only).
CONTFP 01 CONTFP 03 CONTFP 04	Control flip-flops 1, 3, and 4 are gated out of chip during Phase A low-order control of bus control field (all output bus cycles).
MTESTA00 MTESTA01 MTESTA02	Three lines gated into monitor flip-flops during Phase A low when processor bus is not in an output cycle (i.e., bus control field equals DIN or NOP).
ROS DATA (XX)	ROS data lines are gated into the chip during Phase A high time. They are latched internally with the trailing edges of Phase B.
CIPE	Option 1 or Commercial Instruction Processor Enable (CIPE) signal. This signal, active low (steady state), signifies the presence of the CIP option to the chip. It is gated in when Phase A is high.
SIPE	Option 2 or Scientific Instruction Processor Enable (SIPE) signal. This signal, active low (steady state), signifies the presence of the SIP option to the chip. It is gated in when Phase A is high.

2.2.3 Group 3 Signals

Group 3 consists of 19 shared interface lines. Table 2-5 lists the interface lines and the associated signals. Table 2-6 provides a definition of group 3 signals.

Table 2-5. Monitor/Interrupt and ROS Data/Option Interface/Function Names

Interface Name	Function	
	$\overline{\phi}$A Input	ϕA Input
DATRQ0-32	DTR0	ROS DATA 32
DATRQ1-33	DTR1	ROS DATA 33
DATRQ2-27	DTR2	ROS DATA 27
DATRQ3-26	DTR3	ROS DATA 26
DATRQ4-34	DTR4	ROS DATA 34
INTRQ2-28	INTR2	ROS DATA 28
INTRQ1-29	INTR1	ROS DATA 29
INTRQ0-30	INTR0	ROS DATA 30
MTSTB0+13	MTESTB00	ROS DATA 13
MTSTB1+14	MTESTB01	ROS DATA 14
MTSTB2+15	MTESTB02	ROS DATA 15
MTSTB3+16	MTESTB03	ROS DATA 16
POWRON+22	POWON	ROS DATA 22
STSTB0+17	STESTB00	ROS DATA 17
MTSTA3-0A	MTESTA03	Unused
MEMPAR-P0	MEMPAR	MMUE(OPT-0)
MEMPRES-P3	MEMPRES	LAFE(OPT-3)
STSTA0-0A	STESTA00	Unused
MREFSH-P4	MEMFSH	MEMVAL(OPT-4)

Table 2-6. Monitor/Interrupt and ROS Data/Option Signal Description (Sheet 1 of 2)

Signal Name	Description
Data Request DTR0 through DTR4	Data Request is active low and is gated in during Phase A low. Data Request 0 (DTR0) is the highest priority data request and Data Request 4 (DTR4) is the lowest priority data request.
Interrupt Request INTR0 through INTR2	Interrupt Request is active low and is gated in during Phase A low. Interrupt Request 0 (INTR0) is the highest priority interrupt and Interrupt Request 2 is the lowest priority interrupt request. All interrupt requests are honored between instructions.
MTESTB00 through MTESTB03	These are four lines gated in during Phase A low and are used as a source for a major branch based on some external events. User can define these events (such as CIP execution, SIP execution, additional opcode cracking, undefined I/O operations, etc.). They are also a source for test branch.
STESTB0/STESTA0	These lines are gated in during Phase A low and can be used as a source for a test branch condition of external events. User can define these events.
MTESTA03	This line can be used in conjunction with MTESTA00, MTESTA01, and MTESTA02 discussed in group 2 lines. Together they form another source for the major branch test groups. NOTE When taken as a group, this group can only sample external conditions on nonoutput bus cycles. MTESTB00 through MTESTB03 can sample external conditions on any cycle. MTESTA03 as an individual line can also test on any cycle. This line is gated in during Phase A low and is a source for major branch and test branch conditions.
MEM PARITY ERROR	Memory parity error gated in during Phase A Signal is active low. It causes a memory error hardware interrupt.

Table 2-6. Monitor/Interrupt and ROS Data/Option Signal Description (Sheet 2 of 2)

Signal Name	Description
MEM PRESENT	Memory present signal is gated in during Phase A low. An active low signifies the memory is not present. It causes a nonexistent resource hardware interrupt.
POWON	POWON is a signal that becomes active high approximately 10 milliseconds after VCC (+5V) is in steady state, and becomes low approximately 2 milliseconds prior to VCC going off. This low going signal is used to cause a power failure interrupt. The state of this signal is sampled into the chip during Phase A low.
MEMRFRSH	Memory Refresh Request is an active low signal gated in during Phase A low. This signal will be generated at a rate equal to the need of the system's main memory refresh requirement. Receipt of this signal causes a hardware interrupt vector to a firmware routine.
ROS DATA (XX)	14 ROS data lines are gated into the chip during Phase A high. They are latched internally with the trailing edge of Phase B.
MMUE	Option 0 or Memory Management Unit Enable (MMUE). This line, active low (steady state signal), signifies the presence of this option (including necessary firmware) to the chip; gated in during Phase A high.
LAFE	Option 3 or Long Address Format Enable (LAFE) signal. This signal, active low (steady state), signifies the presence of LAF mode to the chip. It is gated in when Phase A is high.
MEMVAL	Option 4 or Memory Valid Signal. This signal, active low (steady state), signifies the presence of a fully charged memory battery backup device. It is gated in when Phase A is high.

2.2.4 Group 4 Signals

Group 4 consists of 13 shared interface lines. Table 2-7 lists the interface lines, and the associated signals. Table 2-8 provides a definition of group 4 signals.

Table 2-7. ROS Address and Data Bus Interface/Function Names

Interface	$\overline{\phi}$A Output	ϕA Input
RSAD00+01	ROS Address 00	ROS Data 01
RSAD01+02	ROS Address 01	ROS Data 02
RSAD02+03	ROS Address 02	ROS Data 03
RSAD03+04	ROS Address 03	ROS Data 04
RSAD04+05	ROS Address 04	ROS Data 05
RSAD05+06	ROS Address 05	ROS Data 06
RSAD06+07	ROS Address 06	ROS Data 07
RSAD07+08	ROS Address 07	ROS Data 08
RSAD08+09	ROS Address 08	ROS Data 09
RSAD09+10	ROS Address 09	ROS Data 10
RSAD10+11	ROS Address 10	ROS Data 11
RSAD11+12	ROS Address 11	ROS Data 12
MEMKIL+31	MEMKIL	ROS Data 31

Table 2-8. ROS Address and Data Bus Signal Description

Signal Name	Description
ROS ADDRESS (00-11)	ROS address lines are gated out during Phase A low. They can be latched externally at the leading edge of Phase B.
ROS DATA (01-12,31)	ROS data lines are gated into the chip during Phase A high. They are latched internally with the trailing edge of Phase B.
MEMKIL	Signifies a memory error violation detected internal to the chip either as a result of MMU operation or a nonzero detected on BI (0D-0A) during SAF Mode (16-Bit Address mode). This signal is gated out of the chip during Phase A, and may be used to prevent alteration of memory contents.

2.3 LEVEL 6 SIGNAL CROSS-REFERENCE

Table 2-9 provides a LSI-6 to Level 6 interface equivalency.

Table 2-9. LSI-6/Level 6 Interface Equivalency

LSI-6 Mnemonic	Level 6 Mnemonic
CF1TA2-00	BYTEXX-00
CF3TA0-P2	PROCED-P2
CF4TA1-P1	BUSYXX-P1
MTESTA02	BYTEX(IN)
MTESTA00	PROCED(IN)
MTESTA01	BUSY(IN)
CONTFP01	BYTEX(OUT)
CONTFP03	PROCED(OUT)
CONTFP04	BUSY(OUT)
MTSTB0+13	MIBGP0+13
MTSTB1+14	MIBGP1+14
MTSTB2+15	MIBGP2+15
MTSTB3+16	MIBGP3+16
MTESTB00	MIBGP0
MTESTB01	MIBGP1
MTESTB02	MIBGP2
MTESTB03	MIBGP3
STSTB0+17	TSTBR1+17
MTSTA3-0A	ONBDCN-0A
STESTB00	TESTBR1
MTESTA03	OBC
STSTA0-0A	MPLOCK-0A
STESTA00	MPLOCK

Section 3
HARDWARE DESCRIPTION

The LSI-6 microprocessor consists of five major internal hardware logic areas as shown in Figure 3-1. The five major logic areas, which will be discussed in the following subsections, are the Processor Bus (PB), the Internal Bus (BI), the data manipulation area (including ALU), the control area, and the Memory Management Unit (MMU).

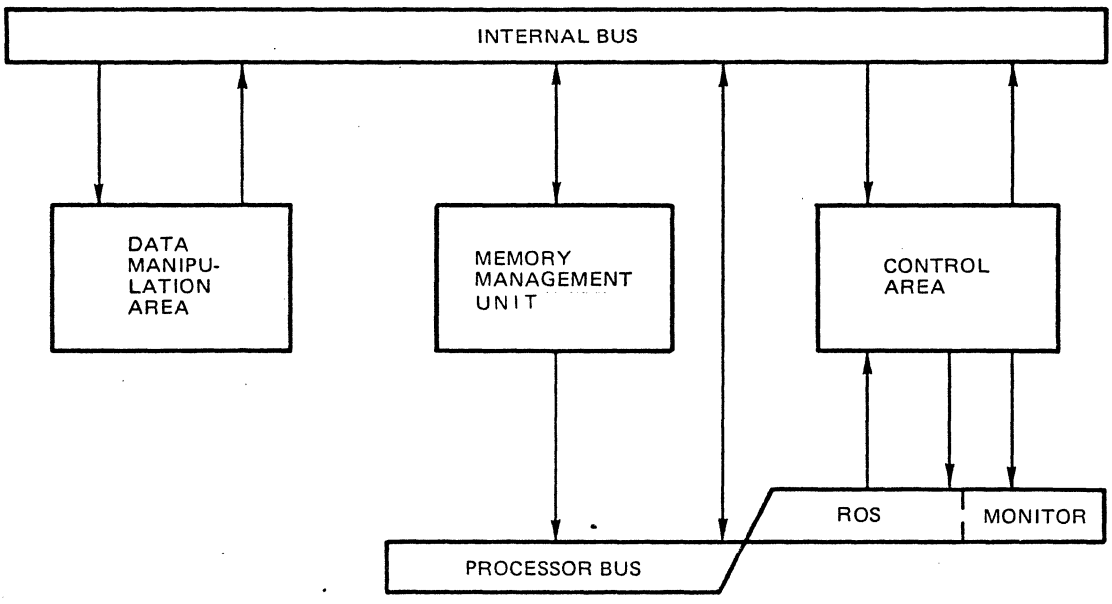


Figure 3-1. LSI-6 Major Block Diagram

3.1 PROCESSOR BUS

The processor bus consists of 20 address/data lines, one memory address violation line, and three general purpose control lines.

The address/data and the general purpose control lines are bidirectional during Phase A low. The direction and source (internal) for output operations is defined by the Bus Control Field (RDDT23 and RDDT25) of the current firmware word. The Memory Address Violation line (MEMKIL+31) is transferred out only during Phase A low.

3.1.1 Bus Address Lines DABS (0D-0A, 00-15)

When the 20 bus address/data lines are used as address lines (as defined by micro-ops: MMR, MWB1, MWB0 and MMW of the bus control field), the most significant 12 bits (D through A, 0 through 7) can originate from either the MMU (MMU adder output) or the internal bus (BI0D through BI0A, BI00 through BI07) depending on whether or not the MMU is enabled (MEMPAR-P0 activated low during Phase A high time [Option 0]). The low-order eight bits of the address (bits 8 through 15) will always originate from the internal bus (BI08 through BI15).

MMU	From	To
	MMU ADDER (12 BITS)	DABS0D-0A, DABS00-07
Enabled	BI08-15	DABS08-15
Disabled	BI0D-0A, BI00-15	DABS0D-0A, DABS00-15

3.1.2 Bus Data Lines DABS (0D-0A, 00-15)

When the 20 bus address/data lines are used for data out (as designated by either the DOUT or DOUTM micro-ops), the output will be 20 bits wide. The origin of the data internal to the chip when using the DOUTM micro-op is as follows:

MMU	From	To
	MMU ADDER (12 BITS)	DABS0D-0A, DABS00-07
Enabled	BI08-15	DABS08-15
Disabled	BI0D-0A, BI00-15	DABS0D-0A, DABS00-15

The origin of the data internal to the chip when using the DOUT micro-op is modified by other micro-ops TWNOUT and SWPOUT as shown below (both micro-ops are from a special command field).

Micro-ops		Origin to Data Out
Bus Control	Special Control	
DOUT	TWNOUT	Zeros -> DABS (0D-0A) BI(08-15) -> DABS (00-07) BI(08-15) -> DABS (08-15)
DOUT	SWPOUT	Zeros -> DABS (0D-0A, 00-11) BI(0D-0A) -> DABS(12-15)
DOUT	--	BI(0D-0A,00-15)->DABS(0D-0A,00-15)

When DIN (bus control micro-op) is used, the data lines are directed into the chip. Data into the chip is 16 bits wide and the data path is as follows:

```
          Zeros --> BI(0D-0A)
DABS (00-15) --> BI(00-15)
```

3.1.3 Memory Address Violation

The memory address violation signal (MEMKIL+31) is gated out when Phase A is low. It is used to prevent the destruction of main memory data when a memory address violation is detected internal to the chip. The source of this signal is either the detection of a nonzero value on BI(0D-0A) when 16-bit addressing mode is enabled or an MMU error is detected.

3.1.4 General Purpose Lines

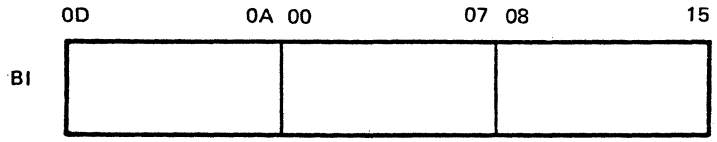
There are three bidirectional general purpose lines that can be used as control/response lines during input/output operations.

When used with processor bus output cycles (data or address out), they provide the contents of control flip-flops 1, 3, and 4 to the processor bus during Phase A low.

When the processor bus is not being transferred out (i.e., bus control bits RDDT 23 through 25 designated DIN or NOP), these lines are used as inputs to the major branch and test branch matrixes via monitor storage flip-flops MTESTA2, MTESTA0, and MTESTA1, respectively. These signals must be gated into the chip during Phase A low.

3.2 INTERNAL BUS

The Internal Bus (BI) is the major data path for communication of information between the other four areas of the processor chip. The internal bus is 20 bits wide and is designated as BI0D through BI0A, and BI00 through BI15. BI0D is the high-order bit and BI15 is the low-order bit as shown below.



There are 12 sources to the BI under control of 11 micro-ops. The ALU is a default source to BI if none of the other 11 defined micro-ops are used. A bus priority network (Prinet) is built into the LSI-6 to prevent damage to the chip if the user accidentally uses conflicting micro-ops to source the BI; however, resulting data to the BI is unspecified.

Tables 3-1 and 3-2 list the internal bus source micro-ops and load micro-ops.

3.3 DATA MANIPULATION AREA

The data manipulation area, as shown in Figure 3-2, performs arithmetic and logical operations on data and memory address generation. It is composed of the following eight elements.

P-Register	ALU
G-Register	Shifting Mechanism
Q-Register	Indicator Register
Register File (Scratch Pad Memory)	M-Register File

3.3.1 P-Register

The P-register is a 20-bit memory address register that contains either the program counter or a logical memory address. It is loaded from the internal bus, can be incremented or decremented, and the register output is transferred to the internal bus.

The following micro-ops are used with the P-register operation:

Micro-Op	Remarks
LDP	BI -> P
PP1	P+1 -> P
PM1	P-1 -> P
BIFP	P -> BI

Table 3-1. BI Source Micro-Ops

Source	Micro-Op	Remarks
Processor Bus	DIN	Zeros -> BI(0D-0A); DABS(00-15) -> BI(00-15)
P-Register	BIFP	P(0D-0A,00-15) -> BI(0D-0A,00-15)
I-Register	BIFI	Zeros -> BI(0D-0A,00-07) I-register (00-07) -> BI(08-15)
M-Register File	BIFM	Ones -> BI(0D-0A,00-07) M(x)REG(00-07) -> BI(08-15)
MMU Register File (Base Word)	BIFMMUH	Zeros -> BI(0D-0A) MMURFx(00-15) -> BI(00-15)
MMU Register File (Size Word)	BIFMMUL	Zeros -> BI(0D-0A) MMURFx(16-31) -> BI(00-15)
A-Port ALU (Register File)	BIFSP	A-Port (0D-0A,00-15) -> BI(0D-0A,00-15) If selected register is 16 bits, then bit 0 is sign propagated through the upper four bits (D through A)
F-Register Mask	BIFMK	A One is sourced to bit position BI(00-15) dependent upon value of count in F-register (12-15). Zeros are sourced to all other positions. BI(00) -> BI(0D-0A)
ROS Address Field (CONST)	INCK	RDDT(04) -> BI(0D-0A,00-07) RDDT(05-12) -> BI(08-15)
Special Control Field (CONST)	RDL	RDDT(39) -> BI(0D-0A,00-07) RDDT(40-47) -> BI(08-15)
Special Control Field (CONST)	RDH	RDDT(40) -> BI(0D-0A) RDDT(40-47) -> BI(00-07) RDDT(39) -> BI(08-15)
ALU Output	DEFAULT (none of the above)	ALU(0D-0A,00-15) -> BI(0D-0A,00-15)

Table 3-2. BI Load Micro-Ops

Load	Micro-Ops	Remarks
PB	DOUT	BI(0D-0A,00-15) -> DABS(0D-0A,00-15)
	DOUTM MMR MWB1 MWB0 MMW	Relocated memory address-DABS
P-Register	LDP	BI(0D-0A,00-15) -> P(0D-0A,00-15)
I-Register	LDI	BI(08-15) -> I-register (00-07)
M-Register	LDM	BI(08-15) -> Mx(00-07)
MMU Register File (Base Word)	WMBS	BI(00-15) -> MMURFx(00-15)
MMURF (Size Word)	WMSZ	BI(00-15) -> MMURFX(16-31)
F-Register	LDFR	BI(00-11) -> F-register (00-11)
FCNT	LDFT	BI(11-15) -> FCNT
Register File (RF) (ALU-SPM)	SPW	BI(0D-0A,00-15) -> RFx(0D-0A,00-15) See reference for other modifications
G-Register	LDG	BI(0D-0A,00-15) -> G(0D-0A,00-15)
Q-Register	LDQ	BI(00-15) -> Q(00-15)

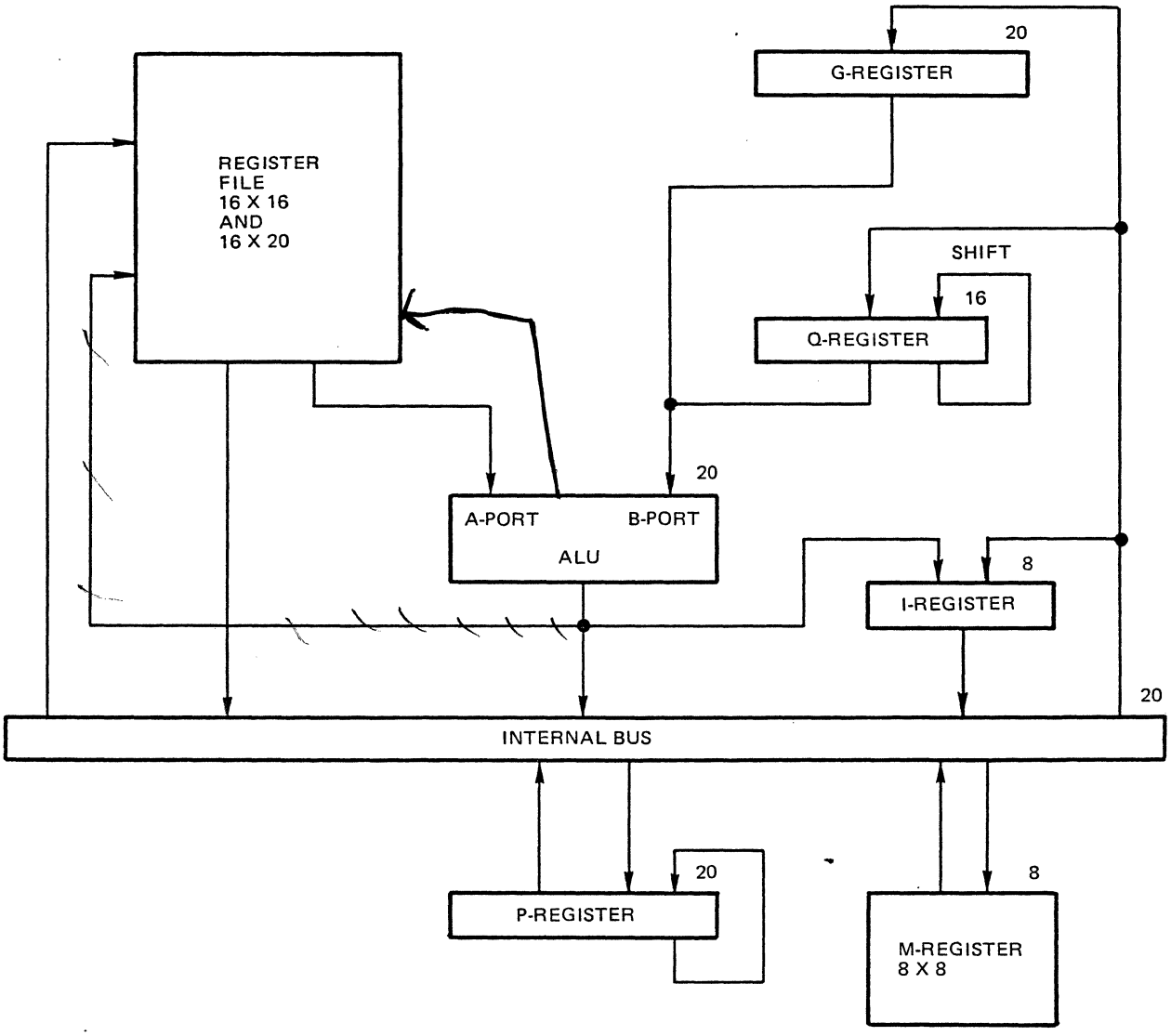


Figure 3-2. Data Manipulation Block Diagram

3.3.2 G-Register

The G-register is 20 bits wide and is used to hold addresses for ALU operations. It is loaded from the internal bus with the LDG micro-op and the output is sent to the B-port of the ALU.

3.3.3 Q-Register

The Q-register is a 16-bit register that provides operand shifts, and holds secondary operands for the ALU. It is loaded from the internal bus and the output is sent to the B-port of the ALU. Register output can be sign extended to 20 bits from Q0, Q8, or Q9 for ALU operations.

The Load Q-register micro-op (LDQ) is used for loading from BI when shifting micro-ops are not used.

3.3.4 Register File

The register file can be loaded from the ALU output or the BI. When loaded from BI, data comes direct, or with byte 0 (BI00 through BI07) swapped with byte 1 (BI08 through BI15), or BI12 through BI15 to RF0D through RF0A. Two write lines exist: one loading bits 00 through 15, the other loading bits 0D through 0A. The register file output feeds the A-port of the ALU. The register address is taken from either the firmware word register (RDDT) or the information in the F-register.

During Phase A high time, the address for the selected register file is generated under control of the register file address field. The selected register file is read out during Phase A high and its contents are latched in an output register during Phase A low. This output register is then available to two possible destinations, the A-port of the ALU (under control of the ALU control field, RDDT bits 18 through 22) and the internal bus (under control of special control field, RDDT bits 35 through 41).

The selected register file is written near the end of Phase A low time. The general command for writing the register file is supplied by RDDT bit 26 (register file load). This general command can be modified by certain special control field micro-ops or subcommands. Table 3-3 provides a list of possible write operations to the register file.

The register file description in subsections 3.3.4.1 through 3.3.4.9 are in conjunction with Level 6 Model 43 terminology. Figure 3-3 shows the register file topology and the hexadecimal locations of the registers.

Table 3-3. Register File Special Control Field Write Operations

SPW	Special Control Field Micro-Ops	Resulting Operation
0		No change in register file
1	IWDTA[a]	Write register file bits 00-16
1	SPXDTA[b]	Write register file (0D-0A) from BI (12-15)
1	BIFSP	Write register file (all bits) from ALU
1	SPFAU	Write register file (all bits) from ALU
1	SPFBIX[c]	Write register file (0-7) from BI (8-15) Write register file (8-15) from BI (0-7)
1	All register file Shift[d] Subcommands	Write register file (all bits) from shifted ALU result
1	None of the above special control field micro-ops	Write register file (all bits) from BI (all bits)

[a] See special control field for complete definition of micro-ops.

[b] Normally used with 20-bit registers.

[c] Normally used with 16-bit registers. If a 20-bit register is selected BI12-BI15 to Register File RF0D-RF0A.

[d] Normally used with 16-bit registers. However, when used with a 20-bit register file, the effect is a 20-bit open left or 20-bit open right shift. Micro-op SFV0A supplies ALU (0A) to ALU (0D) for open right shifts.

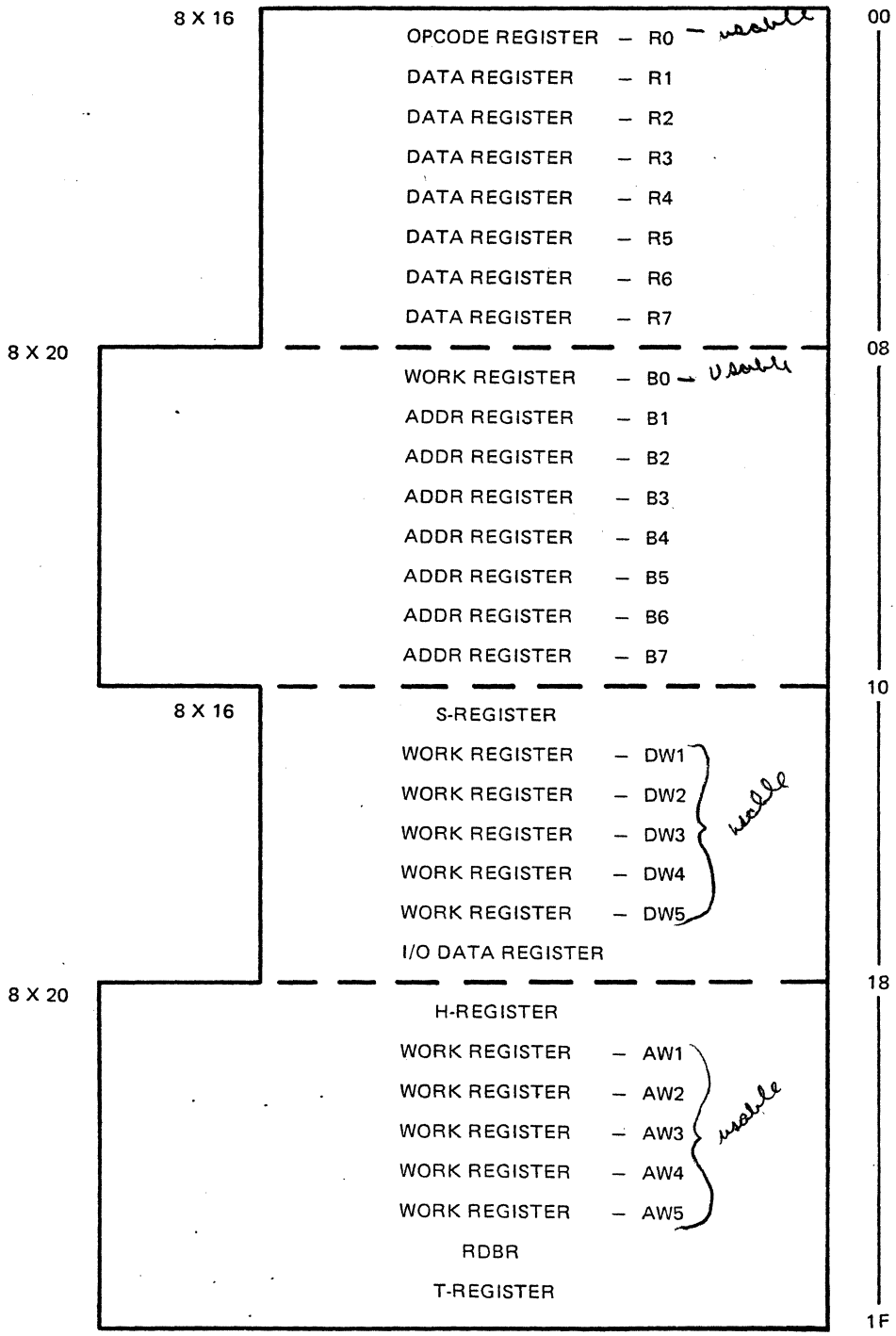


Figure 3-3. Register File Topology

3.3.4.1 DATA REGISTERS

There are seven 16-bit software addressable data registers, R1 through R7. They can be loaded from or stored into memory on either a word or byte basis. Each register can be used as operands in arithmetic, logical, and compare operations. (R0 is a 16-bit register that is used to hold a copy of the executing instruction.)

3.3.4.2 ADDRESS REGISTERS

There are seven software-addressable base registers, B1 through B7. They are 20 bits wide and can be used to hold main memory addresses. B0 is a 20-bit working register used in Panel mode.

3.3.4.3 WORK REGISTERS

Six 16-bit (DW1 through DW5) and five 20-bit (AW1 through AW5) registers are available for temporary storage of information during firmware operations.

NOTE

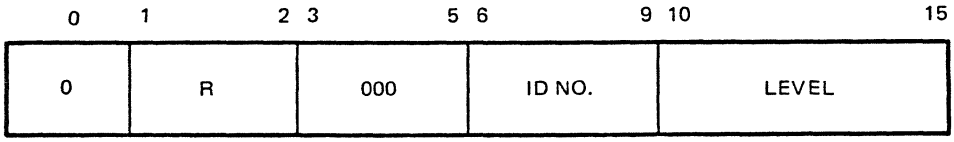
AW1 is normally used as the "effective address" storage element.

3.3.4.4 T-REGISTER

The T-register is the stack address register and is 20 bits wide.

3.3.4.5 S-REGISTER

System keys and processor security keys are contained in this 16-bit register. The bit fields are defined as follows:



R - Ring Number 00,01 = user states
10,11 = privilege states

ID No. - Each processor in the system has an identification number.

Level - The 6-bit level field defines the interrupt priority on which the processor is currently operating. Zero is the highest and 63 the lowest priority.

3.3.4.6 H-REGISTER

The history (H) register is 20 bits wide. It contains the history of the program counter under firmware control.

3.3.4.7 REMOTE DESCRIPTOR BASE REGISTER

The Remote Descriptor Base Register (RDBR) is used by the Commercial Instruction Processor (CIP). It is 20 bits wide.

3.3.4.8 I/O DATA REGISTER

The I/O data register is a 16-bit data working register that can be used for temporary storage during I/O data transfer operations.

3.3.5 Arithmetic Logic Unit

The LSI-6 has an ALU with full 16- or 20-bit capabilities. Overflow and carry functions are generated out of both the 16th and 20th bit positions. The 16-bit version of the ALU is normally used when handling data, while the 20-bit version is normally reserved for address modifications and transfers.

The ALU has two ports for operand inputs, the A- and B-port. The A-port can accept either a 16- or 20-bit register file input. In the case where the register file selected is a 16-bit wide data register, the most significant bit is sign extended to 20 bits. The A-port can also select a value of zero as its input as specified by the ALU control field (RDDT bits 18 through 22). The B-port can select as its inputs: 20 bits from the G-register, 16, 8 or 7 bits right justified from the Q-register. The most significant bit of the field selected from the Q-register is always sign extended to present a 20-bit operand to the B-port. The B-port can also select a value of Zero as its input.

The output of the ALU can be directed to either the BI or the register file. When directed to the register file, its path can be direct (BIFSP or SPFAU, special control field micro-ops) or shifted left or right one bit position (also under control of special control field--all register file shift micro-ops). The ALU output is directed to the BI whenever there is no micro-op called to source the BI (it is the default source for the BI).

The carry and overflow conditions for both 16- and 20-bit operations are stored in temporary flip-flops (see subsection 4.1.2) for testing during the following cycle.

The following is a list of micro-ops used for ALU control.

Micro-Op Name			
SPANDG	SPANDQ8	ZERO	SPPQ8
GNOT	Q8	ZMG	SPMQ8
G	SPXORQ8	SPPG	SPPQ9
SPORG	SPORQ8	SPMG	SPMQ9
SPANDQNOT	SPANDQ	MINUS1	SPPQ
QNOT	Q	ZMQ	SPMQ
SPNOT	SPXORQ	SPM1	SPMQM1
SP	SPORQ	SPP1	SPPQP1

COMMENTS

SP indicates register file (x)
G indicates G-register
Q indicates Q-register
Q8 indicates sign propagation from Q08
Q9 indicates sign propagation from Q09
Z indicates input to A-port is Zero
ZERO indicates output equals Zero
MINUS1 indicates output equals all Ones
AND, OR, NOT, XOR, P, and M are all operations

3.3.6 Shifting Mechanism

The LSI-6 has the ability to perform various shift operations (i.e., open/closed, arithmetic/logical, left/right) on either 16- or 32-bit operands.

Sixteen-bit data shifting can be accomplished in one of two ways. The first takes place from output of the ALU into the register file and the second takes place in the Q-register. These two operations can be concatenated to perform the 32-bit data shift operations.

Three B-field shift micro-ops (SHOPRI, SHOPRF, and SHOP) are used to implement the Level 6 software shift instructions. The shift micro-ops are combined with the F-register decode (the F-register contains the Level 6 software instruction word for this operation) to determine the shift type, direction, and necessary filler bits. The following chart shows the decoded F-register bits and the corresponding shift type.

F-Register Bits 8 Through 11	Shift Type	Level 6 Instruction
0	Single open left shift	SOL
1	Single closed left shift	SCL
2	Single arithmetic left shift	SAL
3	Double closed left shift	DCL
4	Single open right shift	SOR
5	Single closed right shift	SCR
6	Single arithmetic right shift	SAR
7	Double closed right shift	DCR

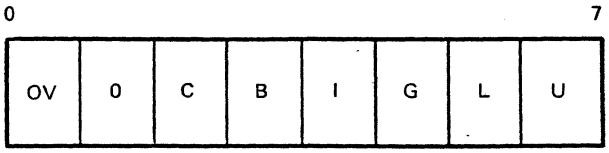
F-Register Bits 8 Through 11	Shift Type	Level 6 Instruction
8	Double open left shift (≤15)	DOL
9	Double open left shift (≥16)	DOL
A	Double arithmetic left shift (≤15)	DAL
B	Double arithmetic left shift (≥16)	DAL
C	Double open right shift (≤15)	DOR
D	Double open right shift (≥16)	DOR
E	Double arithmetic right shift (≤15)	DAR
F	Double arithmetic right shift (≥16)	DAR

F-register bits 1 through 3 contain the R-register to be shifted, and F-register bits 12 through 15 or 11 through 15 contain the number of positions to be shifted. When F-register bit 8 equals a Zero, the number of positions to be shifted is determined by F-register bits 12 through 15; and when F-register bit 8 equals a One, the number of positions to be shifted is contained in F-register bits 11 through 15. A special case exists when the count field contains a value of Zero. In this case, the number of positions to be shifted is contained in register file location R1 (general purpose register).

When a double word is selected (i.e., F-register bits 8 through 11 equals a hexadecimal 3, 7, 8, 9, A, B, C, D, E, or F), then F-register bits 1 through 3 must equal a 3, 5, or 7. This is necessary because it requires a combination of an implied even-numbered register and an explicitly addressed odd-numbered register to perform a double-word shift operation. When register R3 is explicitly addressed, register R2 is the implied addressed register. The even-numbered register contains the most significant bits of the double word.

3.3.7 Indicator (I) Register

The I-register is eight bits wide, containing various single bit indicators in the following format:



OV - Overflow indicator: It is set when any of the data registers R1 through R7 overflow; e.g., when a 16-bit arithmetic result produced is larger than the capacity of the register (under op-code control, out of ALU).

0 - Always Zero.

C - Carry indicator: This is set when the logical capacity of a register is exceeded. The carry indicator is generated from the ALU.

B - Bit test indicator: This bit gives the state of the last bit tested (primarily for bit test operations).

I - Input/output indicator: It indicates whether the last I/O command was accepted by the I/O controller.

G - Greater than indicator.*

L - Less than indicator.*

U - Unlike sign indicator.*

The I-register can also be loaded from the internal bus (BI08 through BI15 to IR0 through IR7), and its output goes to the internal bus (IR0 through IR7 to BI08 through BI15, with Zeros to BI0D through BI07).

3.3.8 Mode (M) Register File

The LSI-6 has an M-register file that has eight registers, each eight bits wide (8 by 8). This file can be loaded from the BI using the LDM micro-op or sourced to BI using the BIFM micro-op. When using either of these micro-ops, the M-register address is supplied by the least significant three bits of the register file address register. When neither of these micro-ops are called, the M-register address defaults to location 1 (M1 register).

M-register bits 1 through 7 of any M-register are testable, with the register file address field (refer to subsection 4.2) selecting the desired M-register, and the desired bit within the register being selected by a code of 1 through 7 in F-register bits (0 through 3). This causes the setting of a temporary flip-flop (MREGBIT+00) when a One bit is detected (refer to subsection 3.4.2). Bit 0 of the selected M-register is sampled in each cycle by a temporary flip-flop (MDREGO+00). Testing of these temporary flip-flops is accomplished on the following cycle using micro-op TBMRGX and TBMRGO, respectively (refer to subsection 4.1.2).

For Level 6/43 functionality the M1, M3, M4, and M5 registers are specified as shown below. M2, M6, M7 are reserved for future Level 6 functionality.

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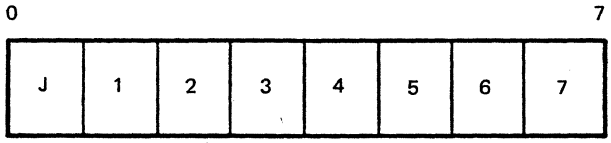
*These three indicators are controlled by micro-ops during the compare instructions and contain the result of the last compare operation executed. Typically, the comparison involves a register and a word from memory. The indicators show whether the register contents are greater than or less than the memory word.

- The NATSAP pointer register (M0) is a 16-bit data working register used in trap routines to point to the Next Available Trap Save Area Pointer (NATSAP). This pointer will contain one of four values, determined by software. The pointer is initialized by firmware to a value of 0010.

- M1 Register is the trap enable mode control register.



J - Trace Trap Enable Bit

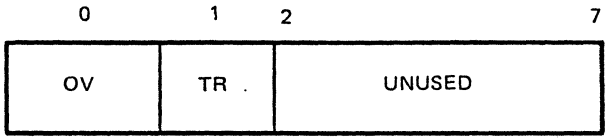
0 = disable
1 = enable

1-7 - Overflow Trap Control Bits

0 = disable
1 = enable

When the J-bit is enabled, all jumps and branches that are executed in a program cause a trap to the trace entry location. The seven overflow trap control bits are associated with the seven data registers R1 through R7. If overflow in any one of these occurs and the corresponding trap control bit is set, an overflow trap pending flip-flop is set causing a software trap to occur during a major branch on SWINT. The overflow trap pending flip-flop can also be tested with a test branch condition TBOVTP (RDDT 3:6 = 18 hexadecimal) and can be reset using the RESOVT (A-field = 0, 1; B-field = 7) micro-op.

- M3 Register contains the control information for the Commercial Instruction Processor (CIP).



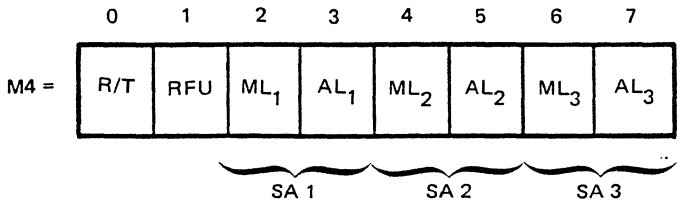
OV - Overflow Trap Mark

0 = disable
1 = enable

TR - Truncated Trap Mask

0 = disable
1 = enable

- M4 and M5 Registers: The M4 and M5 registers contain control information for the Scientific Instruction Processor (SIP). The bit fields are defined as follows:



where:

R/T - Round/Truncate Mode

0 = Truncate
1 = Round

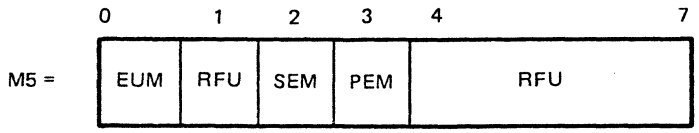
SA 1 - Scientific Accumulator 1
SA 2 - Scientific Accumulator 2
SA 3 - Scientific Accumulator 3

ML - Memory Length - Length of main memory data field associated with this SA

0 = Two Words
1 = Four Words

AL - Accumulator Length - Length of the value in the scientific accumulator.

0 = Two Words
1 = Four Words



EUM - Exponent Underflow Trap Mask

0 = Trap Disable
1 = Trap Enable

SEM - Significance Error Trap Mask

0 = Trap Disable
1 = Trap Enable

PEM - Precision Error Trap Mask

0 = Trap Disable
1 = Trap Enable

RFU - Reserved for Future Use - (Must be Zero)

3.4 CONTROL AREA

The control area (Figure 3-4) of the LSI-6 processor chip is logically divided into three areas:

1. Input latches for control
2. Testable registers
3. Next address generation

3.4.1 Input Latches for Control

There are three groups of latches that store information generated external to the chip, but used for internal control operations.

- ROS DATA REGISTER (RDDT 00-47): This is a 48-bit wide register which holds the firmware currently being executed. It is loaded from the external ROS during Phase A high.

- MONITOR REGISTER: This register holds 22 bits of system status. The system status bits listed below are dynamic in nature and are loaded during Phase A low. The bits marked with an asterisk will cause a hardware interrupt to occur, while the others are testable by firmware.

MEMPRES*	INTR0	STESTA
MEMPAR*	INTR1	STESTB
MEMRFSH*	INTR2	POWON
DTR0*	MTESTA00	MTESTB00
DTR1*	MTESTA01	MTESTB01
DTR2*	MTESTA02	MTESTB02
DTR3*	MTESTA03	MTESTB03
DTR4*		

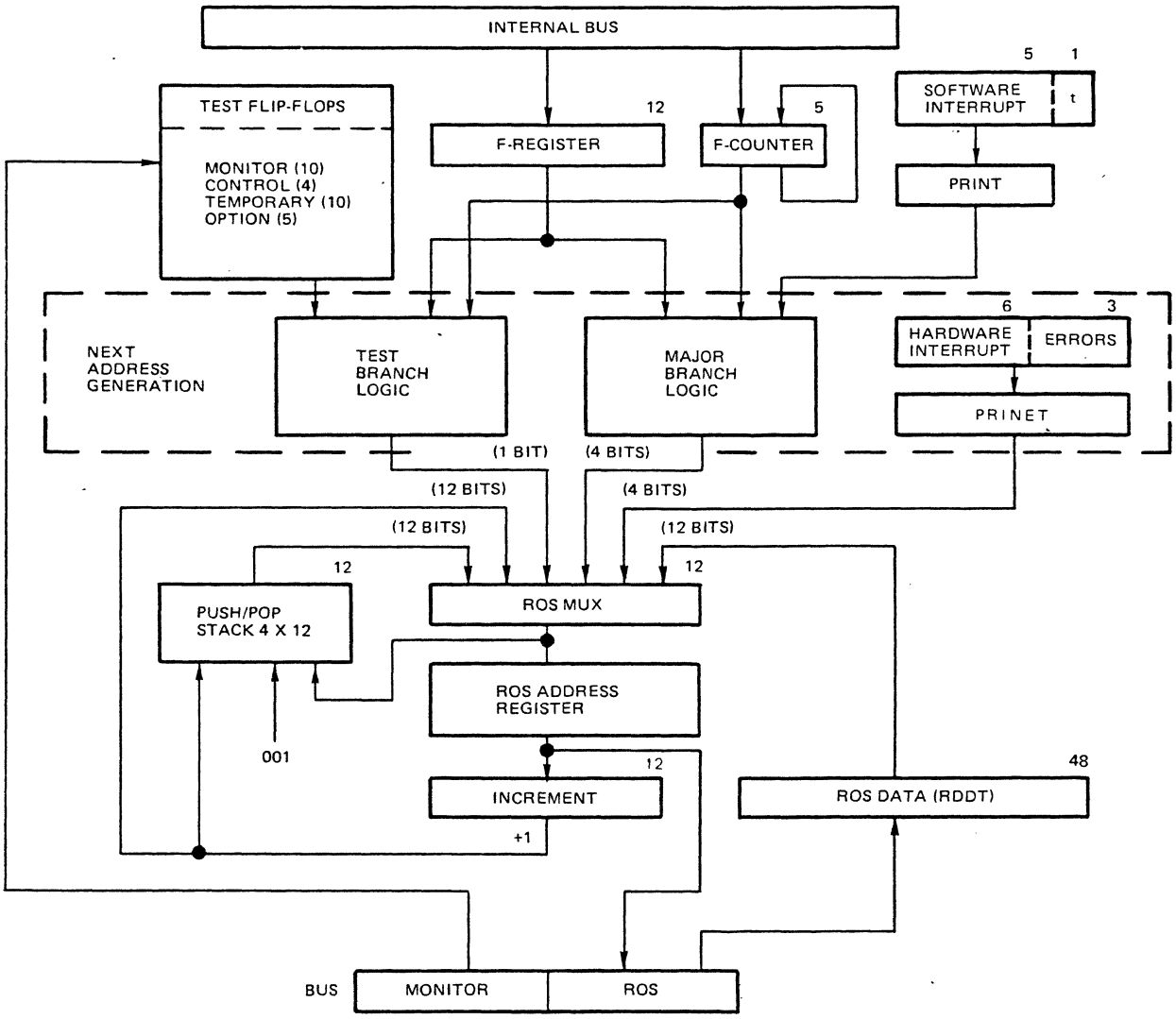


Figure 3-4. Control Major Block Diagram

- OPTION REGISTER: This register holds five bits which sample the status of the system options. These options should be thought of as static in nature. Option 0 (MMUE) and Option 3 (LAFE) are directly tied to control of certain hardware data paths and therefore their use is predetermined. All five option bits listed below are testable by firmware.

Option	Level 6 Function	Remarks
0	MMUE	Enables MMU
1	CIPE	Refer to subsection 2.2.2
2	SIPE	Refer to subsection 2.2.2
3	LAFE	Enables 20-bit address mode when active low. (Refer to subsection 2.2.3.)
4	MEMVAL	Refer to subsection 2.2.3

3.4.2 Testable Registers

The following registers are testable by firmware using test branch and major branch micro-ops.

- F-REGISTERS (F-Counter): The F-Register is a 16-bit instruction register, loaded from the internal bus. All bits are testable by firmware. The low-order four bits also constitute the low-order four bits of a 5-bit counter (FCNT). These five bits can be loaded from the internal bus (BI11 through BI15 to FCNT11 through FCNT15), incremented and decremented. The four low-order bits are also decoded such that a 16-bit mask can be placed on the internal bus (BI00 through BI15) under firmware control. FCNT11 is held at Zero for shift-short instructions; i.e., F-register = ONNN 0000 0XXX XXXX where NNN is not 000 and X is a "don't care."

- TICOS: This flip-flop is set whenever the leading or trailing edge of an external square wave, nominally 60 hertz, is detected. It is reset with firmware. The flip-flop is testable by firmware via the software interrupt Prinet.

- WDT: Whenever set, this flip-flop indicates that the Watchdog Timer (WDT) is ON. It is set and reset with the WDTN and WDTF instructions, respectively, and is testable by the firmware.

- RTC: Whenever set, this flip-flop indicates that the Real-Time Clock (RTC) is ON. It is set and reset with the RTCN and RTCF instructions, respectively, and is testable by the firmware.

- CONTROL FLIP-FLOPS 1-4: Four individual flip-flops are available to be set or reset or to have a bit transferred under firmware control. They are testable by the firmware.

- TEMPORARY FLIP-FLOPS: Ten temporary flip-flops exist (TF0 through TF9) which are loaded during each firmware cycle with the following bits: BI00, BI00 through BI15 = 0, Carry (16), Overflow (16), BI0D through BI15 = 0, Carry (20), Overflow (20), BI15, BI00 through BI11 = 0, and BI0D through BI0A = 0. In addition, there are two M-register temporary flip-flops (refer to subsection 3.3.8) and they are MREGBIT+00 and MDREG+00.

- OVERFLOW TRAP FLIP-FLOP: If an overflow occurs in any of the data registers R1 through R7 of the register file and the corresponding overflow trap bit in the M1 register (bits M1 through M7) is set, then the overflow trap pending flip-flop is set. This flip-flop can be tested by the test branch micro-op TBOVTP or by a software interrupt Prinet via the major branch micro-op MBSWIP. The overflow flip-flop is reset using the RESOVT micro-op.

3.4.3 Next Address Generation

The next address generation section is the essence of the control area as it contains the hardware necessary for sequencing the Read Only Storage (ROS). Below are listed the major hardware registers and/or networks included in the LSI-6 chip for next address generation.

- ROS ADDRESS REGISTER - RAR(00-11): This is a 12-bit register which contains the address for the external ROS. During Phase A high time, this contains the value of the current ROS data word. During Phase A low, it contains the address of the ROS for the next microcycle and will be driven out of the chip on the ROS address bus.

- ROS ADDRESS INCREMENTER: This is a 12-bit incrementer which will be used to source the Push/Pop stack during Push micro-op, and provide the next RAR value for INC and INCK micro-ops.

- PUSH/POP STACK: This is a 4 by 12 Last In First Out (LIFO) array used for subroutines and hardware interrupts. It is initialized to a hexadecimal value of 001 during clear time, and its bottom location is set to 001 for each POP (return micro-operation). A Push micro-operation causes the top of the stack to be sourced by the ROS address incrementer, and a hardware interrupt causes the top of the stack to be sourced by the input network to the RAR.

- TEST BRANCH MATRIX: There are 64 test conditions resulting in a two-way branch address to the RAR.

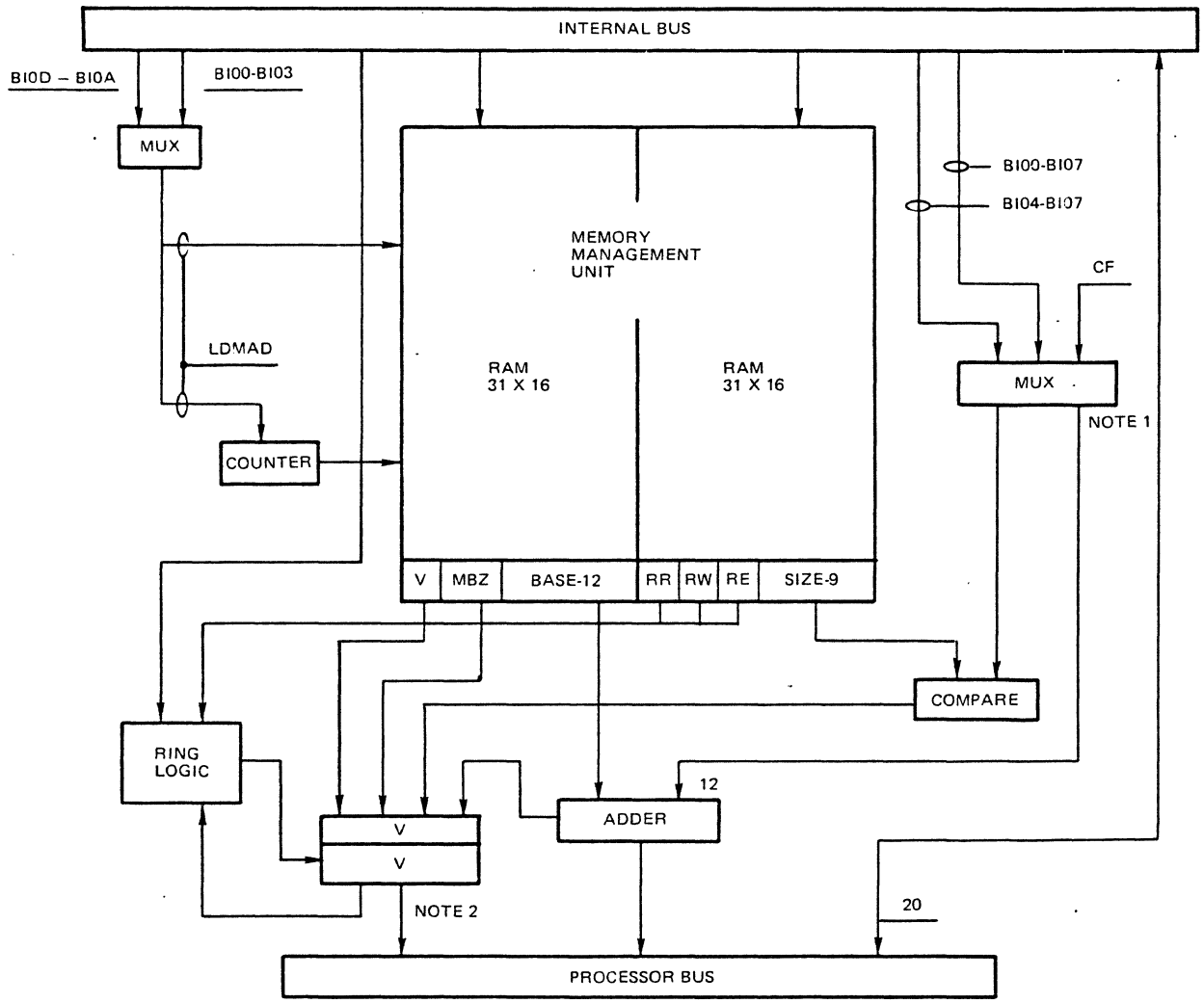
- MAJOR BRANCH MATRIX: There are 15 major branch test matrixes. The majority of the inputs to these matrixes are from the F-register (in various combinations). Other inputs are from monitor and option bits.

- HARDWARE INTERRUPT PRINET: There are 10 possible conditions that can cause a hardware interrupt. The hardware interrupt Prinet allows the prioritization and vector address generation for these conditions.

3.5 MEMORY MANAGEMENT UNIT

The Memory Management Unit (MMU) section of the LSI-6 (Figure 3-5) is composed primarily of (1) a register file (31 by 32) for holding an array of memory segment descriptors, (2) a 12-bit address for base relocation, (3) a 9-bit comparator for checking the size of a memory segment, (4) several 2-bit ring comparators for evaluating access rights to a given segment, and (5) storage flip-flops for indicating potential memory violations. For a detailed description of the MMU, refer to the Memory Management Unit manual, Order No. FN34-02 and Honeywell EPS-1, 60130079.

The MMU of the LSI-6 has the equivalent functionality of the Model 43 in the Level 6 family. The MMU is an optional feature of the LSI-6 which is activated by MEMPAR-P0 being held active low during Phase A high time (Option 0). Activation of the option (MMUE or Option 0) signifies the firmware exists in the ROS external to the chip to support this feature (Validate, Activate Segment Descriptor Instructions). Should this firmware not be installed, the MEMPAR-P0 lines should be driven high during Phase A high time to ensure deactivation of this feature, otherwise unspecified results can occur.



NOTES

1. THE LIMITED ACCESS CHECK EQUALS THE RANGE CHECK FOR VALIDATE, CIP, AND SIP INSTRUCTIONS.
2. HIGH-ORDER MEMORY ADDRESS BIT 21 (MEMKIL) IS SAMPLED BY ALL MEMORIES AND WILL PREVENT MEMORY ACCESS WHEN TRUE.

Figure 3-5. Memory Management Unit Block Diagram

3.5.1 MMU Theory of Operation

During any main memory address cycle (assuming the address is generated on chip), the BI is continually sampled by the MMU hardware. The address on the BI can be thought of as a logical address (as opposed to a physical memory address) containing a segment number, a block number, and an offset value. The MMU extracts the segment number for use in addressing its register file (containing segment descriptors for all possible segments). The proper descriptor is read from that addressed location. Next, the block number is extracted from the BI and added to a base (12 bits) value containing in the descriptor (effectively relocating the logical address). The block number is also checked against the size field of the segment descriptor. Depending upon the type of memory operation (read, write, or execute), the effective ring number is compared against one of three ring numbers contained in the segment descriptor. Precluding any violations, the output of the relocation adder is concatenated with the offset bits of the BI and delivered to the processor bus as a physical memory address.

3.5.2 MMU Hardware

- MMU REGISTER FILE ADDRESSING: The MMU register file addressing can be accomplished by two methods. The first is during normal main memory address cycles. The contents of the internal bus bits BI0D through BI0A and BI00 through BI03 are used to generate an address and load it in the MMU address latch during the trailing edge of Phase A. This latched address is then used to address the register file array.

  The second is via the MMU address register. The MMU address register is loaded with the contents of the internal bus bits BI0D through BI0A and BI00 through BI03 during the leading edge of Phase A using the LDMAD micro-op (refer to subsection 4.8.2). The contents of the MMU address register is then used to address the register file array. The second method can only be used to address the register file array during operations that read or write the register file array data (WMBS, WMSZ, BIFMMUH, and BIFMMUL) or during limited read/write access checks using LRA and LWA micro-ops.

  The MMU address generation for either of the methods described above is accomplished in the following manner. If BI0D through BI0A equals Zero, then the four least significant bits of either the MMU address latch or the MMU address register (determined by LDMAD) is loaded with the contents of BI00 through BI03 and the high-order bit (5) of either the latch or register is set to a Zero indicating a small segment. If BI0D through BI0A does not equal zero, then the four least significant bits of either the latch or register (determined by LDMAD) is loaded with

the contents of BI0D through BI0A and the high-order bit (5) of either the latch or register is set to a One indicating a large segment.

When addressing the MMU using the second method, the MMU address register is incremented when either a WMSZ or BIFMMUL micro-op is used in the firmware word. The increment occurs at the leading edge of Phase A.

- MMU DESCRIPTOR ARRAY: A 31 by 32 register file contains segment descriptors for memory management. Locations 0 to 15 are used to describe small memory segments 0 to 15, each containing a maximum of 4K words of memory. Locations 17 to 31 describe 15 large segments each containing up to 64K maximum. Total address space is one megaword. The array is organized as follows:

	0	1 3	4 15	16 17	18 19	20 21	22 23	31
0	V	MBZ	BASE	RR	RW	RE	MBZ	SIZE
15								
*17								
31								

V - Validity bit; if this bit is a Zero, the segment is undefined.

MBZ - Must be all Zeros

BASE - 12-bit base address.

RR - Read ring value.

RW - Write ring value.

RE - Execute ring value.

SIZE - This 9-bit field defines the size of the memory segment 256-word blocks.

The array is loaded from the internal bus as two 16-bit words (BI00 through BI15 to MMURF00 through MMURF15 and BI00 through BI15 to MMURF16 through MMURF31). Likewise, the array can be read for test purposes (MMURF00 through MMURF15 to BI00 through BI15 and MMURF16 through MMURF31 to BI00 through BI15.

*Address location 16 does not exist as a physical entry in the array.

- MMU LATCHES: Two latches are provided to hold the processor's current ring number, and two for the effective ring number. The former is loaded from the internal bus (BI01 and BI02) while the latter is either a copy of the current ring, a copy of the write ring of the accessed segment descriptor, or set to Ones by the firmware.

- MMU FLIP-FLOPS 1-4: The MMU flip-flops, controlled by the MMU field (bits 31 through 33) of the ROS word, store MMU error conditions.

  - MMU FLIP-FLOP 1 AND 3 indicate a nonexistent resource violation (i.e., the address accesses a memory location which is not within allowable bounds), or the segment descriptor is undefined. When set, this will cause an immediate hardware trap unless the next firmware word contains a Clear Memory Error (CME) micro-op. MMU flip-flop 3 indicates the same function, but is testable by the firmware. It will not cause a hardware interrupt.

  - MMU FLIP-FLOP 2 AND 4 indicate an access violation; i.e., the processor does not have read, write or execute permission for the memory location addressed. This will cause an immediate hardware trap unless the next firmware word contains a Clear Memory Error (CME) micro-op. MMU flip-flop 4 indicates the same function, but is testable by the firmware. It will not cause a hardware interrupt.

- MMU ADDER: This is a 12-bit adder used to add the block number (from BI) to the base value contained in bits 4 through 15 of the MMURF . The output of this adder sources DABS (0D through 0A, 00 through 07) of the processor bus under control of the bus control field.

- MMU BLOCK COMPARATOR: This is a 9-bit comparator which is used to check the block number from BI against bits 23 through 31 of the MMURF for a size violation. This violation causes setting of MMU flip-flop 1 or 3 as noted above.

Section 4
FIRMWARE FORMAT AND DESCRIPTION

The LSI-6 has a 48-bit firmware word (RDDT00 through RDDT47) which is used to define up to 12 simultaneous operations or sub-commands within a given microcycle. Figure 4-1 illustrates the coded fields within the ROS data word (firmware word) and Table 4-1 defines the coded fields.

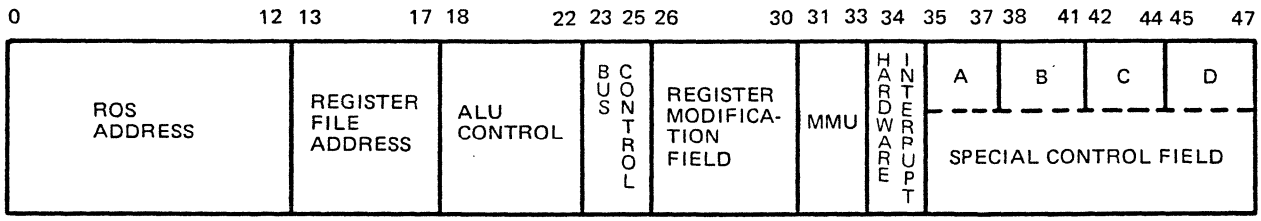


Figure 4-1. ROS Firmware Word Fields

Table 4-1. ROS Data Field Description

Coded Fields	Description
ROS Address (RDDT00 through RDDT12)	(13-bit field) defines or describes the method for generating the next ROS address to be used in a given sequence.
Register File Address (RDDT13 through RDDT17)	(5-bit field) defines or describes the method for generating the register file address to be used during the present microcycle (firmware step).
ALU Control (RDDT18 through RDDT22)	(5-bit field) defines the ALU operations as well as specifying the sources of the inputs to the ALU during the present microcycle.
Bus Control (RDDT23 through RDDT25)	(3-bit field) defines the input/output operations of the memory (I/O) address/data bus during the present microcycle.
Register Modification Field (RDDT26 through RDDT30)	Bit-26 controls the write operation of the register file during the current microcycle. Bit 27 controls the loading of the Q-register during the current microcycle. Bits 28 through 30 define the operation to be performed on one of three registers (F-counter, P-counter, or G-register) during the current microcycle.
MMU (RDDT31 through RDDT33)	(3-bit field) defines the operation to be performed by the MMU during the present microcycle.
Hardware Interrupt (RDDT34)	(1-bit field) is used to prevent a memory refresh or data transfer request from interrupting the predetermined sequence between the present microcycle and the next microcycle (firmware step) as defined in ROS bits 0 through 12 (ROS address field) of the present firmware word.
Special Control Field (RDDT35 through RDDT47)	(13-bit field) is divided into four subfields (A, B, C, and D). The special control field is used to modify as well as supplement certain of the fields mentioned above. It can provide as many as three simultaneous operations or subcommands during the present microcycle.

4.1 ROS ADDRESS FIELD

The ROS address field contains 13 bits (RDDT00 through RDDT12) and is used to generate the address of the next firmware step in a given sequence. The method for generating this address is defined by the first five bits of this field as shown below.

RDDT Bits 0 1 2 3 4	Operation
1 X X X X	Jump
0 1 X X X	Test Branch
0 0 1 X X	Major Branch
0 0 0 1 X	Increment With Constant
0 0 0 0 1	Increment Without Constant
0 0 0 0 0	Return (Pop stack)

A Push operation can be used in conjunction with any of the first five operations listed above. This has the effect of calling a subroutine, from which it is expected the microprogrammer will wish to return (Pop stack) to the present ROS address plus One (RAR+1).

To facilitate this operation, the LSI-6 chip has built in hardware which allows the Push subcommand, when initiated, to push the contents of the present ROS address register incremented by One on top of the Push/Pop stack (see Figure 3-4). The Return (Pop stack) operation is then used in the last firmware step of the called subroutine to return to the caller's sequence.

One exception to the next address generation being defined by the above six operations is the hardware interrupt. When a hardware interrupt is initiated, the next ROS address will be provided as a hardware vector and the ROS address generated by the ROS address field of the present firmware word will be placed on top of the Push/Pop stack. If a Push subcommand (special control field) is used in conjunction with one of the first five operations shown above, then the microprogrammer must also initiate the hardware interrupt inhibit field (RDDT bit 34) in order to prevent conflicting Push operations. Since the hardware interrupt can be initiated (normally an external event) at any time prior to completion of a given firmware sequence, special consideration must be given to allow its use.

The branching capabilities of the six operations are referred to as page branching and bank branching. A page is defined as 64 consecutive memory locations, and a bank is defined as 1024 memory locations or 16 pages. As shown in Figure 4-2 the branch boundaries for the Test Branch operation is restricted to any location within a page. The branch boundaries for the major branch is restricted to any location within a bank. The remaining four operations are capable of branching or incrementing from one bank to another.

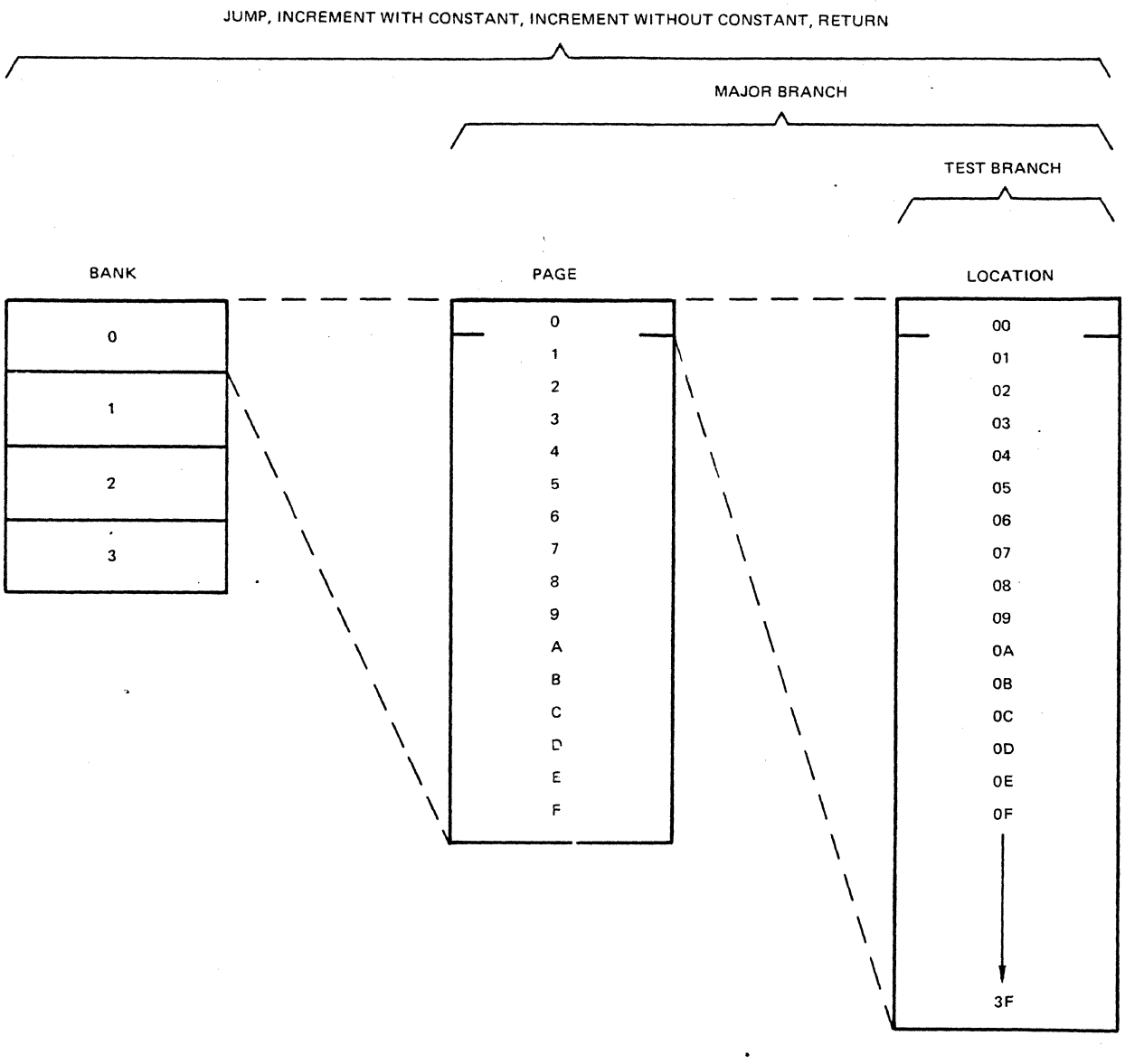
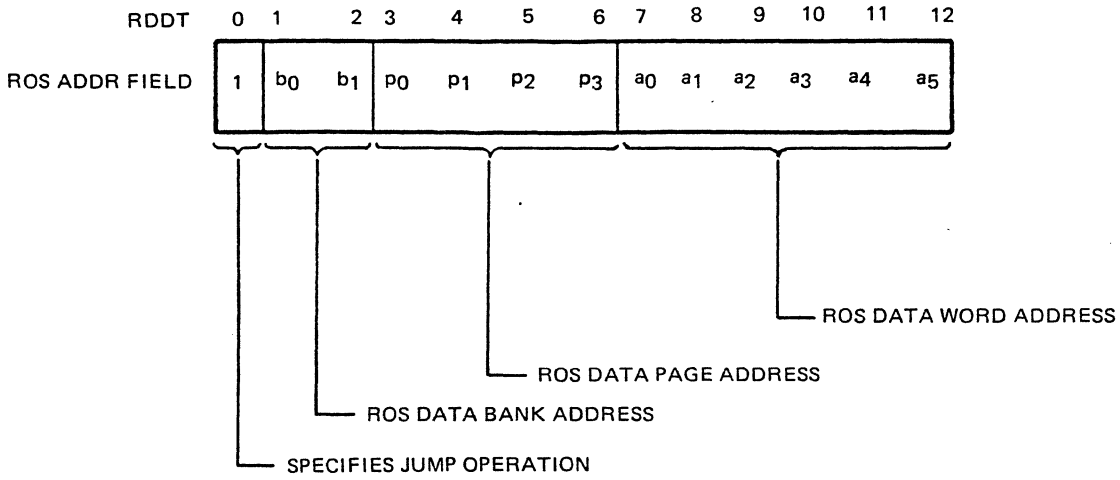


Figure 4-2. Firmware Instruction Branch Boundaries

4.1.1 Jump

The Jump operation is the only next address generation method that allows a branch to any of the possible 4096 locations of the ROS. This is accomplished by providing, within the ROS address field, a 12-bit direct address of the next firmware step in sequence.

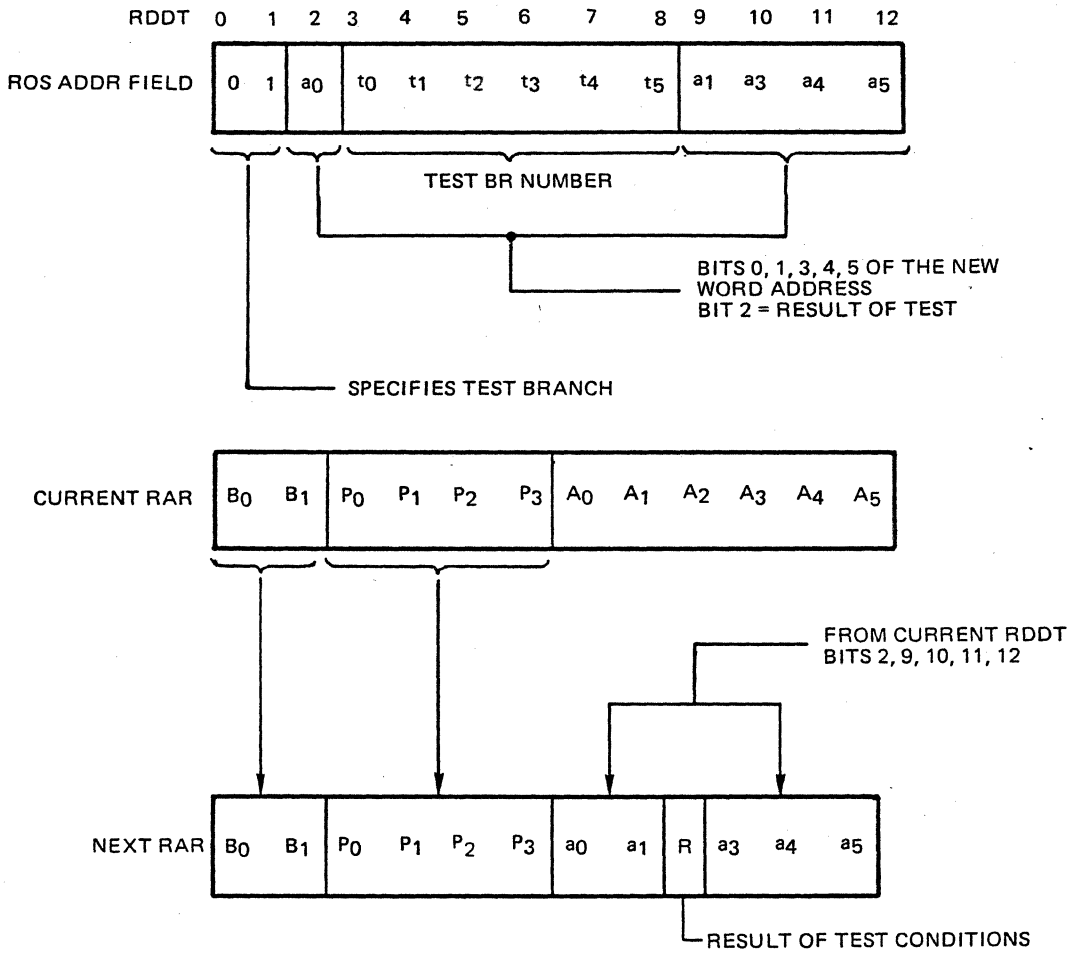


When RDDT bit 0 equals a One, RDDT bits 1 through 12 of the present ROS data word (firmware word) are delivered directly to the ROS address register (bits 0 through 11) as the next address in sequence, assuming of course, no intervening hardware interrupt. Should a hardware interrupt occur, this next address would be pushed on top of the Push/Pop stack and the generated hardware vector will replace it as the contents of the next RAR.

A Push operation (special control field) can be used along with the Jump operation. Hardware interrupt bit RDDT34 will be inhibited when the Push micro-op is used. The current RAR+1 will be pushed on top of Push/Pop stack.

4.1.2 Test Branch

The Test Branch operation is a two-way branch using the result of one of 64 test conditions specified as part of the ROS address field (t_0-t_5). All test branches are restricted to branching within the current page, that is, the next ROS address generated as a result of the test will always be one of two locations (depending on result of test; i.e., true or false) eight locations apart, but within the page (64 locations) currently being addressed by the ROS Address Register (RAR).



The next RAR shown above contains the next address generated as a result of the test branch as specified in bits 0 through 13 of the current firmware word assuming no intervening hardware interrupt. Should a hardware interrupt occur, this address is placed on the top of the Push/Pop stack and the generated hardware vector replaces it as the contents of the next RAR.

The Push operation (special control field) can be used along with Test Branch operations. Hardware interrupts should be inhibited (RDDT bit 34) in this case. The current RAR+1 will be placed on top of the Push/Pop stack.

The Test Branch instruction is categorized into nine groups for the purpose of discussion only. Each group contains related branch conditions that can be tested with the Test Branch instruction.

The following groups define each test branch category and the test conditions associated with each group. Refer to Tables 4-2 and 4-3 for a combined list of Test Branch instruction sets.

- Group 1--Single Bit F-Register Test Branch

  The single bit F-register test branch group pertains to branch operations that can be performed by testing any one of 16 F-register bits. The format for the single bit F-register test branch is shown below.

F-Register Bit	Test Condition Code RDDT03 Through RDDT08	
FR00	TBFR00	(00)
FR01	TBFR01	(10)
FR02	TBFR02	(20)
FR03	TBFR03	(30)
FR04	TBFR04	(01)
FR05	TBFR05	(11)
FR06	TBFR06	(21)
FR07	TBFR07	(31)
FR08	TBFR08	(02)
FR09	TBFR09	(12)
FR10	TBFR10	(22)
FR11	TBFR11	(32)
FR12	TBFR12	(03)
FR13	TBFR13	(13)
FR14	TBFR14	(23)
FR15	TBFR15	(33)

  The F-register is a 16-bit instruction register that is loaded from the internal bus (BI). All bits are testable, and the low-order four bits (FR11 through FR15) also constitute the low-order four bits of a 5-bit counter called the F-counter (FNCT). These five bits can be loaded, incremented, or decremented independently when specified by the destination field (RDDT28 through RDDT30) of the firmware word. The four low-order bits of the F-counter are also decoded such that a 16-bit mask can be placed onto the internal bus (BI00 through BI15) under firmware control.

- Group 2--Grouped F-Register Test Branch

  The grouped F-register test branch group pertains to branch operations that can be performed by testing specified combinations of F-register bits. The format for the grouped F-register test branch is shown below.

F-Register Bit	Test Condition Code RDDT03 Through RDDT08	
FR12 through FR15 = 0000	TFBR3Z	(0C)
FR01 through FR03 = 000	TFBFIT3Z	(1C)
FR01 through FR03 = 111	TFBFIT37	(2C)
FR11 through FR15 = 0 (F-Counter)	TFBFTZ	(37)

- Group 3--Control Flip-Flop Test Branch

  The control flip-flop test branch group consists of four individual control flip-flops that can be set, reset, or loaded under firmware control. The format of the control flip-flop test branch is shown below.

Control Flip-Flop	Test Condition Code RDDT03 Through RDDT08	
Control Flip-Flop 1	TBCF1	(0F)
Control Flip-Flop 2	TBCF2	(1F)
Control Flip-Flop 3	TBCF3	(2F)
Control Flip-Flop 4	TBCF4	(3F)

- Group 4--MMU Flip-Flop Test Branch

  The MMU flip-flop test branch group consists of two Memory Management Unit (MMU) error conditions that are testable by firmware. There are two other MMU flip-flops (MMU flip-flops 1 and 2) that are available but not testable by firmware.

  MMU flip-flops 1 and 3 indicate a nonexistent resource violation occurred or that the segment descriptor is undefined. When set, these flip-flops cause an immediate hardware trap (TV15). MMU flip-flop 3 is testable with the Test Branch instruction.

  MMU flip-flops 2 and 4 indicate an access violation and cause an immediate hardware trap (TV14). MMU flip-flop 4 is testable with the Test Branch instruction.

  The format for the MMU Flip-Flop Test Branch is shown below.

MMU Flip-Flop	Test Condition Code RDDT03 Through RDDT08	
MMU Flip-Flop 3	101110	(2E)
MMU Flip-Flop 4	111110	(3E)

- Group 5--M-, I-, Q-, and S-Register Test Branch

The M-, I-, Q-, and S-register test branch group consists of selectable hardware register bits that are testable by firmware.

There are two I-register tests that can be performed by the Test Branch instruction. The first test is with I-register bit 2 which is the carry indicator bit. This bit is set when the logical capacity of a register is exceeded. The second test is with I-register bit 3 which is the bit test indicator. This bit reflects the state of the last bit tested.

A Q-register test is performed by the test branch which tests Q-register bit 15. The Q-register, a 16-bit register, handles operand shifts and holds secondary operands for the ALU.

An S-register test is performed by the test branch which tests the most significant bit of the current ring number of the MMU to determine whether the system is in Privilege mode. The current ring number is a duplicate of S-register bits 1 and 2 loaded under control of the LDMURG micro-op.

The format for the above mentioned register test branches are shown below.

Register Bit	Test Condition Code RDDT03 Through RDDT08	
IR2 (C-Bit)	TBIRGC	(2D)
IR3 (B-Bit)	TBIRGB	(3D)
QR15	TBQ15	(27)
SR01	TBSRG1	(3C)

- Group 6--Temporary Flip-Flop Test Branch

The temporary flip-flop test branch group can test 10 temporary flip-flops (TF00 through TF09) and two M-register temporary flip-flops which are loaded during each firmware cycle. Since these conditions exist for just one firmware cycle, it is required that hardware interrupts be inhibited between the microcycle being tested and the microcycle performing the test branch. Each flip-flop represents a hardware condition described in the chart below.

There are two M-register tests that can be performed by the Test Branch instruction. The first test branches on the state of M-register bit 0 at the time of the test branch operation. The second test branches on M-register bit X, where X equals the value of F-register bits 1 through 3 at the time of the test branch operation. If the value of X equals zero, the test branch is inhibited.

Temporary Flip-Flop	Representation	Test Condition Code RDDT03 Through RDDT08	
TF0	BI00	TBBI00	(28)
TF1	BI00-BI15 = 0	TBBI16Z	(09)
TF2	CARRY(16) = 1	TBCY16	(19)
TF3	OVERFLOW(16)	TBOV16	(2B)
TF4	BI0D=BI15 = 0	TBBI20Z	(0B)
TF5	CARRY(20) = 1	TBCY20	(1B)
TF6	OVERFLOW(20)	TBOV20	(3B)
TF7	BI15	TBBI15	(38)
TF8	BI00-BI11 = 0	TBBI12Z	(08)
TF9	BI0D-BI0A = 0	TBBIDTA2	(0A)
MRO		TBMRG0	(0D)
MRX		TBMRGX	(1D)

- Group 7--External Conditions Test Branch

The external conditions test branch group consists of conditions testable by firmware. Eight of the ten conditions (MTESTA00 through MTESTA03 and MTESTB00 through MTESTB03) can also be tested with the Major Branch instruction. The format for the external conditions test branch is shown below.

External Condition	Test Code Condition RDDT03 Through RDDT08	
MTESTA00	TBMTA0	(04)
MTESTA01	TBMTA1	(14)
MTESTA02	TBMTA2	(24)
MTESTA03	TBMTA3	(34)
MTESTB00	TBMTB0	(05)
MTESTB01	TBMTB1	(15)
MTESTB02	TBMTB2	(25)
MTESTB03	TBMTB3	(35)
STESTA00	TBSTA0	(26)
STESTB00	TBSTB0	(36)

- Group 8--Software Conditions Test Branch

The software conditions test branch group tests external conditions that are set and reset via software and is testable by firmware. The format for the software conditions test branch is shown below.

Software Condition	Test Condition Code RDDT03 Through RDDT08	
RTC	TBRTC	(0E)
WDT	TBWDT	(1E)
TICOS	TBMTCK	(07)
INT PENDING	TBINTP	(06)
PIOVFTP	TBOVTP	(18)

- Group 9--Options Test Branch

The options test branch group can test any one of five options that may be present with the system. The format for the options test branch is shown below.

Option	Test Condition Code RDDT03 Through RDDT08	
MMUE	TBMMU	(2A)
CIPE	TBCIP	(17)
SIPE	TBSIP	(16)
LAFE	TBLAF	(1A)
MEMVAL	TBOP4	(3A)

Table 4-2. Test Branch Test Condition Codes

Code Number	Mnemonic	Nomenclature	Code Number	Mnemonic	Nomenclature
00	TBFR00	F-register bit 00	20	TBFR02	F-register bit 02
01	TBFR04	F-register bit 04	21	TBFR06	F-register bit 06
02	TBFR08	F-register bit 08	22	TBFR10	F-register bit 10
03	TBFR12	F-register bit 12	23	TBFR14	F-register bit 14
04	TBMTA0[a]	MTESTA00[a]	24	TBMTA2	MTESTA02[a]
05	TBMTB0	MTESTB00[a]	25	TBMTB2	MTESTB02[a]
06	TBINTP	Interrupt pending	26	TBSTA0	STESTA00[a]
07	TBMTCK	Missed TICOS	27	TBQ15	Q-register bit 15
08	TBBI12Z	BI00-BI11 = 0 (TF8)	28	TBBI00	BI00 (TF0)
09	TBBI16Z	BI00-BI15 = 0 (TF1)	29	-	BI00-BI15 = 0 (Test only)
0A	TBBIDTAZ	BI0D-BI0A = 0 (TF9)	2A	TBMMU	Option 0-MMUE
0B	TBBI20Z	BI0D-BI15 = 0 (TF4)	2B	TBOV16	Overflow 16 (TF3)
0C	TBFR3Z	F-register bits 12-15 = 0	2C	TBFIT37	F-register bits 1-3 = 7
0D	TBMPC0	M-register bit 0	2D	TBIRGC	I-register bit 2 (C-bit)
0E	TBRTC	Real-time clock on	2E	TBMMU3	MMU flip-flop 3
0F	TBCF1	Control flip-flop 1	2F	TBCF3	Control flip-flop 3
10	TBFR01	F-register bit 01	30	TBFR03	F-register bit 03
11	TBF05	F-register bit 05	31	TBFR07	F-register bit 07
12	TBFR09	F-register bit 09	32	TBFR11	F-register bit 11
13	TBFR13	F-register bit 13	33	TBFR15	F-register bit 15
14	TBMTA1	MTESTA01[a]	34	TBMTA3	MTESTA03[a]
15	TBMTB1	MTESTB01[a]	35	TBMTB3	MTESTB03[a]
16	TBSIP	Option 2 - SIPE	36	TBSTB0	STESTB00[a]
17	TBCIP	Option 1 - CIPE	37	TBFTZ	F-counter = 0 (FR11-FR15)
18	TBOVTP	ALU overflow trap pending	38	TBBI15	BI15 (TF7)
19	TBCY16	Carry 16 = 1 (TF2)	39	-	Carry 16 = 1 (Test only)
1A	TBLAF	Option 3 - LAFE	3A	TBOP4	Option 4 - Memory Valid
1B	TBCY20	Carry 20 = 1 (TF5)	3B	TBOV20	Overflow 20 (TF6)
1C	TBFIT3Z	F-register bits 1-3 = 0	3C	TBSRG1	S-register bit 1 (Privilege Mode)
1D	TBMRGX	M-register bit X	3D	TBIRGB	I-register bit (B-bit)
1E	TBWDT	Watchdog timer on	3E	TBMMU4	MMU flip-flop 4
1F	TBCF2	Control flip-flop 2	3F	TBCF4	Control flip-flop 4

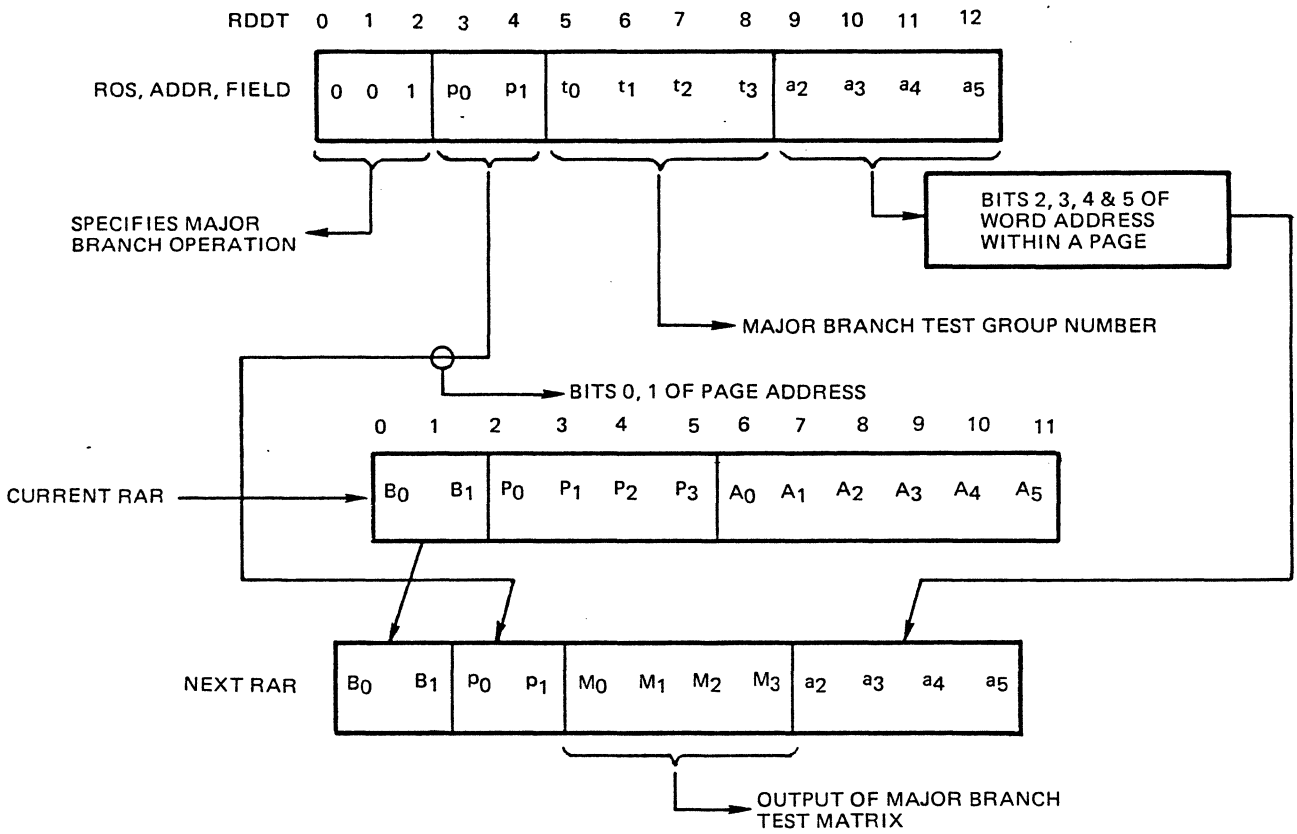
[a]Refer to Table 4-3 for Level 6 equivalent nomenclature.

Table 4-3. LSI-6/Level 6 Nomenclature

Code Number	Mnemonic	LSI-6 Nomenclature	Level 6 Nomenclature
04	TBMTA0	MTESTA00	PROCEED-IN
14	TBMTA1	MTESTA01	BUSY-IN
24	TBMTA2	MTESTA02	BYTE-IN
34	TBMTA3	MTESTA03	OBC-IN
05	TBMTB0	MTESTB00	MIBGPO
15	TBMTB1	MTESTB01	MIBGP1
25	TMBTB2	MTESTB02	MIBGP2
35	TBMTB3	MTESTB03	MIBGP3
26	TBSTA0	STESTA00	MPLOCK
36	TBSTB0	STESTB00	TESTBR1

4.1.3 Major Branch

The major branch is a 16-way branch using the result of 15 test groups specified as part of the ROS Address Field (t_{ϕ}-t_3). All major branches are restricted to branching within the current bank (1024 locations). That is, the next ROS address generated as a result of the major branch test will always be one of 16 locations (depending on output of Major Branch matrix) 16 locations apart, but within the bank (1024 locations) currently being addressed by the ROS Address Register (RAR).



The next RAR shown above receives the next address generated as a result of the major branch as specified in bits 0 through 12 of the current firmware word assuming no intervening hardware interrupt. Should a hardware interrupt occur, this newly generated address will be placed on top of the Push/Pop stack and the generated hardware interrupt vector replaces it as the contents of the next RAR.

The Push operation (special control field) can be used along with Major Branch operations. Hardware interrupts should be inhibited (RDDT bit 34) in this case. The current RAR+1 will be placed on top of the Push/Pop stack.

The major branch is divided into two test groupings. Major branch test groups 0 through 7 are for general use where major branch test groups 8 through E are specifically dedicated to the implementation of Honeywell Level 6 functionality. RDDT bits 5 through 8 (t_ϕ through t_3) equal to a hexadecimal F is not used.

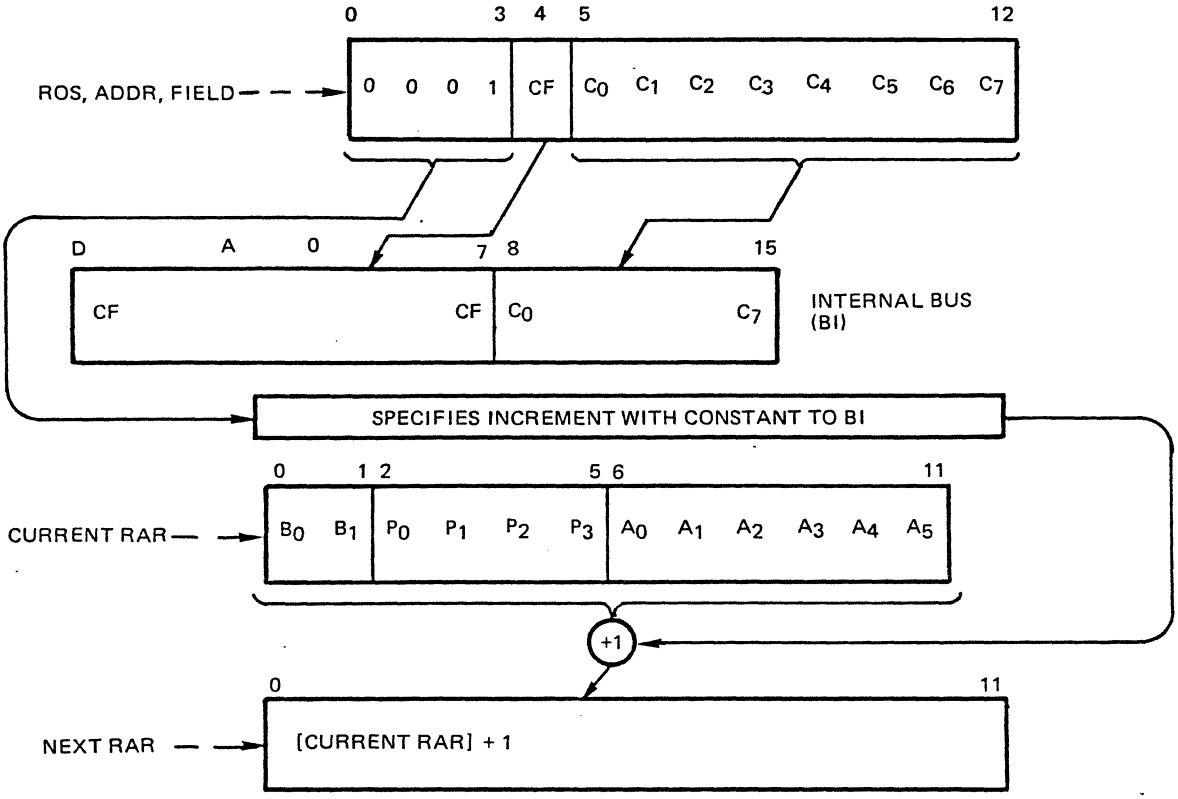
Table 4-4 lists the 16 major branch test condition codes. For detailed information of the major branch test condition codes, refer to Appendix A.

Table 4-4. Major Branch Test Condition Codes

Code Number	Mnemonic	Description
00	MBFR0	FR0 (F-register bits 0-3)
01	MBFR1	FR1 (F-register bits 4-7)
02	MBFR2	FR2 (F-register bits 8-11)
03	MBFR3	FR3 (F-register bits 12-15)
04	MBTESTA	MTESTA00-MTESTA03
05	MBTESTB	MTESTB00-MTESTB03
06	MBSWIP	Software INT Prinet
07	MBMULT	0, 0, Q14, FT=0
08	MBFMT	Instruction format
09	MBOP	D0/S0 instruction group
0A	MBINX	D0/S0 index group
0B	MBGEN	Generic instruction
0C	MBADRS	Address syllable
0D	MBCIP	Data description address syllable
0E	MBBRCH	0, P Branch, F9TEZ, FR15
0F	------	Not used

4.1.4 Increment With Constant to BI

The increment with constant to BI operation as specified in the ROS address field (bits 0 through 3 of the 13-bit field) of the current firmware word causes the current value of the ROS address register, incremented by One, to be placed into the ROS address register for the next microcycle. In addition to this next address generation, the remaining nine bits (RDDT bits 4 through 12) are used to generate an 8-bit constant plus a filler to the BI during the current microcycle (see format below).

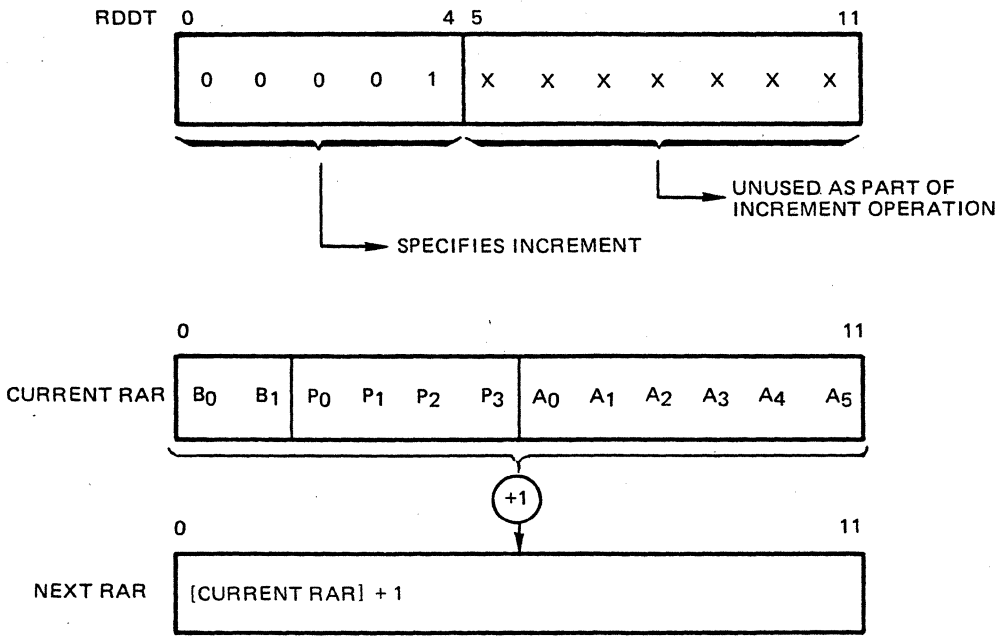


The next RAR shown above receives the current RAR contents plus One as specified by the increment with constant to BI operation in RDDT bits 0 through 3 of the current firmware word assuming no intervening hardware interrupt. Should a hardware interrupt occur, this newly generated next address will be placed on the top of the Push/Pop stack and the generated hardware interrupt vector will replace it as the contents of the next RAR.

The Push operation (special control field) can be used along with Increment operations. Interrupts should be inhibited (RDDT bit 34) when using a Push operation. The current RAR+1 will be placed on top of the Push/Pop stack, in addition to becoming the next value of RAR.

4.1.5 Increment

The Increment operation as specified in the ROS address field initiates the same operation as that in subsection 4.1.4 with the exception that no constant is generated to the BI.

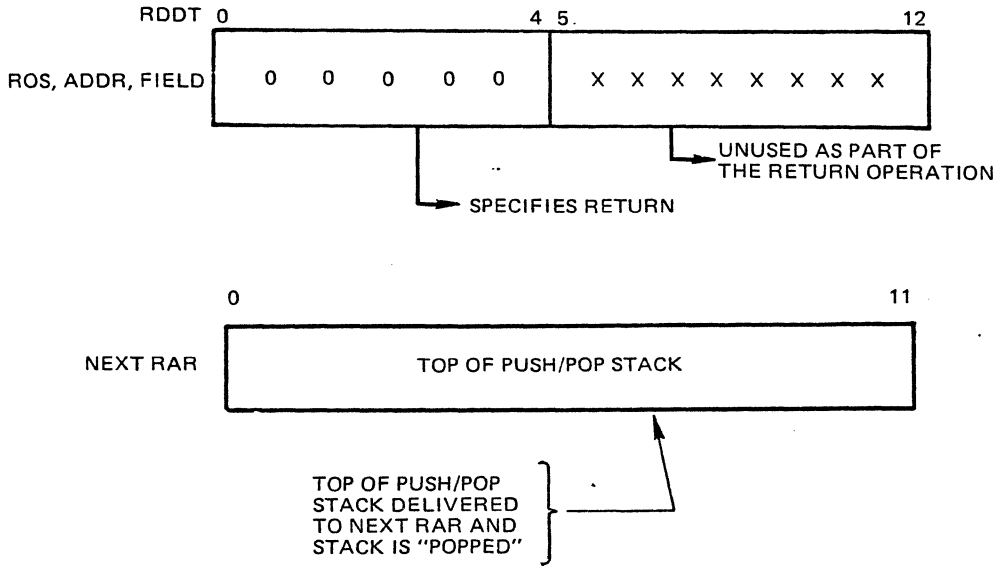


The next RAR shown above receives the current RAR contents plus One assuming no intervening hardware interrupt. Should a hardware interrupt occur, the newly generated next address (RAR+1) will be placed on top of the Push/Pop stack and the generated hardware vector replaces it as the contents of the next RAR.

The Push operation (special control field) can be used with the Increment operation. Hardware interrupts should be inhibited (RDDT bit 34) when using the Push operation. When the Push operation is used in conjunction with the Increment operation, the next RAR and the top of the Push/Pop stack receives the same value for the next microcycle ROS address (e.g., the contents of the current RAR incremented by One [RAR+1]).

4.1.6 Return (Pop Stack)

The Return or Pop Stack operation causes the contents of the top of the Push/Pop stack to be used as the ROS address for the next microcycle (i.e., next RAR contents).



The next RAR shown above receives the current contents of the top of the Push/Pop stack and the stack is "popped" as specified by the Return (Pop stack) operation in RDDT bits 0 through 4 of the current firmware word, assuming no intervening hardware interrupt. Should a hardware interrupt occur, the Return or Pop operation will effectively be bypassed, or canceled. This is of no consequence, since any programmed interrupt sequence (such as Memory Refresh, Data Transfer, etc.) has a Return as its last steps in its microprogramming sequence.

The Push operation (special control field) must not be used with the Return operation, as the results are unspecified.

4.2 REGISTER FILE ADDRESS GENERATION

The LSI-6 has a 32-location register file (see Figure 3-3). Location 00 through 07 and 10 through 17 are 16-bit registers and are primarily used for storage of data, whereas locations 08 through 0F and 18 through 1F are 20-bit registers and are primarily used for storage of main memory addresses.

Fourteen of the first sixteen locations are designated as data and base address registers for use by Honeywell Level 6 software. They are R1 through R7 (locations 01 through 07) and B1 through B7 (locations 09 through 0F). These registers normally will be addressed implicitly using designated bit fields of the F-register (software instruction register) under control of the register file address field (RDDT bits 13 through 17). The facility explicitly addressing these locations exists, using a constant obtained from RDDT bits 9 through 12 of the current firmware word under control of the register file address field.

Note that since RDDT bits 9 through 12 are part of the ROS address field of the current firmware word, it is recommended that this type of explicit addressing be restricted to increment or return (Pop stack) type of next ROS address generation as designated by the ROS address field. It is during these two operations that RDDT bits 9 through 12 are normally not used. However, the hardware implementation does not restrict the microprogrammer from using RDDT bits 9 through 12 as an address constant during any of the next ROS address generations that may be specified in the ROS address field.

Other Level 6 software registers such as the S, RDBR and T (locations 10, 1E, and 1F, respectively), although implicitly designated in certain Level 6 instructions, are explicitly addressed by the register file address field.

All other registers in the register file can be considered as working registers, although some are dedicated to the operation of the Level 6 functionality. These registers are, in general, explicitly addressed by the register file address field of the current firmware word.

Table 4-5 depicts the register file address selection under control of the register file address field (RDDT bits 13 through 17).

Table 4-5. Register File Address Selection (Sheet 1 of 2)

RDDT (13-17)	RFAR 01234[a]	Location(s)	Selected Register(s)	Firmware Micro-Op[b]
00	0yyyy	00-0F	R0-R7,B0-B7	DK
01	00000	00	R0	DO
02	00f_1 f_2 f_3	00-07	R0-R7	DX
03	00f_1 f_2 0	00,02,04,06	R0,R2,R4,R6	DXM1
04	00f_9 f_{10} f_{11}	00-07	R0-R7	DM
05	0000f_{10} f_{11}	00-03	R0-R3	DMM4
06	00f_{13} f_{14} f_{15}	00-07	R0-R7	DN
07	000f_{14} f_{15}	00-03	R0-R3	DNM4
08	0yyyy	00-0F	R0-R7,B0-B7	BK
09	01000	08	B0	BO

Table 4-5. Register File Address Selection (Sheet 2 of 2)

RDDT (13-17)	RFAR[a] 01234	Location(s)	Selected Register(s)	Firmware Micro-Op[b]
0A	01f_1 f_2 f_3	08-0F	B0-B7	BX
0B	01f_1 f_2 0	08,0A,0C,0E	B0,B2,B4,B6	BXM1
0C	01f_9 f_{10} f_{11}	08-0F	B0-B7	BM
0D	010f_{10} f_{11}	08-0B	B0-B3	BMM4
0E	01f_{13} f_{14} f_{15}	08-0F	B0-B7	BN
0F	010f_{14} f_{15}	08-0B	B0-B3	BNM4
10	10000	10	S	S
11	10001	11	DW1	DW1
12	10010	12	DW2	DW2
13	10011	13	DW3	DW3
14	10100	14	DW4	DW4
15	10101	15	DW5	DW5
16	10110	16	DW6	DW6
17	10111	17	L6IO	L6IO
18	11000	18	H	H
19	11001	19	AW1	AW1
1A	11010	1A	AW2	AW2
1B	11011	1B	AW3	AW3
1C	11100	1C	AW4	AW4
1D	11101	1D	AW5	AW5
1E	11110	1E	RBDR	RDBR
1F	11111	1F	T	T

[a] RFAR = Register File Address Register
1 yyyy = RDDT Bits 9 through 12
2 fx = F-Register Bit (x)

[b] See Firmware Directory in Section 5

4.3 ALU CONTROL FIELD

The ALU control field (RDDT 18 through 22) not only controls the arithmetic and logical functions of the ALU, but also selects the inputs to its A- and B-ports. Table 4-6 represents the functions of the ALU control field.

Table 4-6. ALU Control (RDDT 18 Through 22)

RDDT (18-22)	Micro-Op/ Subcommand	RDDT (18-22)	Micro-Op/ Subcommand
00	SPANDG	10	ZERO
01	GNOT	11	ZMG
02	G	12	SPPG
03	SPORG	13	SPMG
04	SPANDQNOT	14	MINUS1
05	QNOT	15	ZMQ
06	SPNOT	16	SPM1
07	SP	17	SPP1
08	SPANDQ8	18	SPPQ8
09	Q8	19	SPMQ8
0A	SPXORQ8	1A	SPPQ9
0B	SPORQ8	1B	SPMQ9
0C	SPANDQ	1C	SPPQ
0D	Q	1D	SPMQ
0E	SPXORQ	1E	SPMQM1
0F	SPORQ	1F	SPPQP1

SP indicates register file (x)
G indicates G-register
Q indicates Q-register
Q8 indicates sign propagation from Q08
Q9 indicates sign propagation from Q09
Z indicates input to A-port is Zero
ZERO indicates output equals Zero
MINUS1 indicates output equals all Ones
AND, OR, NOT, XOR, P and M are all operations

4.4 BUS CONTROL FIELD (RDDT 23-25)

The LSI-6 processor bus control field (RDDT bits 23 through 25) is summarized below:

RDDT (23-25)	Micro-Op	Remarks
0	NOP	Drivers not enabled
1	DIN	Data into LSI-6 (to internal bus)
2	DOUT	Data out of LSI-6 (internal bus)
3	DOUTM	Data out of LSI-6 (MMU)
4	MMR	Memory address out (read word)
5	MWB1	Memory address out (write byte 1)
6	MWB0	Memory address out (write byte 0)
7	MMW	Memory address out (write word)

4.5 REGISTER MODIFICATION FIELD

The register modification field (RDDT26 through RDDT30) is composed of three simultaneous operations.

1. RDDT bit 26 - Register file load or SPW
2. RDDT bit 27 - Q-register load or LDQ
3. RDDT (28-30) - Destination field used to alter contents of FCNT, P- and G-registers.

4.5.1 Register File Load Field

The register file load field (RDDT bit 26) is a 1-bit field also known as Scratch Pad Write (SPW). When this bit is Zero, the register file contents cannot be altered (written). When this field is a One, its operation can be modified by micro-ops from the special control field as mentioned in register file description.

4.5.2 Q-Register Load Field

The Q-register load field (RDDT bit 27) is a 1-bit field also known as Load Q (LDQ). When this bit is Zero, the contents of the Q-register cannot be altered. When this bit is a One, the modification of the Q-register may be dependent upon the special control field (RDDT bits 35 through 47) which contains all the shift modification micro-ops for the Q-register. If none of the shift micro-ops are activated for the current firmware word, the default will be to load Q with the contents of the internal bus BI(00-15) -> Q(00-15).

4.5.3 Destination Field

This 3-bit field (RDDT bits 28 through 30) is used to alter the contents of the FCNT, G- and P-registers as shown below.

RDDT (28-30)	Micro-Op	Function
0	----	No Operation
1	LDFT	BI (11-15) --> FCNT (11-15)
2	FTP1	FCNT + 1 --> FCNT
3	FTM1	FCNT - 1 --> FCNT
4	LDG	BI(0D-0A,00-15) --> G(0D-0A,00-15)
5	LDP	BI(0D-0A,00-15) --> P(0D-0A,00-15)
6	PP1	P + 1 --> P
7	PM1	P - 1 --> P

4.6 MMU CONTROL FIELD

This 3-bit field (RDDT bits 31 through 33) is used to determine access rights selection and checking desired within the MMU.

RDDT (31-33)	Micro-Op	Function
0	----	No operation
1	ERS	Execute ring selection
2	RRS	Read ring selection
3	WRS	Write ring selection
4	IA	Indirect address
5	FM	Firmware mode (firmware-generated address)
6	LRA	Limited read access
7	LWA	Limited write access

4.7 HARDWARE INTERRUPT INHIBIT FIELD

A hardware interrupt forces a branch to a fixed firmware address. This address is determined by a priority net (see Table 4-7) which has various error signals and interrupt requests (memory refresh and data transfer requests) as inputs. Hardware interrupt also causes the next firmware generated address to be pushed onto the Push/Pop stack. If the next address had been generated from the stack via a Return micro-op, "popping" of the stack would be inhibited. Hardware interrupts must be inhibited whenever a Push operation is performed.

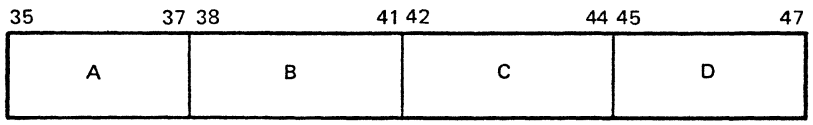
When the hardware interrupt inhibit field (RDDT bit 34) is a One, memory refresh and data request hardware interrupts are inhibited (prevented from intervening between current and next firmware-generated address). Hardware error inputs to the Prinet are not under control of RDDT bit 34 and can intervene between any given microcycles. When bit 34 is a Zero, all hardware interrupts are allowed.

Table 4-7. Hardware Interrupt Prinet

Next RAR Value	Function	Remarks
000	System clear	Unaffected by hardware interrupt inhibit field (RDDT bit 34)
002	MEMPRES (active low)	
	MMU (nonexistent resource)	
003	MMU (access violation)	
004	Memory parity error	
005	Memory refresh request	Under control of hardware interrupt inhibit field (RDDT bit 34)
006	Data request DTR0	
007	Data request DTR1	
008	Data request DTR2	
009	Data request DTR3	
00A	Data request DTR4	

4.8 SPECIAL CONTROL FIELD

The special control field (RDDT bits 35 through 47) is used to modify as well as supplement certain of the other fields in the current firmware word. It provides up to three simultaneous micro-operations during a given microcycle. The special control field is divided into four subfields as shown in the following format.



The A-field defines the use of the B-, C-, and D-fields as follows:

When A-Field = 0 (general use)

B-Field controls loading of F-, P-, I-, and M-registers, modification to register file loading (SPWs), modifications to Process Bus Data-Out operations, and special sourcing to the BI.

C-field controls the set, reset, and load of control flip-flops 2 and 4 in addition to providing the Push micro-op.

D-field controls the set, reset, and load of control flip-flops 1 and 3 in addition to RTC/WDT control.

When A-field = 1 (MMU control)

B-field controls loading of certain MMU registers plus sourcing of the BI from MMU register file.

C-field (same as when A-field = 0)

D-field (same as when A-field = 0)

When A-field = 2 (indicator register control)

B-field controls set, reset, and loading of individual indicator register bits.

C-field - internal results are inhibited.

D-field - internal results are inhibited.

When A-Field = 3 (shift control)

B-field designates register (S) to be shifted and provide carry (C) and overflow (OV) indicator controls for "Shift by Op-Code" micro-ops.

C-field designates the direction (left or right) and the type of shift (open, closed, or arithmetic) when B-field designates a firmware-controlled shift (not "Shift by Op-Code"). When "Shift by Op-code" micro-op is called in B-field, the C-field should contain a value of Zero (NOP).

D-field designates the filler to be used when B-field designates a firmware-controlled shift (not "Shift by Op-Code").

When "Shift by Op-Code" micro-op is called in the B-field, the D-field should contain a value of Zero (NOP).

When A-Field = 4 (constant to BI)

RDDT bits 38 through 47 will be used to generate a constant to source the BI.

When A-Field = 5, 6, or 7

Bits 38 through 47 (10 bits) are available for use external to the chip.

4.8.1 General Use (A-Field = 0)

B-Field	Micro-Op	Function
0	-	No operation
1	BIFP	P (0D-15)-->BI (0D-15)
2	LDM	BI (08-15) -->Mx (00-07); x defined by RFAR bits (2-4)
3	BIFM	Mx (00-07)-->BI (08-15), Ones BI --> (00-07); x defined by RFAR bits (2-4)
4	IWDTA	Inhibit write to register file bits (0D-0A) when used with SPW.
5	SPFBIX	Swap bytes of BI to register file. BI (00-07)-->RF (08-15); BI (08-15)-->RF (00-07).
6	LDFR	BI (00-11)-->F-register (00-11)
7	SPXDTA	BI (12-15)-->register file (0D-0A) when used with SPW. Register file (00-15) remain unchanged.
8	RSTCK	Reset timer (TICOS) interrupt flip-flop.
9	BIFMK	FR3 (F-register bits 12-15) generates a 16-bit mask to BI (00-15), BI(00)-->(0D-0A).
A	LDI	BI(08-15)-->I-register (00-07)
B	BIFI	I-Register (00-07)-->BI(08-15), Zeros--BI(0D-07)
C	SPFAU	ALU (0D-15)-->Register file (0D-15) used with SPW

B-Field	Micro-Op	Function
D	TWNOUT	BI (08-15)-->DABS (08-15) BI (08-15)-->DABS (00-07), Zeros --> DABS (0D-0A) when used with DOUT
E	BIFSP	Register file -->A-port -->BI (To ensure the contents of the register file to BI, the ALU command must contain the scratch-pad term in the ALU micro-op; i.e., SP,SPPG,SPMG etc. Refer to subsection 4.3 for a complete list of ALU micro-ops). ALU (0D-15)--> Register file (0D-15) when used with SPW
F	SWPOUT	BI (0D-0A)-->DABS (12-15); Zeros-->DABS 0D-11 when used with DOUT

When the A-field equals Zero and the B-field is not 5, 7, D, or F, then the C- and D-fields are specified as shown below. When the B-field equals 5, 7, D, or F, the C and D-fields are inhibited internally.

C-Field	Micro-Op	Function
0	-	No operation
1	RCF4	Reset control flip-flop 4
2	SCF4	Set control flip-flop 4
3	LCF4	BI (00) -> CF4
4	PUSH*	(RAR) +1 pushed into top of Push/Pop stack (refer to subsection 4.1.6)
5	RCF2	Reset control flip-flop 2
6	SCF2	Set control flip-flop 2
7	LCF2	Q-Register (00) -> CF2

D-Field		
0	-	No operation
1	RCF1	Reset control flip-flop 1
2	SCF1	Set control flip-flop 1
3	LCF1	BI (15) -> CF1

*A Push micro-op is only used when the inhibit hardware interrupt bit (RDDT34) is a One.

D-Field	Micro-Op	Function
4	RTC	Set/reset RTC/WDR dependent on software instruction in F-register
5	RCF3	Reset control flip-flop 3
6	SCF3	Set control flip-flop 3
7	RESOVT	Reset "Trap on Overflow" flip-flop

4.8.2 MMU Control (A-Field = 1)

B-Field	Micro-Op	Function
0	CME	Clear MMU error flip-flops
1	LDMAD	Load MMU register file address register from BI. If BI (0D-0A) = 0, then 0 -> MMUAR(0), and BI (00-03) -> MMUAR (1-4). If BI (0D-0A) ≠ 0, then 1 -> MMUAR (0), and BI (0D-0A) -> MMUAR (1-4).
2	LDEF	Load effective ring from current ring
3	LDMURG	Load current and effective rings from BI (01,02). Any time S-register ring is updated this micro-op must be used.
4	WMBS	Write base word in register file BI (00-15) - MMURF (00-15)
5	BIFMMUH	MMURF (00-15) - BI (00-15)
6	WMSZ	Write Size Word in register file BI (00-15) - MMURF (16-31), [MMUAR]+1 - [MMUAR]
7	BIFMMUL	MMURF (16-31) - BI (00-15) [MMUAR]+1 - [MMUAR]
8 through F	-	No operation

The C- and D-fields are identical to those of subsection 4.8.1.

4.8.3 Indicator Register Control (A-Field = 2)

B-Field	Micro-Op	Function
0	-	No operation
1	RIOV	Reset overflow indicator (I0)
2	SIOV	Set overflow indicator (I0)
3	IBFAL00	BI00 - Bit indicator (I3)
4	LIOVCA	Load overflow (I0), and load carry (I2) for 16-bit operations only
5	RICA	Reset carry indicator (I2)
6	SICA	Set carry indicator (I2)
7	IBFALZN	If BI (00-15) ≠ 0, set bit indicator; otherwise reset bit indicator (I3) (i.e., a One bit on BI causes Indicator bit to be set)
8	IGLU16	Indicator bits G (I5), L (I6), and U (I7) are loaded for 16-bit ALU operations
9	RIG	Reset "greater than" (G) indicator (reset I5)
A	SIG	Set "greater than" indicator (set I5 or G-bit)
B	RII	Reset input/output bit - Reset I-bit (I4)
C	IGLU20	Indicator bits G (I5), L (I6), and U (I7) are loaded as the result of a 20-bit ALU operation.
D	RIL	Reset "less than" indicator - reset (I6)
E	SIL	Set "less than" indicator - set (I6)
F	SII	Set input/output indicator - set (I4)

When A-field = 2; C- and D-field internal results are inhibited.

4.8.4 Shift Control (A-Field = 3)

B-Field	Micro-Op	Function
0*	SHOPRI	Reset overflow indicator (I0) for SAL or DAL instructions. Reset carry indicator (I2) for SOL, SOR, SAR, DOL, DOR and DAR instructions.
1*	(None)	Shift Q-register under F-register control
2*	SHOPRF	Shift register file only by op-code - single word shift and set indicators by op-code: Set I0 (0V), if SAL and sign changes; set I2 (C), if SOL and last bit out of ALU00 is equal to One. Set I2 (C), if SOR or SAR and last bit out of ALU15 equals One. NOTE This command is used in conjunction with SPW micro-op active.
3*	SHOP	Shift register file and Q-register concantenated. Double-word shift and set indicators by op-code: Set IO (OV), if DAL and sign changes, set I2 (C), if DOL and last bit shifted out of ALU00 equals One. Set I2 (C), if DOR or DAR and last bit out of Q15 equals One. NOTE This micro-op command is used with both SPW and LDQ micro-ops active.
4*	(None)	No operation
5	**	Q-register shift under firmware control
6	**	Register file shift under firmware control
7	**	F-register, Q-register shift under firmware control

*For B-field codes of 0 through 4, the C- and D-fields must be Zero as unspecified results occur.
**Refer to C- and D-field tables below for micro-ops when B-field has a value of 5, 6 or 7.

B-field = 5 (LDQ micro-op must be active)

C-Field	Micro-Op	Function
0	SQOL	Shift Q-register open left
1	SQCL	Shift Q-register closed left
2	SQAL	Shift Q-register arithmetic left
3	(None)	Duplicate of SQCL
4	SQOR	Shift Q-register open right
5	SQCR	Shift Q-register closed right
6	SQAR	Shift Q-register arithmetic right
7	(None)	Duplicate of SQCR

B-field = 6 (SPW micro-op must be active)

C-Field	Micro-Op	Function
0	SRFOL	Shift register file open left
1	SRFCL	Shift register file closed left
2	SRFAL	Shift register file arithmetic left
3	(None)	Duplicate of SRFCL
4	SRFOR	Shift register file open right
5	SRFCR	Shift register file closed right
6	SRFAR	Shift register file arithmetic right
7	(None)	Duplicate of SRFCR

B-field = 7 (LDQ and SPW micro-ops are both active)

C-Field	Micro-Op	Function
0	SRFQOL	Shift register file, Q-register concatenated open left
1	SRFQCL	Shift register file, Q-register concatenated closed left
2	SRFQAL	Shift register file, Q-register concatenated arithmetic left
3	(None)	Duplicate of SRFQCL
4	SRFQOR	Shift register file, Q-register concatenated open right
5	SRFQCR	Shift register file, Q-register concatenated closed right
6	SRFQAR	Shift register file, Q-register concatenated arithmetic right
7	(None)	Duplicate of SRFQCR

When the B-field = 5, 6 or 7, and the C-field = 0, 2 or 4, refer to the following table.

D-Field	Micro-Op	Function
0	SFO	Shift filler equal Zero
1	SFCF1	Shift filler equal CF1
2	SFCF4N	Shift filler equal CF4 negation
3	SFCF4	Shift filler equal CF4 assertion
4	SFC16	Shift filler equal carry out of 16-bit ALU
5	SFUOA	Shift filler equal ALU (0A) 17th bit
6	SFU00	Shift filler equal ALU (00) 16th bit
7	SFQ00	Shift filler equal Q-register (00)

Summary Notes: (Shift Control or A = 3)

1. When using B-field micro-ops SHOPRI, SHOPRF and SHOP (B-field = 0, 2, and 3, respectively), the C- and D-fields should be allowed to default to Zero (no C- or D-field micro-ops should be called).

2. For B-field values of 1 and 4 there are no micro-ops specified, and the C- and D-fields are also unspecified (C- and D-field should be allowed to default to Zeros).

3. For B-field value of 5 (Q-register shifts under firmware control), LDQ must be activated (RDDT 27 = 1) and the C-field micro-op specifies the type and direction of the shift. Filler micro-ops (D-field) should be called where necessary (see Note 6 below).

4. For B-field value of 6 (register file shifts under firmware control), SPW micro-op must be activated (RDDT 26 = 1) and the C-field micro-op specifies the type and direction of the shift. Filler micro-ops (D-field) should be called where necessary (see Note 6 below).

5. For B-field value of 7 (register file concatenated with Q-register to provide a 32-bit shift under firmware control), SPW and LDQ must be activated (RDDT 26, 27 = 1,1), and the C-field micro-op specifies the type and direction of the shift. Filler micro-ops (D-field) should be called where necessary (see Note 6 below).

6. The D-field micro-ops should be used to designate the filler for B-field values of 5, 6, and 7 when C-field values are 0, 2 or, 4.

7. For B-field values of 8 through F, the C- and D-field operations are inhibited internally.

8. All register file shifts are accomplished by shifting the output of the ALU into the register file.

4.8.5 Constant to BI (A-Field = 4)

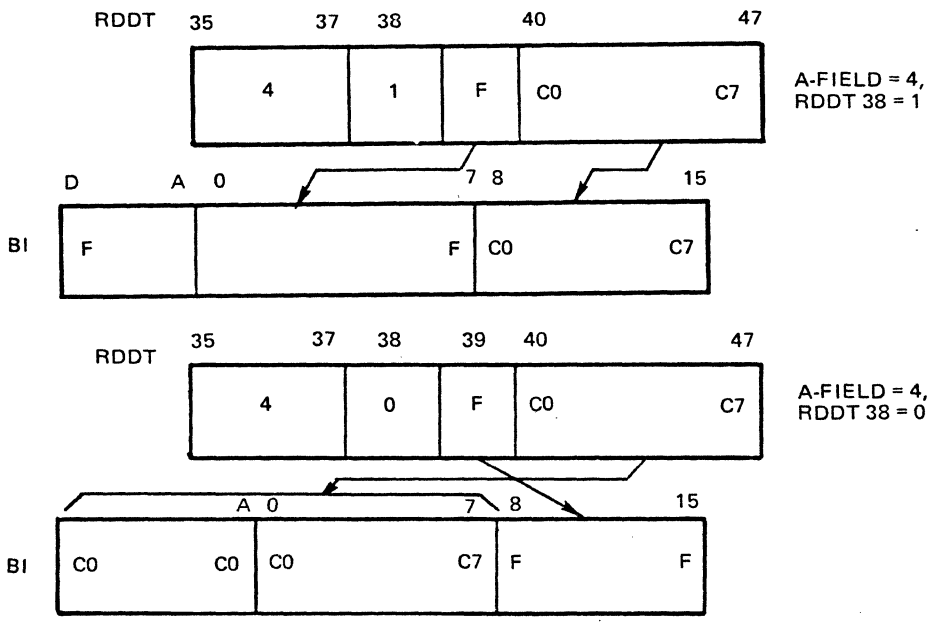
RDDT bit 38 determines if the byte constant will be sourced to BI (00 through 07) or BI (08 through 15).

RDDT bit 39 determines whether the filler byte will be Ones or Zeros.

RDDT bits 40 through 47 contain the byte constant.

NOTE

Whichever bit is selected to source BI (00) will also source BI (0D-0A).



4.8.6 User Codes (A-Field = 5, 6 or 7)

When the A-field contains a value of 5, 6 or 7, RDDT bits 38 through 47 become available for control operations external to the chip.

Section 5
MICRO-OPS

This section provides the user with a list of micro-ops that are used with the LSI-6 microprocessor. Tables 5-1 through 5-8 list the micro-ops according to the micro-op function performed, with a brief description of each micro-op. Table 5-9 lists the micro-ops in alphanumeric order, a reference to the micro-op group and subgroup if any.

Table 5-1. Branch Micro-Ops (Sheet 1 of 3)

Micro-Op Name		Description
Group	Subgroup	
TB Two-way branching to test branching address based on test results	TBFR00	F-register bit 00
	TBFR04	F-register bit 04
	TBFR08	F-register bit 08
	TBFR12	F-register bit 12
	TBPROC[a]	Proceed - in
	TBMBG0[a]	Major branch in bit 0
	TBINTP	Interrupt pending
	TBMTCK	Missed TICKOS
	TBBI12Z	BI00-11 = 0 temporary flip-flop
	TBBI16Z	BI00-15 = 0 temporary flip-flop
	TBBIDTAZ	BI0D-0A = 0 temporary flip-flop

Table 5-1. Branch Micro-Ops (Sheet 2 of 3)

Micro-Op Name		Description
Group	Subgroup	
TB (continued)	TBBI10Z	BI0D-0A, 00-15 = 0 temporary flip-flop
	TBFR3Z	F-register (12-15) = 0
	TBMRG0	M-register (Bit 00)
	TBRTC	Real-time clock on
	TBCF1	Control file flip-flop 1
	TBFR01	F-register bit 01
	TBFR05	F-register bit 05
	TBFR09	F-register bit 09
	TBFR13	F-register bit 13
	TBBUSY[a]	Busy - in
	TBMBG1[a]	Major branch in bit 01
	TBSIP	Option 2 SIPE
	TBCIP	Option 1 CIPE
	TBOVTP	ALU overflow trap pending
	TBCY16	CARRY16 = 1 temporary flip-flop
	TBLAF	Option 3 LAFE
	TBCY20	CARRY20 = 1 temporary flip-flop
	TBF1T3Z	F-register bits 01-03 = 0
	TBMRGX	M-register bit selected by F-register bits 01-03
	TBWDT	Watchdog timer on
	TBCF2	Control flip-flop 2
	TBFR02	F-register bit 02
	TBFR06	F-register bit 06
	TBFR10	F-register bit 10
	TBFR14	F-register bit 14
	TBBYTX[a]	BYTEX - in
	TBMBG2[a]	Major branch in bit 02
	TBMPLK[a]	MPO lock
	TBQ15	Q-register (bit 15)
	TBBI00	Temporary flip-flop BI00
	TBBIZER0	BI00-15 = 0 same cycle (chip test only)
	TBMMU	Option 0 MMUE
	TBOV16	Overflow 16 temporary flip-flop
	TBF1T37	F-register bits 01-03 = 7
	TBIRGC	I-register (C-bit)
	TBMMU3	MMU flip-flop 3 Validity - size check error
	TBCF3	Control flip-flop 3
	TBFR03	F-register bit 03
	TBFR07	F-register bit 07
	TBFR11	F-register bit 11
	TBFR15	F-register bit 15
	TBOBC[a]	OBC - in

Table 5-1. Branch Micro-Ops (Sheet 3 of 3)

Micro-Op Name		Description
Group	Subgroup	
TB (continued)	TBMBG3[a]	Major branch in bit 03
	TBSTB[a]	TSTBR1 (monitor test bit)
	TBFTZ	FCNT = 0
	TBBI15	BI15 temporary flip-flop
	TBCARRY	16-bit ALU = Carry same cycle (chip test only)
	TBOP4	Option 4 memory valid
	TBOV20	OVERFLOW20 temporary flip-flop
	TBSRG1	S-register bit 01 (PRVLG mode)
	TBIRGB	I-register (B-bit)
	TBMMU4	MMU flip-flop 4 ring check error
	TBCF4	Control flip-flop 4
MB Sixteen-way branching based on test results	MBFR0	FR0 (F-register bits 00-03)
	MBFR1	FR1 (F-register bits 04-07)
	MBFR2	FR2 (F-register bits 08-11)
	MBFR3	FR3 (F-register bits 12-15)
	MBPROC	Proceed, Busy, Bytex, OBC
	MBMGT	MIBGP0 - 3
	MBSWIP	Software interrupt Prinet
	MBMULT	0, 0, Q14, FT = 0
	MBFMT	Instruction format
	MBPO	D0/S0 instruction group
	MBINX	D0/S0 index group
	MBGEN	Generic instruction
	MBADRS	Address syllable
	MBCIP	Data descriptor address syllable
	MBBRCH	0, P branch, F9TEZ, FR15
POP Go to address at the top of the Push/Pop stack	DKCNST	RDDT bits 09 through 12 to register file address.
INCK Go to next address and generate a constant	BICNST	Constant to BI.
INC Go to current address plus One	DKCNST	RDDT bits 09 through 12 to register file address.

[a]Refer to Table 4-3 for LSI-6 equivalent nomenclature.

Table 5-2. Register File Address Micro-Ops

Micro-Op Name	Description
DK	Register File address = 0; RDDT 9,10,11,12
DO	Register File address = 0,0,0,0,0
DX	Register File address = 0,0; FR1,2,3
DXM1	Register File address = 0,0; FR1,2,0
DM	Register File address = 0,0; FR9,10,11
DMM4	Register File address = 0,0,0; FR10,11
DN	Register File address = 0,0; FR13,14,15
DNM4	Register File address = 0,0,0; FR14,15
BK	Register File address = 0; RDDT 9,10,11,12
BO	Register File address = 0,1,0,0,0
BX	Register File address = 0,1; FR1,2,3
BXM1	Register File address = 0,1; FR1,2,0
BM	Register File address = 0,1; FR9,10,11
BMM4	Register File address = 0,1,0; FR10,11
BN	Register File address = 0,1; FR13,14,15
BNM4	Register File address = 0,1,0; FR14,15
S	Status register
DW1	Data working location 1
DW2	Data working location 2
DW3	Data working location 3
DW4	Data working location 4
DW5	Data working location 5
DW6	Data working location 6
L6IO	Data working location 7
H	Program control history register
AW1	Address working location 1
AW2	Address working location 2
AW3	Address working location 3
AW4	Address working location 4
AW5	Address working location 5
RDBR	Remote descriptor base register
T	Stack address register

Table 5-3. ALU Micro-Ops

Micro-Op Name	Description
	Logic Functions
SPANDG	SP ANDed with G-register
GNOT	Negation of G-register (Ones complement)
G	G-register
SPORG	SP ORed with G-register
SPANDQNOT	SP ANDed with Q-register negation
QNOT	Negation of Q-register
SPNOT	SP negation
SP	SP
SPANDQ8	Ripple QR08 to all higher bits (SP ANDed with Q-register bits 08-15)
Q8	Ripple QR08 to all higher bits (Q-register 08-15)
SPXORQ8	Ripple QR08 to all higher bits (SP XORed with Q-register bits 08-15)
SPORQ8	Ripple QR08 to all higher bits (SP ORed with Q-register bits 08-15)
SPANDQ	SP ANDed with Q-register
Q	Q-register
SPXORQ	SP XORed with Q-register
SPROQ	SP ORed with Q-register
	Arithmetic Functions
ZERO	ALU output equals Zero
ZMG	Zero minus G-register
SPPG	SP plus G-register
SPMG	SP minus G-register
MINUS1	ALU output equals all Ones
ZMQ	Zero minus Q-register
SPM1	SP minus One
SPP1	SP plus One
SPPQ8	Ripple QR08 to all higher bits (SP plus Q 08-15)
SPMQ8	Ripple QR08 to all higher bits (SP minus Q 08-15)
SPPQ9	Ripple QR09 to all higher bits (SP plus Q 09-15)
SPMQ9	Ripple QR09 to all higher bits (SP minus Q 09-15)
SPPQ	SP plus Q-register
SPMQ	SP minus Q-register
SPMQM1	SP minus Q-register minus One
SPPQP1	SP plus Q-register plus One

Table 5-4. Bus Control Micro-Ops

Micro-Op Name	Description
DIN	Data into LSI-6
DOUT	Data out LSI-6 internal bus
DOUTM	Data out from MMU
MMR	Memory address, read word
MWB1	Memory address, write byte 1
MWB0	Memory address, write byte 0
MMW	Memory address, write word

Table 5-5. Register Modification Micro-Ops

Micro-Op Name	Description
SPW	Control write into register file
LDQ	BI to Q-register if no other source
LDP	BI to program counter
PP1	P plus One to P-register
PM1	P minus One to P-register
LDG	BI to G-register
LDFT	BI11-15 to FCNT11-15
FTP1	FCNT plus One to FCNT
FTM1	FCNT minus One to FCNT

Table 5-6. MMU Micro-Ops

Micro-Op Name	Description
NOP	No operation
RRS	Read ring selection
WRS	Write ring selection
IA	Indirect address
FM	Firmware mode
LRA	Limited read access
LWA	Limited write access
ERS	Execute ring selection

Table 5-7. Hardware Interrupt Micro-Op

Micro-Op Name	Description
DHI	Disable Hardware Interrupt

Table 5-8. Special Control Micro-Ops (Sheet 1 of 3)

Micro-Op Name		Description
Group	Subgroup	
General RDDT 35-37 = 000	BIFP	P-register to BI
	LDM	BI08-15 to M-register addressed by SPAR
	BIFM	M-register to BI08-15, one to others addressed by SPAR
	IWDTA	INH SPW into bits 0D-0A
	SPFBIX	SWAP, BI to register file
	LDFR	BI to FR00-FR11
	SPXDTA	BI12-15 to SPM 0D-0A
	RSTCK	Reset TICKOS
	BIFMK	FR3 generates a mask to BI
	LDI	BI08-15 to I-register
	BIFI	I-register to BI08-15, 0 to other
	SPFAU	SPM input from ALU
	TWNOUT	BI08-15 to PB00-07,08-15
	BIFSP	SPM to BI, ALU to SPM
	SWPOUT	0->PB(0D-0A,0-11) BI(0D-0A) to PB(12-15)
	RCF4	Reset CF4
	SCF4	Set CF4
	LCF4	Load BI00 into CF4
	PUSH	Push RAR plus One to stack
	RCF2	Reset CF2
	SCF2	Set CF2
	LCF2	Load QR00 into CF2
	RCF1	Reset CF1
	SCF1	Set CF1
	LCF1	Load BI15 into CF1
	RTC	Set, reset real-time clock and watch-dog timer depending on OPCD
	RCF3	Reset CF3
	SCF3	Set CF3
	RESOVT	Reset TRAP ON OVERFLOW

Table 5-8. Special Control Micro-Ops (Sheet 2 of 3)

Micro-Op Name		Description
Group	Subgroup	
MMU RDDT 35-37 = 001	CME LDMAD LDEF LDMURG WMBS BIFMMUH WMSZ BIFMMUL RCF4 SCF4 LCF4 PUSH RCF2 SCF2 LCF2 RCF1 SCF1 LCF1 RTC RCF3 SCF3 RESOVT	Clear memory errors Load MMU address from BI MMU current ring to effective ring Load MMU backup ring and effective ring and SRG1 flip-flop Write MMU base MMU00-15 BI00-15 Write MMU size 00 MMU16-31 BI00-15 Reset CF4 Set CF4 Load BI00 into CF4 Push RAR plus One to stack Reset CF2 Set CF2 Load QR00 into CF2 Reset CF1 Set CF1 Load BI15 into CF1 Set, reset real-time clock and watch-dog timer depending on OPCD Reset CF3 Set CF3 Reset TRAP ON OVERFLOW
Indicator Register RDDT 35-37 = 010	RIOV SIOV IBFAL00 LIOVCA RICA SICA IBFALZN IGLU16 RIG SIG RII IGLU20 RIL SIL SII	Reset OV bit Set OV bit Load B-bit from ALU bit $\overline{00}$ Load OV, C-bits Reset C-bit Set C-bit Load B-bit from ALU = 0 G-, L-, U-bits from 16-bit ALU Reset G-bit Set G-bit Reset I-bit G-, L-, U-bits from 20-bit ALU Reset L-bit Set L-bit Set I-bit

Table 5-8. Special Control Micro-Ops (Sheet 3 of 3)

Micro-Op Name		Description
Group	Subgroup	
Shift	SHOPRI	Reset IOV,ICA depending on OPCE
	SHOPRF	Shift register file only
RDDT 35-37 = 011	SHOP	Shift according to the op-code in F-register, and Q-register will be changed, IOV
	SQOL	Shift Q-register open left
	SQCL	Shift Q-register close left
	SQAL	Shift Q-register arithmetic left
	SQOR	Shift Q-register open right
	SQCR	Shift Q-register close right
	SQAR	Shift Q-register arithmetic right
	SRFOL	Shift register file open left
	SRFCL	Shift register file close left
	SRFAL	Shift register file arithmetic left
	SRFOR	Shift register file open right
	SRFCR	Shift register file close right
	SRFAR	Shift register file arithmetic right
	SRFQOL	Shift register file Q-register open left
	SRFQCL	Shift register file Q-register closed left
	SRFQAL	Shift register file Q-register arithmetic left
	SRFQOR	Shift register file Q-register open right
	SRFQCR	Shift register file Q-register closed right
	SRFQAR	Shift register file Q-register arithmetic right
Constant Generation	SF0	Shift filler equals Zero
	SFCF1	Shift filler equals CF1
	SFCF4N	Shift filler equals CF4 negative
RDDT 35-37 = 100	SFCF4	Shift filler equals CF4
	SFC16	Shift filler equals carry out of 16-bit ALU
	SFBI0A	Shift filler equals ALU0A
	SFU00	Shift filler equals ALU00
	SFQ00	Shift filler equals QR00
External Use		RDDT40 to BI0D-0A RDDT40-47 to BI00-07
RDDT 35-37 = 101	RDH	RDDT39 to BI08-15
RDDT 35-37 = 110	RDL	RDDT39 to BI0D-0A,00-07
RDDT 35-37 = 111	RDVL	RDDT40-47 to BI08-15

Table 5-9. Micro-Ops Listed Alphanumerically (Sheet 1 of 6)

Micro-Op	Micro-Op Reference
AW1	Register file address
AW2	Register file address
AW3	Register file address
AW4	Register file address
AW5	Register file address
BICNST	Branch/INCK, Pop
BIFI	Special control/general
BIFM	Special control/general
BIFMK	Special control/general
BIFMMUH	Special control/MMU
BIFMMUL	Special control/MMU
BIFP	Special control/general
BIFSP	Special control/general
BK	Register file address
BM	Register file address
BMM4	Register file address
BN	Register file address
BNM4	Register file address
BX	Register file address
BXM1	Register file address
BO	Register file address
CME	Special control/MMU
DHI	Hardware interrupt
DIN	Bus control
DK	Register file address
DKCNST	Branch/INC,INCK,Pop
DM	Register file address
DMM4	Register file address
DN	Register file address
DNM4	Register file address
DOUT	Bus control
DOUTM	Bus control
DW1	Register file address
DW2	Register file address
DW3	Register file address
DW4	Register file address
DW5	Register file address
DW6	Register file address
DX	Register file address
DXM1	Register file address
D0	Register file address
ERS	MMU
FM	MMU
FTM1	Register modification
FTP1	Register modification
G	ALU
GNOT	ALU
H	Register file address

Table 5-9. Micro-Ops Listed Alphanumerically (Sheet 2 of 6)

Micro-Op	Micro-Op Reference
IA	MMU
IBFALZN	Special Control/I-register
IBFAL00	Special Control/I-register
IGLU16	Special Control/I-register
IGLU20	Special Control/I-register
INC	Special branch/INC
INCK	Special branch/INCK
JMP	Special branch/Jump
LCF1	Special control/general,MMU
LCF2	Special control/general,MMU
LCF4	Special control/general,MMU
LDEF	Special control/MMU
LDFR	Special control/general
LDFT	Register modification
LDG	Register modification
LDI	Special control/general
LDM	Special control/general
LDMAD	Special control/MMU
LDMURG	Special control/MMU
LDP	Register modification
LDQ	Register modification
LIOVCA	Special control/I-register
LRA	MMU
LWA	MMU
L6IO	Register file address
MB	Branch/major branch
MBADRS	Branch/major branch
MBBRCH	Branch/major branch
MBCIP	Branch/major branch
MBFMT	Branch/major branch
MBFR0	Branch/major branch
MBFR1	Branch/major branch
MBFR2	Branch/major branch
MBFR3	Branch/major branch
MBGEN	Branch/major branch
MBINX	Branch/major branch
MBMGT	Branch/major branch
MBMULT	Branch/major branch
MBOP	Branch/major branch
MBSWIP	Branch/major branch
MINUS1	ALU
MMR	Bus control
MMW	Bus control
MWB0	Bus control
MWB1	Bus control
NOP	MMU
PM1	Register modification
POP	Branch/Pop

Table 5-9. Micro-Ops Listed Alphanumerically (Sheet 3 of 6)

Micro-Op	Micro-Op Reference
PP1	Register modification
PUSH	Special control/general,MMU
Q	ALU
GNOT	ALU
Q8	ALU
RCF1	Special control/general,MMU
RCF2	Special control/general,MMU
RCF3	Special control/general,MMU
RCF4	Special control/general,MMU
RDBF	Register file address
RDH	Special control/external use
RDL	Special control/external use
RDVL	Special control/external use
RESOVT	Special control/external,MMU
RICA	Special control/I-register
RIG	Special control/I-register
RII	Special control/I-register
RIL	Speical control/I-register
RIOV	Special control/I-register
RRS	MMU
RSTCK	Special control/general
RTC	Special control/general,MMU
S	Register file address
SCF1	Special control/general,MMU
SCF2	Special control/general,MMU
SCF3	Special control/general,MMU
SCF4	Special control/general,MMU
SFBI0A	Special control/constant general
SFCF1	Special control/constant general
SFCF4	Special control/constant general
SFCF4N	Special control/constant general
SFC16	Special control/constant general
SFQ00	Special control/constant general
SFU00	Special control/constant general
SF0	Special control/constant general
SHOP	Special control/shift
SHOPRF	Special control/shift
SHOPRI	Special control/shift
SICA	Special control/I-register
SIG	Special control/I-register
SII	Special control/I-register
SIL	Specail control/I-register
SIOV	Special control/I-register
SP	ALU
SPANDG	ALU
SPANDQ	ALU
SPANDQNOT	ALU
SPANDQ8	ALU

Table 5-9. Micro-Ops Listed Alphanumerically (Sheet 4 of 6)

Micro-Op	Micro-Op Reference
SPFAU	Special control/general
SPFB1X	Special control/general
SPIWDTA	Special control/general
SPMG	ALU
SPMQ	ALU
SPMQM1	ALU
SPMQ8	ALU
SPMQ9	ALU
SPM1	ALU
SPNOT	ALU
SPORG	ALU
SPORQ	ALU
SPORQ8	ALU
SPPG	ALU
SPPQ	ALU
SPPQP1	ALU
SPPQ8	ALU
SPPQ9	ALU
SPP1	ALU
SPW	Register modification
SPXDTA	Special control/general
SPXORQ	ALU
SPXORQ8	ALU
SQAL	Special control/shift
SQAR	Special control/shift
SQCL	Special control/shift
SQCR	Special control/shift
SQOL	Special control/shift
SQOR	Special control/shift
SRFAL	Special control/shift
SRFAR	Special control/shift
SRFCL	Special control/shift
SRFCR	Special control/shift
SRFOL	Special control/shift
SRFOR	Special control/shift
SRFQAL	Special control/shift
SRFQAR	Special control/shift
SRFQCL	Special control/shift
SRFQCR	Special control/shift
SRFQOL	Special control/shift
SRFQOR	Special control/shift
SWPOUT	Special control/general
T	Register file address
TB	Branch/test branch
TBBIDTAZ	Branch/test branch
TBBIZERO	Branch/test branch
TBBI00	Branch/test branch
TBBI12Z	Branch/test branch

Table 5-9. Micro-Ops Listed Alphanumerically (Sheet 5 of 6)

Micro-Op	Micro-Op Reference
TBBI15	Branch/test branch
TBBI16Z	Branch/test branch
TBBI20Z	Branch/test branch
TBBUSY	Branch/test branch
TBBYTX	Branch/test branch
TBCARRY	Branch/test branch
TBCF1	Branch/test branch
TBCF2	Branch/test branch
TBCF3	Branch/test branch
TBCF4	Branch/test branch
TBCIP	Branch/test branch
TBCY16	Branch/test branch
TBCY20	Branch/test branch
TBFR00	Branch/test branch
TBFR01	Branch/test branch
TBFR02	Branch/test branch
TBFR03	Branch/test branch
TBFR04	Branch/test branch
TBFR05	Branch/test branch
TBFR06	Branch/test branch
TBFR07	Branch/test branch
TBFR08	Branch/test branch
TBFR09	Branch/test branch
TBFR10	Branch/test branch
TBFR11	Branch/test branch
TBFR12	Branch/test branch
TBFR13	Branch/test branch
TBFR14	Branch/test branch
TBFR15	Branch/test branch
TBFR3Z	Branch/test branch
TBFTZ	Branch/test branch
TBF1T3Z	Branch/test branch
TBF1T37	Branch/test branch
TBINTP	Branch/test branch
TBIRGB	Branch/test branch
TBIRGC	Branch/test branch
TBLAF	Branch/test branch
TBMBG0	Branch/test branch
TBMBG1	Branch/test branch
TBMBG2	Branch/test branch
TBMBG3	Branch/test branch
TBMMU	Branch/test branch
TBMMU3	Branch/test branch
TBMMU4	Branch/test branch
TBMPLK	Branch/test branch
TBMRGX	Branch/test branch
TBMRG0	Branch/test branch
TBMTB	Branch/test branch

Table 5-9. Micro-Ops Listed Alphanumerically (Sheet 6 of 6)

Micro-Op	Micro-Op Reference
TBMTCK	Branch/test branch
TBOBC	Branch/test branch
TBOP4	Branch/test branch
TBOVTP	Branch/test branch
TBOV16	Branch/test branch
TBOV20	Branch/test branch
TBPROC	Branch/test branch
TBQ15	Branch/test branch
TBRTC	Branch/test branch
TBSIP	Branch/test branch
TBSRG1	Branch/test branch
TBWDT	Branch/test branch
TWNOUT	Special control/general
WMBS	Special control/MMU
WMSZ	Special control, MMU
WRS	MMU
ZERO	ALU
ZMG	ALU
ZMQ	ALU

Appendix A
MAJOR BRANCH CODING

This appendix provides detailed information for the Major Branch instruction. The Major Branch instruction is a six-way branch which has 15 test groups, 0 through E. The first eight groups are for general use and the remaining seven groups are Honeywell Level 6 specific.

A.1 MAJOR BRANCH TEST GROUPS 0 THROUGH 7

Major branch test groups 0 through 7 are enabled with RDDT bits 05 through 08. The eight test groups are further defined in Table A-1.

Table A-1. Major Branch Test Groups 0 through 7

Test Group (RDDT05-08)	Test Condition Output M0	M1	M2	M3	Function
0	FR00	FR01	FR02	FR03	Not applicable
1	FR04	FR05	FR06	FR07	
2	FR08	FR09	FR10	FR11	
3	FR12	FR13	FR14	FR15	
4	MTESTA0	MTESTA1	MTESTA2	MTESTA3	
5	MTESTB0	MTESTB1	MTESTB2	MTESTB3	
	M0 through M3 = 0				Firmware trap (previous instruction had software violations)
	M0 through M3 = 1				POWON (Trailing edge detected for power fail)
6	M0 through M3 = 2				External Interrupt INTR0
	M0 through M3 = 3				External Interrupt INTR1
Software	M0 through M3 = 4				External Interrupt INTR2
Interrupt	M0 through M3 = 5				TICOS (leading and trailing edge detected)
Prinet	M0 through M3 = 6				Not used
	M0 through M3 = 7				No interrupt pending (resume instruction sequence)
7	0	0	Q14	FCNT=0	Not applicable

A.2 MAJOR BRANCH TEST GROUPS 8 THROUGH 15

The major branch test groups 8 through 15 are defined in subsections A.2.1 through A.2.7.

A.2.1 Format Group (8)

The format group is enabled when RDDT bits 05 through 08 equal a hexadecimal 8. The format groups are further defined in Table A-2.

Table A-2. Format Groups (Sheet 1 of 2)

Input					Output	
F-Register (0)	F-Register (1-3)	F-Register (4-7)	F-Register (8)	F-Register (10-11)	M-Register (0-3)	Instruction Type
0	0	0	0	0-3	A	Generic
0	0	0	1	0-3	0	Illegal
0	0	1	X	0-3	0	Illegal
0	0	2-B	X	0-3	1	BI
0	0	C-E	X	0-3	0	Illegal
0	0	F	X	0-3	1	BI
0	1-7	0	0	0-2	4	SWS (Shift)
0	1-7	0	0	3	6	DWS (Shift)
0	1-7	0	1	0-3	6	DWS (Shift)
0	1-7	1-2	X	0-3	0	Illegal
0	1-7	3	X	0-3	B	CIP Branch
0	1-7	4-6	X	0-3	7	SIP Branch
0	1-7	7	0	0-3	2	BDC
0	1-7	7	1	0-3	3	BINC
0	1-7	8-B	X	0-3	1	BR
0	1-7	C-F	X	0-3	5	SI
1	0	0	0	0-3	8	IO
1	0	0	1	0-3	0	Illegal
1	0	1	X	0-3	8	IO
1	0	2	X	0-3	D	Read SO
1	0	3	0	0-3	0	Illegal
1	0	3	1	0-3	C	Write SO
1	0	4	X	0-3	E	SO
1	0	5	X	0-3	0	Illegal
1	0	6	0	0-3	D	Read SO
1	0	6	1	0-3	0	Illegal
1	0	7	X	0-3	C	Write SO
1	0	8-A	X	0-3	D	Read SO
1	0	B	0	0-3	D	Read SO
1	0	B	1	0-3	C	Write SO
1	0	C	0	0-3	C	Write SO
1	0	C	1	0-3	E	SO
1	0	D	0	0-3	E	SO
1	0	D	1	0-3	9	B-register group
1	0	E	X	0-3	D	Read SO
1	0	F	0	0-3	C	Write SO
1	0	F	1	0-3	D	Read SO
1	1-7	0	X	0-3	D	Read DO
1	1-7	1	0	0-3	0	Illegal
1	1-7	1	1	0-3	D	Read DO

Table A-2. Format Groups (Sheet 2 of 2)

Input					Output	
F-Register (0)	F-Register (1-3)	F-Register (4-7)	F-Register (8)	F-Register (10-11)	M-Register (0-3)	Instruction Type
1	1-7	2	X	0-3	D	Read DO
1	1-7	3	0	0-3	D	Read DO
1	1-7	3	1	0-3	C	Write DO
1	1-7	4-6	X	0-3	D	Read DO
1	1-7	7	X	0-3	C	Write DO
1	1-7	8	0	0-3	D	Read DO
1	1-7	8	1	0-3	E	SIP other than branch
1	1-7	9	0	0-3	D	Read DO
1	1-7	9	1	0-3	E	SIP other than branch
1	1-7	A	X	0-3	D	Read DO
1	1-7	B	0	0-3	D	Read DO
1	1-7	B	1	0-3	C	Write DO
1	1-7	C	0	0-3	E	SIP other than branch
1	1-7	C	1	0-3	9	B-register group
1	1-7	D	0	0-3	E	SIP other than branch
1	1-7	D	1	0-3	9	B-register group
1	1-7	E	0	0-3	D	Read DO
1	1-7	E	1	0-3	9	B-register group
1	1-7	F	X	0-3	C	Write DO

A.2.2 Op-Code Group (9)

The op-code group is enabled when RDDT bits 05 through 08 equal a hexadecimal 9. The op-code group is further defined in Table A-3.

Table A-3. Op-Code Group (Sheet 1 of 2)

Input			Output	Instruction	
F-Register (1-3)	F-Register (4-7)	F-Register (8)	M-Register (0-3)	Type	Mnemonic
0	0	0	5	IO	IO
0	0	1	0	Illegal	
0	1	0	5	IO	IOH
0	1	1	5	IO	IOLD
0	2	0	E	SO	NEG
0	2	1	6	SO	LB
0	3	0	0	Illegal	
0	3	1	D	SO	JMP
0	4	0	E	SO	AID
0	4	1	F	SO	SID
0	5	X	0	Illegal	
0	6	0	E	SO	CPL
0	6	1	0	Illegal	
0	7	0	7	SO	CL
0	7	1	F	SO	CLH
0	8	0	6	SO	LBF
0	8	1	F	SO	DEC
0	9	0	6	SO	LBT
0	9	1	F	SO	CMZ
0	A	0	6	SO	LBS
0	A	1	F	SO	INC
0	B	0	6	SO	LBC
0	B	1	F	SO	ENT
0	C	0	E	SO	STS
0	C	1	F	SO	LDI
0	D	0	E	SO	SDI
0	D	1	4	SO	CMN
0	E	0	E	SO	LEV
0	E	1	F	SO	CAD
0	F	0	E	SO	SAVE
0	F	1	F	SO	RSTR

Table A-3. Op-Code Group (Sheet 2 of 2)

Input			Output	Instruction	
F-Register (1-3)	F-Register (4-7)	F-Register (8)	M-Register (0-3)	Type	Mnemonic
1-7	0	0	2	DO	MTM
1-7	0	1	3	DO	LDH
1-7	1	0	0	Illegal	
1-7	1	1	3	DO	CMH
1-7	2	0	2	DO	SUB
1-7	2	1	3	DO	LLH
1-7	3	0	2	DO	DIV
1-7	3	1	F	DO	LNJ
1-7	4	0	2	DO	OR
1-7	4	1	3	DO	ORH
1-7	5	0	2	DO	AND
1-7	5	1	3	DO	ANH
1-7	6	0	2	DO	XOR
1-7	6	1	3	DO	XOH
1-7	7	0	2	DO	STM
1-7	7	1	F	DO	STH
1-7	8	0	9	DO	LDR
1-7	8	1	1	SIP	(May be redundant)
1-7	9	0	A	DO	CMR
1-7	9	1	1	SIP	(May be redundant)
1-7	A	0	C	DO	ADD
1-7	A	1	3	DO	SRM
1-7	B	0	2	DO	MUL
1-7	B	1	E	DO	LAB
1-7	C	0	1	SIP	(May be redundant)
1-7	C	1	4	DO	LDB
1-7	D	0	1	SIP	(May be redundant)
1-7	D	1	4	DO	CMB
1-7	E	0	8	DO	SWR
1-7	E	1	4	DO	SWB
1-7	F	0	B	DO	STR
1-7	F	1	4	DO	STB

A.2.3 Index Group (A)

The index group is enabled when RDDT bits 05 through 08 equal a hexadecimal A. The op-code group is further defined in Table A-4.

Table A-4. Index Group (Sheet 1 of 2)

Input				Output	
F-Register (1-3)	F-Register (4-7)	F-Register (8)	LAF[a]	M-Register (0-3)	Instruction Type/Mnemonic
0	0	0	X	2	Word
0	0	1	X	0	Illegal
0	1	X	X	6	Byte
0	2	0	X	2	Word
0	2	1	X	4	Bit
0	3	0	X	0	Illegal
0	3	1	X	2	Word
0	4	X	X	3	Double Word
0	5	X	X	0	Illegal
0	6	0	X	2	Word
0	6	1	X	0	Illegal
0	7	0	X	2	Word
0	7	1	X	6	Byte
0	8	0	X	4	Bit
0	8	1	X	2	Word
0	9	0	X	4	Bit
0	9	1	X	2	Word
0	A	0	X	4	Bit
0	A	1	X	2	Word
0	B	0	X	4	Bit
0	B	1	X	2	Word
0	C	0	X	2	Word
0	C	1	X	3	Double Word
0	D	0	X	3	Double Word
0	D	1	0	2	Word
0	D	1	1	3	Double Word
0	E	X	X	2	Word
0	F	X	X	2	Word
1-7	0	0	X	2	Word
1-7	0	1	X	6	Byte
1-7	1	0	X	0	Illegal
1-7	1	1	X	6	Byte
1-7	2	0	X	2	Word
1-7	2	1	X	6	Byte
1-7	3	X	X	2	Word
1-7	4	0	X	2	Word
1-7	4	1	X	6	Byte
1-7	5	0	X	2	Word
1-7	5	1	X	6	Byte
1-7	6	0	X	2	Word

Table A-4. Index Group (Sheet 2 of 2)

Input				Output	
F-Register (1-3)	F-Register (4-7)	F-Register (8)	LAF[a]	M-Register (0-3)	Instruction Type/Mnemonic
1-7	6	1	X	6	Byte
1-7	7	0	X	2	Word
1-7	7	1	X	6	Byte
1-7	8	0	X	2	Word
1-3	8	1	X	1	Scientific (2 or 4 words)
4	8	1	X	3	Double Word
5-7	8	1	X	1	Scientific (2 or 4 words)
1-7	9	0	X	2	Word
1-3	9	1	X	1	Scientific (2 or 4 words)
4	9	1	X	3	Double Word
5-7	9	1	X	1	Scientific (2 or 4 words)
1-7	A	X	X	2	Word
1-7	B	X	X	2	Word
1-3	C	0	X	1	Scientific (2 or 4 words)
4	C	0	X	5	Quad Word
5-7	C	0	X	1	Scientific (2 or 4 words)
1-7	C	1	0	2	Word
1-7	C	1	1	3	Double Word
1-3	D	0	X	1	Scientific (2 or 4 words)
4	D	0	X	5	Quad Word
5-7	D	0	X	1	Scientific (2 or 4 words)
1-7	D	1	0	2	Word
1-7	D	1	1	3	Double Word
1-7	E	0	X	2	Word
1-7	E	1	0	2	Word
1-7	E	1	1	3	Double Word
1-7	F	0	X	2	Word
1-7	F	1	0	2	Word
1-7	F	1	1	3	Double Word

[a]A One indicates Long Address Format (LAF).

A.2.4 Generic Group (B)

The generic group is enabled when RDDT bits 05 through 08 equal a hexadecimal B. The generic group is further defined in Table A-5.

Table A-5. Generic Group

Input		Output	
F-Register (9-11)	F-Register (12-15)	M-Register (0-3)	Instruction Mmemonic/Class
0	0	1	Halt
0	1	1	MCL
0	2	1	BRK
0	3	1	RTT
0	4	1	RTCN
0	5	1	RTCF
0	6	1	WDTN
0	7	1	WDTF
0	8	1	MMM
0	9	1	Generic (Unassigned)
0	A	1	ASD
0	B	1	VLD
0	C	1	LRDB
0	D	1	SRDB
0	E	1	Generic (Unassigned)
0	F	1	Generic (Unassigned)
1	0	2	STAX (LDT, STT, ACQ, RLQ)
1	1	3	RSC
1	2-F	0	Illegal
2	0-F	4	CIP
3	0-F	5	CIP (Illegal)
4	0-F	0	Illegal
5	0-F	0	Illegal
6	0	6	DQA
6	1	7	QOT
6	2	8	DQH
6	3	9	QOH
6	4-F	0	Illegal
7	0-F	0	Illegal

A.2.5 Address Syllable Group (C)

The address syllable group is enabled when RDDT bits 05 through 08 equal a hexadecimal C. The address syllable group is further defined in Table A-6.

Table A-6. Address Syllable Group

Input			Output	
F-Register (9-11)	F-Register (12)	F-Register (13-15)=10	M-Register (0-3)	Comments Address Type
0	0	0	1	IMA
0	0	1-7	3	BN
0	1	0	2	IMA
0	1	1-7	4	BN
1	0	0	5	IMA+R1
1	0	1-7	6	BN&R1
1	1	0	5	IMA[a]+R1
1	1	1-7	7	BN[a]+R1
2	0	0	5	IMA+R2
2	0	1-7	6	BN+R2
2	1	0	5	IMA[a]+R2
2	1	1-7	7	BN[a]+R2
3	0	0	5	IMA+R3
3	0	1-7	6	BN+R3
3	1	0	5	IMA[a]+R3
3	1	1-7	7	BN[a]+R3
4	0	0	8	P+DSP
4	0	1-7	8	BN+DSP
4	1	0	8	(P+DSP)
4	1	1-7	8	(BN+DSP)
5	0	0	0	Reserved
5	0	1-7	B	BN,RN(RAS)
5	1	0	0	Reserved
5	1	1-3	C	BN+R1
5	1	4	0	Reserved
5	1	5-7	D	B(N-4)+R1
6	0	0	0	Reserved
6	0	1-7	E	BN(Push)
6	1	0	0	Reserved
6	1	1-3	C	BN+R2
6	1	4	0	Reserved
6	1	5-7	D	B(N-4)+R2
7	0	0	9	IMO
7	0	1-7	F	BN[a](Pop)
7	1	0	A	IV+DSP
7	1	1-3	C	BN+R3
7	1	4	0	Reserved
7	1	5-7	D	B(N-4)+R3

[a]Indirect Address

A.2.6 CIP Data Descriptor Address Syllable Group (D)

The CIP data descriptor address syllable group is enabled when RDDT bits 05 through 08 equal a hexadecimal D. The CIP data descriptor address syllable group is further defined in Table A-7.

Table A-7. CIP Data Descriptor Address Syllable Group

Input			Output	
F-Register (9-11)	F-Register (12)	F-Register (13-15)=N	M-Register (0-3)	Comments
0	0	0	1	Remote
0	0	1-7	6	D+DSP
0	1	0	2	P+DSP
0	1	1-7	7	(B+DSP)[a]
1	0	0	1	Remote
1	0	1-7	8	BN+DISP+R1
1	1	0	4	P+DISP+R1
1	1	1-7	9	(BN+DISP)[a] +R1
2	0	0	1	Remote
2	0	1-7	8	BN+DISP+R2
2	1	0	4	P+DISP+R2
2	1	1-7	9	(BN+DISP)[a] +R2
3	0	0	1	Remote
3	0	1-7	8	BN+DISP+R3
3	1	0	4	P+DISP+R3
3	1	1-7	9	(BN+DISP)[a] +R3
4	0	0	1	Remote
4	0	1-7	8	BN+DISP+RS
4	1	0	3	(P+DSP)[a]
4	1	1-7	9	(BN+DISP)[a] +R4
5	0	0	1	Remote
5	0	1-7	8	BN+DISP+R5
5	1	0	0	RFU(Illegal)
5	1	1-7	9	(BN+DISP)[a] +R5
6	0	0	1	Remote
6	0	1-7	8	BN+DISP+R6
6	1	0	0	RFU(Illegal)
6	1	1-7	9	(BN+DISP)[a] +R6
7	0	0	1	Remote
7	0	1-7	8	BN+DISP+R7
7	1	0	5	IMO
7	1	1-7	9	(BN+DISP)[a] +R7

[a] Indirect Address

A.2.7 PBRANCH Group (E)

The PBRANCH group is enabled when RDDT bits 05 through 08 equal a hexadecimal E. The result of the test conditions (M0 through M3) is shown below:

RDDT 05-08	M 0	M1	M2	M3
E	0	PBRANCH	F9TEZ	FR15

The PBRANCH indicator equals One if FR08 equals Zero and the condition tested is true, or if FR08 equals One and the condition tested is false. The PBRANCH conditions are listed in Table A-8.

Table A-8. PBRANCH Group

Selection Bits			
F-Register (1-3)	F-Register (4-7)	Condition Tested	Remarks
0	0-1	0	Not used in L6
0	2	I(L)	Less than indicator
0	3	I(G)	Greater than indicator
0	4	I(OV)	Overflow indicator
0	5	I(B)	Bit test indicator
0	6	I(C)	Carry indicator
0	7	I(I)	Input/output indicator
0	8	$\overline{I(U) + I(L)}$	Arithmetic less than
0	9	I(G) + I(L)	Equal
0	A	I(U) + I(G)	Arithmetic greater than
0	B	I(U)	Unlike signs indicator
0	C-E	0	Not used in L6
0	F	0	NOP/Unconditional Branch
1-7	0-6	SEL M-register bit	See Note 1
1-7	7	TF2 } See	Carry 16=1
1-7	8	TF0 } Note	BI00 = 1
1-7	9	$\overline{TF1}$ } 2	BI00-15 = 0
1-7	A	$\overline{(TF0+TF1)}$	BI00-15 > 0
1-7	B	TF7	BI15 = 0
1-7	C-F	0	Not used in L6

NOTES

1. M-register selected by register file address bits. The bit in the M-register field is selected by F-register bits 01-03.

2. Temporary flip-flops store information from the previous microcycle.

Appendix B
TIMING

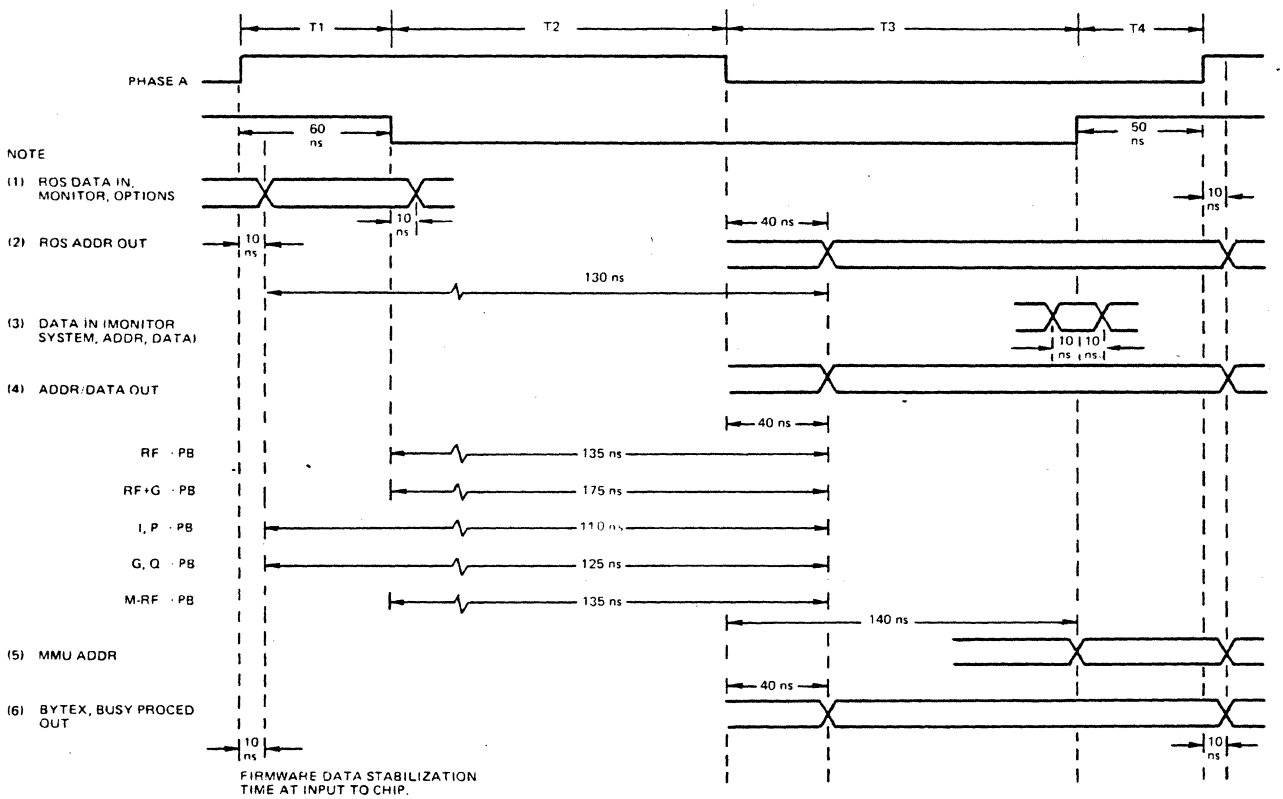
This appendix provides a detailed timing description of the LSI-6 microprocessor chip. Figure B-1 shows the timing requirements for interfacing with the external system. Figure B-2 indicates which clock signal transition controls the latching, setting, resetting, or loading of all internal registers, flip-flops, and latches. Figure B-3 lists events that occur during the four time slots (T1 through T4) that are generated internally from Phase A and Phase B clock signals.

NOTE

> The stated chip time delays are preliminary, based upon computer simulation. Final timing numbers will be specified after the LSI-6 has been fabricated and characterized.

Figure B-3 also includes the minimum slot times required by internal functional blocks. Some conflicts exist with these times but they are resolved when specific operations are considered. For example, a register file Read operation requires that T1 plus T2 have a minimum time of 110 nanoseconds. However, if an MMU address is being developed, T1 plus T2 will have a minimum time of 185 nanoseconds. This allows variable frequency clocking (depending upon the instruction being executed) to allow a user to maximize performance.

Figure B-4 illustrates three possible types of operation that can occur internally and the timing relationship associated with each operation. The times that are presented in the figure are typical times and can vary depending on the type of transfer.



NOTES

1. ROS ADDRESS IN: ROS DATA 00-48

   MONITOR BITS - OPTIONS:

SIPE	LAFE
CIPE	MEMVAL
MMUE	

2. ROS ADDR OUT: ROS ADDRESS 00-11

3. DATA IN:

   (A) MONITOR BITS - SYSTEM STATUS:

TESTBR1[a]	OBC
BYTEX(IN)[a]	MEMPAR
PROCED(IN)[a]	MEMPRES
BUSY(IN)[a]	MPLOCK[d]
DET0-4	POWON
INTR0-2	MEM RFRH
MIBGP0-3	

   (B) ADDRESS/DATA:

   BUS DATA 00-15

4. ADDR/DATA OUT: BUS ADDRESS 00-15
   BUS DATA 00-15

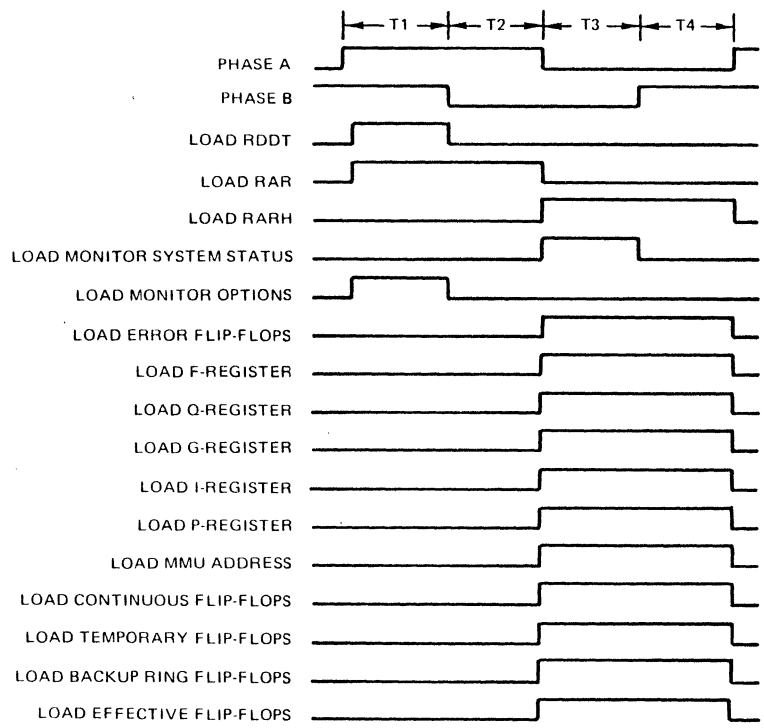
   TIMING IS SHOWN FOR THE VARIOUS SOURCES OF ADDRESS/DATA INFORMATION INTERNALLY. INFORMATION IS AVAILABLE AT THE OUTPUT OF THE CHIP AFTER THE INDICATED DELAY, OR 40 NANOSECONDS AFTER THE FALLING EDGE OF PHASE A, WHICHEVER IS GREATER.

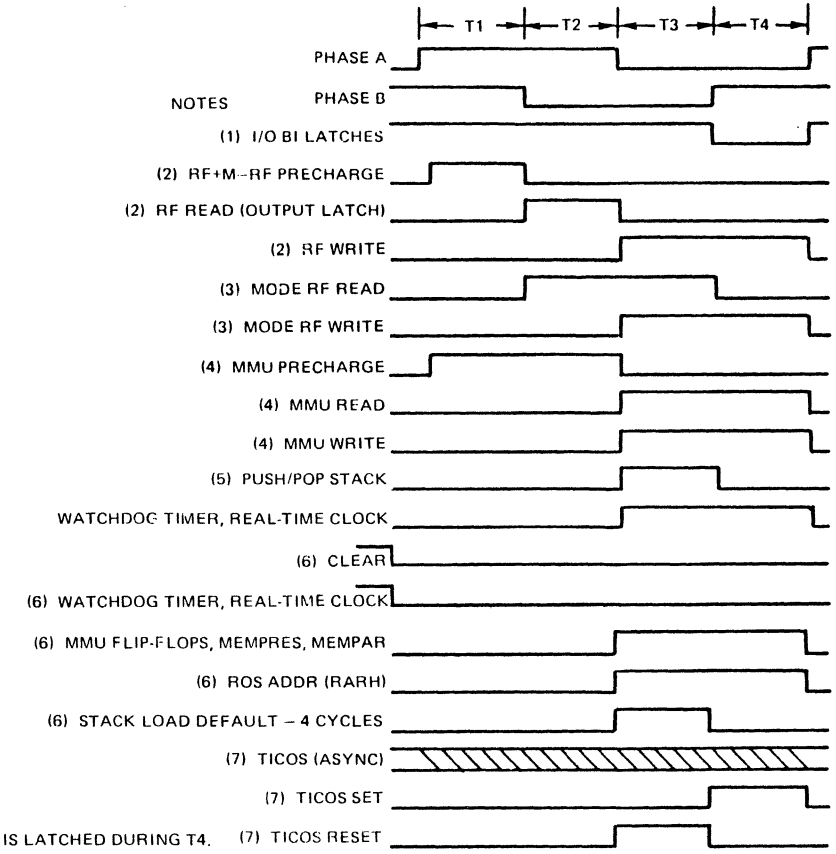
5. MMU ADDR: BUS ADDRESS 00-15
   MEMKIL

6. BYTEX(OUT)
   BUSY(OUT)
   PROCED(OUT)

*REFER TO TABLE 4-3 FOR LSI-6 NOMENCLATURE.

Figure B-1. External System Timing Requirements





NOTES

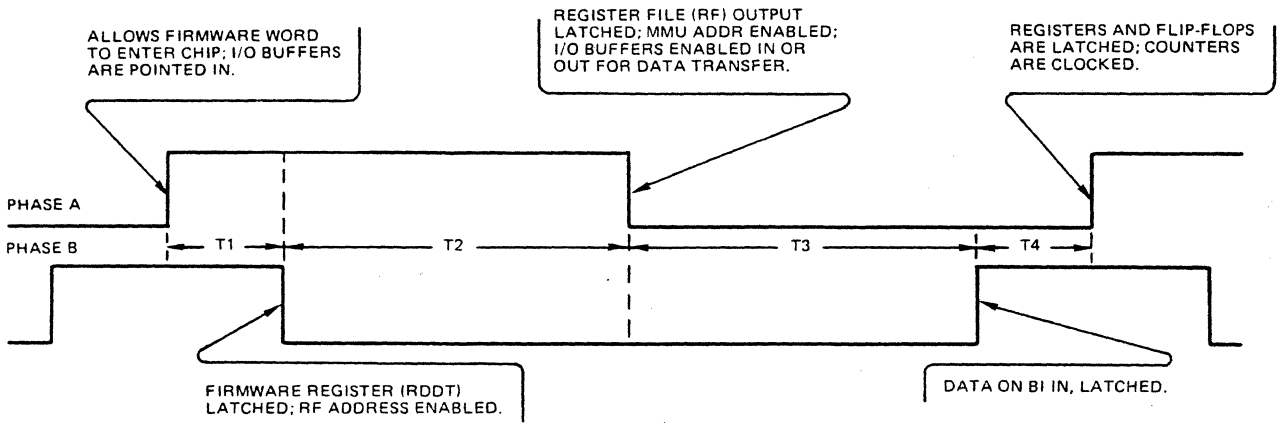
1. INTERNAL OR EXTERNAL SOURCES CAN DRIVE THE INTERNAL BUS (BI) DURING T3, BI IS LATCHED DURING T4.
2. REGISTER FILE (RF): DURING PRECHARGE, ALL REGISTER FILE OUTPUT IS LOW; OUTPUT IS ENABLED DURING PHASE A, BUT VALID DATA DOES NOT APPEAR UNTIL AFTER T2 ENABLES THE FILE ADDRESS. OUTPUT IS LATCHED AT THE END OF T2. NO PRECHARGE OCCURS DURING WRITE OPERATIONS.
3. OPERATION OF THE MODE RF (M-RF) IS THE SAME AS THE RF.
4. MMU-RF: DURING PRECHARGE, THE DESCRIPTOR ARRAY OUTPUT IS LOW, EXCEPT FOR BIT 0 WHICH IS HIGH. THIS PREVENTS ANY MMU ERROR CONDITIONS FROM BEING DETECTED FALSELY DURING PRECHARGE. FILE ACCESS DOES NOT BEGIN UNTIL T3.
5. STACK: DATA INTO THE STACK IS LOADED DURING PHASE A AND HELD DURING PHASE A, IN LATCHES; DATA IS TRANSFERRED TO/FROM STACK DURING T3.
6. CLEAR FUNCTIONALITY:

   MMU FLIP-FLOPS, MEMPRES, AND MEMPAR ARE RESET ON FIRST PHASE A FALLING TRANSITION.

   ROS ADDR IS FORCED TO ALL ZEROS ON FIRST $\overline{\phi A}$ FALLING EDGE.

   STACK IS "POPPED" FOUR TIMES TO FILL IT WITH DEFAULT CODE (0001); FOUR T3 TIMES ARE REQUIRED.
7. TICOS IS AN ASYNCHRONOUS SIGNAL HAVING A TRANSITION EVERY 8.33 MILLISECONDS. IT IS STROBED INTO AN EDGE TRIGGERED FLIP-FLOP AT T3; THE FLIP-FLOP CAN BE EDGE TRIGGERED RESET AT T2 UNDER FIRMWARE CONTROL.

Figure B-2. Internal Timing Requirements



CLOCK INPUTS

PHASE A – CONTROLS DIRECTION OF THE DATA FLOW INTO AND OUT OF THE CHIP; THAT IS, TRISTATE ENABLE/DISABLE. THE LEADING AND TRAILING EDGES LATCH REGISTERS AND FLIP-FLOPS.

PHASE B – USED AS A STROBE PULSE FOR LATCHING I/O DATA.

INTERNAL TIMESLOTS

T1 ↕A•↕B. THE FIRMWARE WORD IS LOADED INTO THE CHIP; THE I/O BUFFERS ARE POINTED IN; THE RF, M-RF, AND MMU RF ARE BEING PRECHARGED; A MINIMUM OF 60 NANOSECONDS IS REQUIRED FOR FIRMWARE REGISTER SETUP TIME AND FILE PRECHARGE TIME.

T2 ↕A•↕$\overline{B}$. RF/ALU/DATA OPERATIONS OCCUR; THE NEXT FIRMWARE ADDRESS IS GENERATED; THE I/O BUFFERS ARE POINTED IN; THE MMU IS BEING PRECHARGED; THE RF AND M-RF ACCESS OCCURS A MINIMUM OF 60 NANOSECONDS.

T3 $\overline{\updownarrow A \bullet \updownarrow B}$. MMU OPERATION OCCURS; THE I/O DRIVERS ARE POINTED IN OR OUT; THE NEXT FIRMWARE ADDRESS IS SENT OUT; THE PUSH/POP OF THE FIRMWARE STACK OCCURS.

T4 $\overline{\updownarrow A}$•↕B. DATA ON THE INTERNAL BUS IS LATCHED; A MINIMUM OF 50 NANOSECONDS FOR RF SETUP.

T1 + T2 EQUALS A MINIMUM OF 195 NANOSECONDS FOR MMU PRECHARGE TIME IF DESCRIPTOR ARRAY ADDRESS IS INDEXED; 155 NANOSECONDS MINIMUM TIME IF ADDRESS IS NOT INDEXED.

Figure B-3. Time Slot Events with Phase A and Phase B

Figure B-4A illustrates the internal chip timing assuming the following conditions: ROS address stable, external ROS firmware based on 80-nanosecond access PROMS, and RF+G --> MMU --> PB.

Figure B-4B illustrates address timing with MMU active assuming the following conditions: RF+G --> BI and BI --> MMU --> PB.

Figure B-4C illustrates data out timing or address out timing with MMU not active assuming the following conditions: ROS address stabilized and RF+G --> PB.

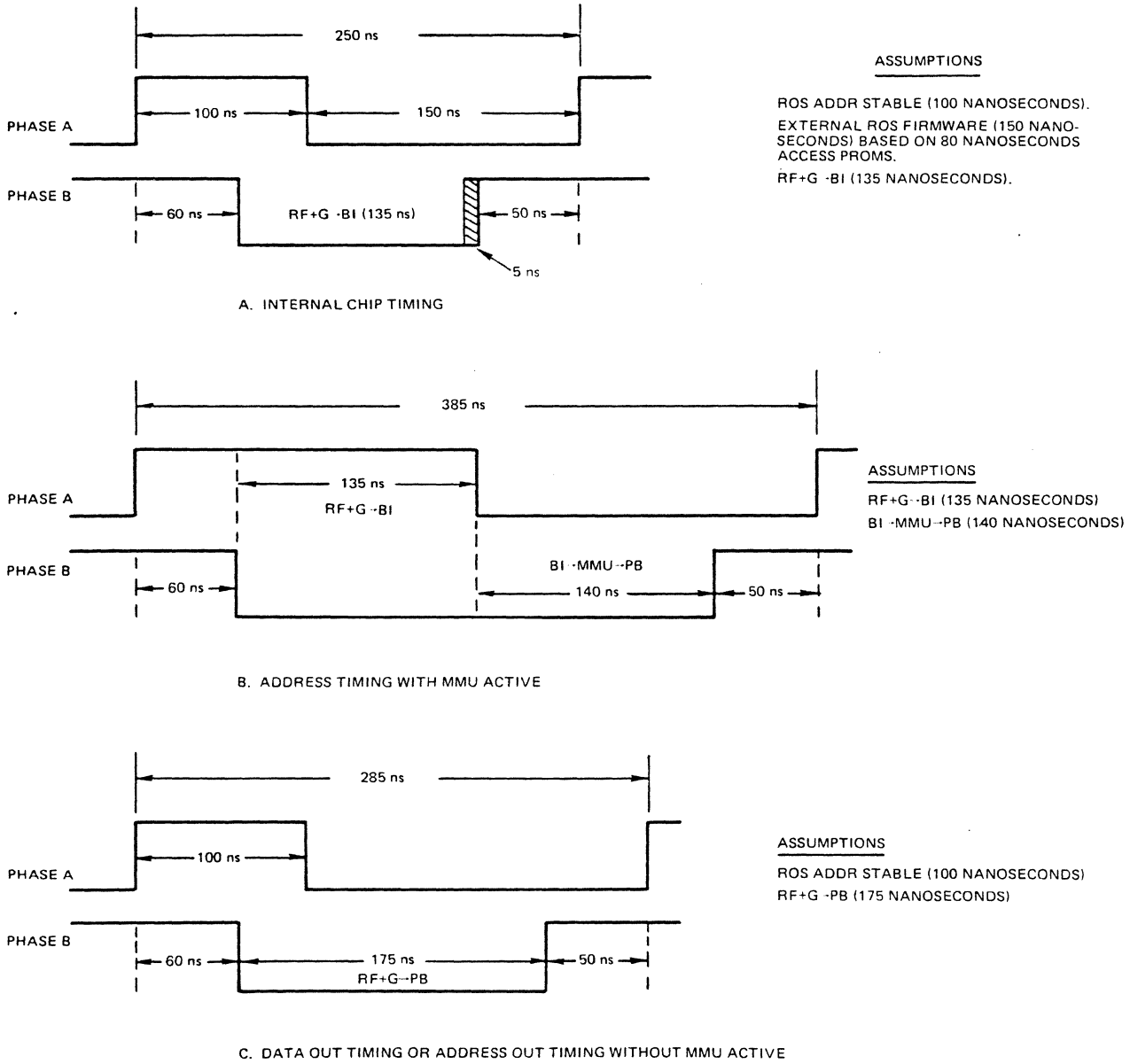


Figure B-4. Optimum Microcycle Timing of Phase A and Phase B

Appendix C
PIN IDENTIFICATION AND PLACEMENT

The LSI-6 microprocessor chip incorporates a 68-pin leadless chip. The chip is mounted on a 68-pin Dual Inline Package (DIP) socket which is then soldered on a Printed Wire Assembly (PWA). Figure C-1 illustrates the pin identification and placement as viewed from the component side of the PWA. Table C-1 provides the interface signal name associated with each pin.

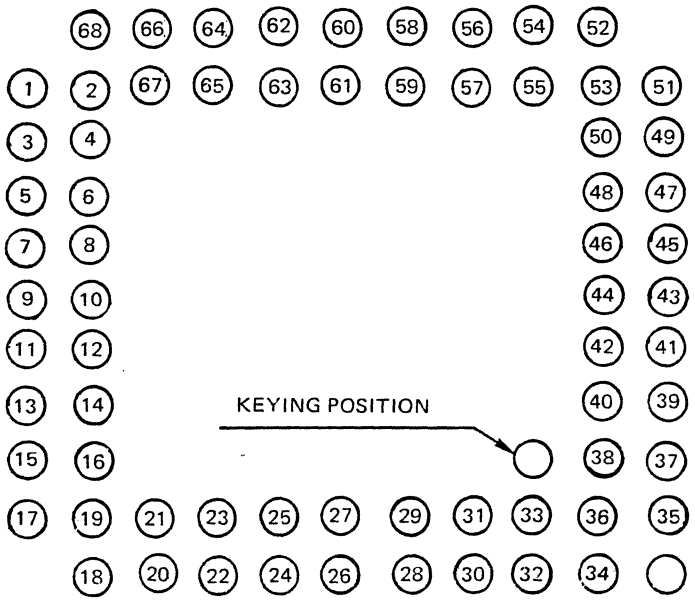


Figure C-1. Pin Identification and Placement

Table C-1. Interface Signal Name to Pin Number Correlation

Pin No.	Interface Signal Name	Pin No.	Interface Signal Name
1	VBB (-5V)	35	DATRQ1-33
2	No connection	36	MEMPAR-P0
3	No connection	37	MREFSH-P4
4	INTRQ2-28	38	DATRQ0-32
5	POWRON+22	39	DATRQ2-27
6	DABS15+47	40	RSAD11+12
7	DABS14+46	41	RSAD10+11
8	DABS13+45	42	RSAD9+10
9	DABS12+44	43	RSAD8+9
10	DABS11+43	44	RSAD7+8
11	DABS10+42	45	RSAD6+7
12	DABS09+41	46	RSAD5+6
13	DABS08+40	47	RSAD4+5
14	VCC (+5V)	48	RSAD3+4
15	VSS (GND)	49	RSAD2+3
16	PHASE B (ØB)	50	RSAD1+2
17	PHASE A (ØA)	51	RSAD0+1
18	DABS07+39	52	VSS (GND)
19	DABS06+38	53	VCC (+5V)
20	DABS05+37	54	BYTEXX-00[a]
21	DABS04+36	55	BUSYXX-P1[a]
22	DABS03+35	56	ONBDCN-0A[a]
23	DABS02+25	57	MPLOCK[a]
24	DABS01+24	58	PROCED-P2[a]
25	DABS00+23	59	MIBGP0+13[a]
26	DABS0A+21	60	MIBGP1+14[a]
27	DABS0B+20	61	MIBGP2+15[a]
28	DABS0C+19	62	MIBGP3+16[a]
29	DABS0D+18	63	TSTBR1+17[a]
30	MEMPRES-P3	64	No connection
31	CLEARX-0A	65	TICKOS+0A
32	DATRQ4-34	66	INTRQ0-30
33	DATRQ3-26	67	INTRQ1-29
34	MEMKIL+31	68	No connection

[a] Refer to Table 2-9 for LSI-6 equivalent nomenclature.

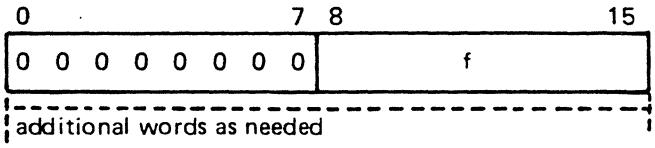
Appendix D
LEVEL 6 INSTRUCTION SET

SECTION 1

INSTRUCTION TYPES

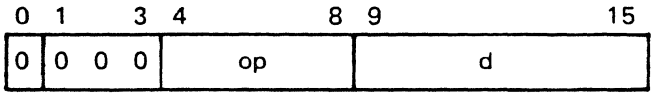
Type/Source Format | **Memory Format**

Generic (GE)
[label] op



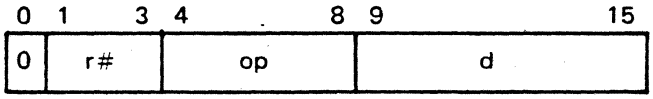
f — Function.

Branch on Indicators (BI)
[label] op branchloc



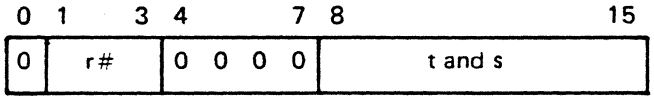
d — Displacement, calculated by the assembler as follows:
If "<branchloc" is coded, d = 0 and the next word(s) contain a pointer to branchloc
If "branchloc" is coded, d = 1 and the next word contains the displacement (DSP) to branchloc. If ">branchloc" is coded, d = −64 through +63, which is the displacement to branchloc; ">branchloc" must not tag this instruction or the next word.

Branch on Registers (BR)
[label] op r#,branchloc



d — See "Branch on Indicators," above.

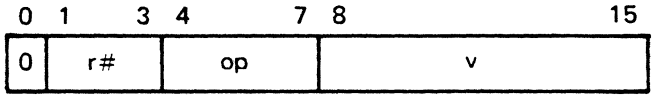
Shift Short (SHS) and
Shift Long (SHL).
[label] op r#,s



t — Type and direction of shift. Requires bits 8 — 11 for SHS and bits 8 — 10 for SHL.

s — Shift distance. Requires bits 12 — 15 for SHS and bits 11 — 15 for SHL. (If s = 0, the shift distance is obtained from R1.)

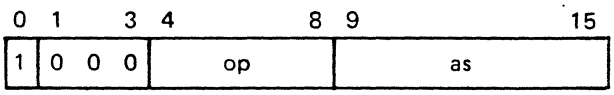
Short Value Immediate (SI)
[label] op r#,v



v — Value between −128 and +127.

Input/Output (I/O)
See Systems Handbook, CC71

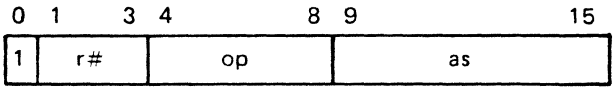
Single Operand (SO
[label] op as[,maskword]



as —See "Address Syllable."

maskword — Used only in SAVE, RSTR, and (optionally) bit instructions. If maskword is all zeros, the mask is obtained from R1.

Double Operand (DO)
[label] op r#,as[,maskword]



as — See "Address Syllable."

maskword — Used only in SRM instruction. If maskword is all zeros, the mask is obtained from R1.

DSP	16-bit displacement (–32,768 through +32,767)
op	Operation code
r#	Register number
[]	Optional

SECTION 2

BASIC INSTRUCTIONS

Mnemonic	Type	Description	Operation
ADD	DO	Add to R Reg	R# ← R# + [EA] I(ov), I(c) affected
ADV	SI	Add Value to R Reg	R# ← R# + V I(ov), I(c) affected
ACQ	GE	Acquire Stack Space	See Note
AID	SO	Add Double Word Integer	R6, R7, ← R6, R7 + [EA] I(ov), I(c) affected
AND	DO	AND With R Reg	R# ← R#∧[EA]
ANH	DO	AND Halfword With R Reg	R# ← R#∧[EA] sign extended
ASD	GE	Activate Segment Descriptor	See Note
B	BI	Branch	P ← EA
BAG	BI	Br Alg Greater Than	If I(g) ⊕ I(u) = 1, then P ← EA
BAGE	BI	Br Alg Greater Than or Equal	If I(l) ⊕ I(u) = 0, then P ← EA
BAL	BI	Br Alg Less Than	If I(l) ⊕ I(u) = 1, then P ← EA
BALE	BI	Br Alg Less Than or Equal	If I(g) ⊕ I(u) = 0, then P ← EA
BBF	BI	Br on Bit Test Indicator False	If I(b) = 0, then P ← EA
BBT	BI	Br on Bit Test Indicator True	If I(b) = 1, then P ← EA
BCF	BI	Br on Carry False	If I(c) = 0, then P ← EA
BCT	BI	Br on Carry True	If I(c) = 1, then P ← EA
BDEC	BR	Br After Decrementing R Reg	R# ← R# + FFFF; if R# ≠ FFFF, then P ← EA
BE	BI	Br Equal	If I(l) ∨ I(g) = 0, then P ← EA
BEVN	BR	Br if R Reg Even	If R#(15) = 0, then P ← EA
BEZ	BR	Br if R Reg Equal to Zero	If R# = 0, then P ← EA
BG	BI	Br Greater Than	If I(g) = 1, then P ← EA
BGE	BI	Br Greater Than or Equal	If I(l) = 0, then P ← EA
BGEZ	BR	Br if R Reg Greater Than or Equal to Zero	If R#(0) = 0, then P ← EA
BGZ	BR	Br if R Reg Greater Than Zero	If R#(1:15) ≠ 0 and R#(0) = 0, then P ← EA

Mnemonic	Type	Description	Operation
BINC	BR	Br After Incrementing R Reg	R# ← R# + 0001; If R# ≠ 0, then P ← EA
BIOF	BI	Br on I/O Indicator False	If I(i) = 0, then P ← EA
BIOT	BI	Br on I/O Indicator True	If I(i) = 1, then P ← EA
BL	BI	Br Less Than	If I(l) = 1, then P ← EA
BLE	BI	Br Less Than or Equal	If I(g) = 0, then P ← EA
BLEZ	BR	Br if R Reg Less Than or Equal to Zero	If R#(0) = 1 or P# = 0, then P ← EA
BLZ	BR	BR if R Reg Less Than Zero	If R#(0) = 1, then P ← EA
BNE	BI	Br Not Equal	If I(l) ∨ I(g) = 1, then P ← EA
BNEZ	BR	Br if R Reg Not Equal to Zero	If R# ≠ 0, then P ← EA
BNOV	BI	Br on Not Overflow	If I(ov) = 0, then P ← EA
BODD	BR	Br if R Reg Odd	If R#(15) = 1, then P ← EA
BOV	BI	Br on Overflow	If I(ov) = 1, then P ← EA
BRK	GE	Breakpoint	Generate trap via Trap Vector #2.
BSE	BI	Br Signs Equal	If I(u) = 0, then P ← EA
BSU	BI	Br Signs Unlike	If I(u) = 1, then P ← EA
CAD	SO	Carry Add	[EA] ← [EA] + I(c) I(ov), I(c) affected
CL	SO	Clear Memory	[EA] ← 0000
CLH	SO	Clear Memory Halfword	[EA] ← 00
CMB	DO	Compare B Reg	B# :: [EA] I(g), I(l) affected I(u) affected but undefined
CMH	DO	Compare R Reg With Halfword	R# :: [EA] sign extended I(g), I(l), I(u) affected
CMN	SO	Compare With Null	[EA] :: Null Address I(g), I(l) affected I(u) affected but undefined
CMR	DO	Compare R Reg	R# :: [EA] I(g), I(l), (u) affected
CMV	SI	Compare R Reg With Value	R# :: V sign extended I(g), I(l), I(u) affected
CMZ	SO	Compare With Zero	[EA] :: 0000 I(g), I(l), I(u) affected
CNFG	GE	Configure	See Note
CPL	SO	Complement	[EA] ← [EA] ⊕ FFFF

Mnemonic	Type	Description	Operation
DAL	SHL	Dbl Shift Arith Left	See Note
DAR	SHL	Dbl Shift Arith Right	See Note
DCL	SHS	Dbl Shift Closed Left	See Note
DCR	SHS	Dbl Shift Closed Right	See Note
DEC	SO	Decrement	[EA] ← [EA] + FFFF; I(b) ← [EA] (0) I(ov), I(c), I(b) affected
DIV	DO	Divide R Reg	R# ← R# / [EA] except if r# = R7, then R7 ← R6, R7 / [EA] and R6 ← remainder I(ov), I(c) affected
DOL	SHL	Dbl Shift Open Left	See "Shift Instructions"
DOR	SHL	Dbl Shift Open Right	See "Shift Instructions"
DOA	GE	Dequeue by Address	See Note
DQH	GE	Dequeue from Head	See Note
ENT	SO	Enter	P ← EA;S(p) ← 0
HLT	GE	Halt	See Note
INC	SO	Increment	I(b) ← [EA] (0); [EA] ← [EA] + 0001 I(ov), I(c), I(b) affected
IO	I/O	Input/Output (Word)	See Note
IOH	I/O	Input/Output Halfword	See Note
IOLD	I/O	Input/Output Load	See Note
JMP	SO	Jump	P ← EA
LAB	DO	Load EA Into B Reg	B# ← EA
LB	SO	Load Bit	I(b) ← [EA] i (if indexed) I(b) ← ∨ [EA] m (if masked) I(b) affected
LBC	SO	Load Bit and Complement	I(b) ← [EA] i; / [EA] i ← $\overline{[EA]\ i}$ } (if indexed) I(b) ← ∨ [EA] m; / [EA] m ← $\overline{[EA]\ m}$ } (if masked) I(b) affected
LBF	SO	Load Bit and Set False	I(b) ← [EA] i / [EA] i ← 0 } (if indexed) I(b) ← ∨[EA] m; / [EA]m ← 0 } (if masked) I(b) affected
LBS	SO	Load Bit and Swap	I(b) ⟷ [EA] i (if indexed) Temp ← I(b); I(b) ← ∨[EA] m; } (if masked) [EA] m ← Temp i(b) affected

Mnemonic	Type	Description	Operation
LBT	SO	Load Bit and Set True	I(b) ← [EA] i; [EA] i ← 1 } (if indexed) I(b) ← V[EA] m; [EA] m ← 1 I(b) affected } (if masked)
LDB	DO	Load B Reg	B# ← [EA]
LDH	DO	Load Halfword Into R Reg	R# ← [EA] sign extended
LDI	SO	Load Doubleword Integer	R6, R7 ← [EA]
LDR	DO	Load R Reg	R# ← [EA]
LDT	GE	Load T Register	T ← B#
LDV	SI	Load Value Into R Reg	R# ← V sign extended
LEV	SO	Level Change	See Note
LLH	DO	Load Logical Halfword	R#(8:15) ← [EA]; R#(0:7) ← 00
LNJ	DO	Load B Reg and Jump	B# ← NSIA;P ← EA
LRDB	GE	Load Remote Descriptor Base Register	RDBR ← B3
MCL	GE	Monitor Call Via Trap	Generate trap via Trap Vector #1
MLV	SI	Multiply R Reg by Value	R# ← R# * V except if r# = 7, then R6, R7 ← R7 *V I(ov) affected
MMM	GE	Memory to Memory Move	See Note
MTM	DO	Modify Test M Reg	See Note
MUL	DO	Multiply R Reg	R# ← R# * [EA] except if r# = R7, then R6, R7 ← R7 * [EA] I(ov) affected
NEG	SO	Negate	[EA] ← 0000 [EA] I(ov), I(c) affected
NOP	BI	No Operation	None
OR	DO	OR With R Reg	R# ← R# V [EA]
ORH	DO	OR Halfword With R Reg	R# ← R# V [EA] sign extended
QOH	GE	Queue on Head	See Note
QOT	GE	Queue on Tail	See Note
RLQ	GE	Relinquish Stack Space	See Note
RSTR	SO	Restore Context	See Note

Mnemonic	Type	Description	Operation
RTCF	GE	Real Time Clock Off	See Note
RTCN	GE	Real Time Clock On	See Note
RTT	GE	Return From Trap	See Note
SAL	SHS	Sgl Shift Arith Left	See "Shift Instructions"
SAR	SHS	Sgl Shift Arith Right	See "Shift Instructions"
SAVE	SO	Save Context	See Note
SCL	SHS	Sgl Shift Closed Left	See "Shift Instructions"
SCR	SHS	Sgl Shift Closed Right	See "Shift Instructions"
SDI	SO	Store Doubleword Integer	[EA] ← R6, R7
SID	SO	Subtract Doubleword Integer	R6, R7 ← R6, R7 + [EA] + 1; I(ov), I(c) affected
SOL	SHS	Sgl Shift Open Left	See "Shift Instructions"
SOR	SHS	Sgl Shift Open Right	See "Shift Instructions"
SRDB	GE	Store Remote Descriptor Base Register	B3 ← RDBR
SRM	DO	Store Reg Masked	[EA] ← (R#∧m)∨ ([EA]∧$\overline{m}$)
STB	DO	Store B Reg	[EA] ← B#
STH	DO	Store Halfword From R Reg	[EA] ← R# (8:15)
STM	DO	Store M Reg	[EA] (8:15) ← M1 [EA] (0:7) ← FF If r# ≠ M1, generate trap via Trap Vector #5 (Model 33 only)
STR	DO	Store R Reg	[EA] ← R#
STS	SO	Store S Reg	[EA] ← S
STT	GE	Store T Reg	B ← T
SUB	DO	Subtract From R Reg	R# ← R# ← [EA] I(ov), I(c) affected
SWB	DO	Swap B Reg	B# ⟷ [EA]
SWR	DO	Swap R Reg	R# ⟷ [EA]
VLD	GE	Validate	See Note
WDTF	GE	Watchdog Timer Off	See Note
WDTN	GE	Watchdog Timer On	See Note
XOH	DO	Exclusive OR Halfword With R Reg	R# ← R# ⊕ [EA] sign extended
XOR	DO	Exclusive OR With R Reg	R# ← R# ⊕ [EA]

B#	Value store specified B register
EA	Effective address
[EA]	Value of operand (bit, halfword, word, doubleword) pointed to by the effective address
[EA] (0)	Value of bit 0 of operand pointed to by the effective address
[EA] (0:7)	Value of bits 0 through 7 of operand pointed to by the effective address
[EA] (8:15)	Value of bits 8 through 15 of operand pointed to by the effective address
$\underline{[EA]\ i}$	Value of single bit obtained through an indexed address
$\overline{[EA]\ i}$	Complement value of single bit obtained through an indexed address
[EA] m	Value of each masked bit in the word pointed to be the effective address
$\overline{[EA]\ m}$	Complement value of each masked bit in the word pointed to by the effective address
V[EA] m	Single bit value obtained by an inclusive OR operation on the logical product of (1) the designated mask and (2) the word pointed to be the effective address
I(b)	"Bit test" indicator bit of I register
I(c)	"Carry" indicator bit of I register
I(g)	"Greater than" indicator bit of I register
I(i)	"Input/output" indicator bit of I register
I(l)	"Less than" indicator bit of I register
I(ov)	"Overflow" indicator bit of I register
I(u)	"Unlike signs" indicator bit of I register
m	Value of mask operand
$\overline{m}$	Complement of mask operand value
M#	Specified M register
NSIA	Next sequential instruction address
P	Program counter (P register)
r#	Register number
R#	Specified R register
R#(0)	Bit 0 of specified R register
R#(15)	Bit 15 of specified R register
R#(0:7)	Bits 0 through 7 of specified R register
R#(1:15)	Bits 1 through 15 of specified R register
R#(8:15)	Bits 8 through 15 of specified R register
S	S register
S(p)	"Privilege state" bits of S register
Temp	Temporary storage location for a single bit; the value stored in this temporary storage location
T	Stack address register
V	Value in bits 8 through 15 of this instruction

⊕	Exclusive OR
∨	Inclusive OR
∧	Logical AND
/	Division operator
*	Multiplication operator
;	Separator for nonsimultaneous operations
::	Is compared with
←	Is replaced by
⟷	Is exchanged with

NOTE: Refer to Systems Handbook, CC71

SECTION 3

SCIENTIFIC INSTRUCTIONS (ALPHABETICAL)

Mnemonic	Type	Description	Operation
SAD	DO	Scientific Add	[SA#] ← [SA#] + [EA]
SBE	BI	Branch if Equal	If [SI (L) V SI (G) = 0, then [P] ← EA
SBEU	BI	Branch on Exponent Underflow	If [SI (EUF)] = 1, then [P] ← EA
SBEZ	BR	Branch on SA = 0	If [SA# (f)] = 0, then [P] ← EA
SBG	BI	Branch on Greater Than	If [SI (G)] = 1, then [P] ← EA
SBGE	BI	Branch on Greater Than or Equal to	If (SI (L)] = 0, then [P] ← EA
SBGEZ	BR	Branch on SA ⩾ 0	If [SA# (s)] = 0, or if [SA# (f) = 0, then [P] ← EA
SBGZ	BR	Branch on SA > 0	If [SA# (f)] ≠0 and [SA# (s)] = 0, then [P] ← EA
SBL	BI	Branch on Less Than	If [SI (L)] = 1, then [P] ← EA
SBLE	BI	Branch on Less Than or Equal to	If [SI (G)] : 0, then [P] ← EA
SBLEZ	BR	Branch on SA ⩽ 0	If [SA# (f)] = 0 or if [SA# (s)] = 1, then [P] ← EA
SBLZ	BR	Branch on SA < 0	If [SA# (s)] = 1 and [SA# (f)] ≠ 0 then [P] ← EA
SBNE	BI	Branch on Not Equal	If [SI (L) V SI (G)] = 1, then [P] ← EA
SBNEU	BI	Branch on No Exponent Underflow	If [SI (EUF)] = 0, then [P] ← EA
SBNEZ	BR	Branch on SA ≠ 0	If [SA# (f)] ≠ 0, then [P] ← EA
SBNPE	BI	Branch on No Precision Error	If [SI (PE)] = 0, then [P] ← EA

Mnemonic	Type	Description	Operation
SBNSE	BI	Branch on No Significance Error	If [SI (SE)] = 0, then [P] ← EA
SBPE	BI	Branch on Precision Error	If [SI (PE)] = 1, then [P] ← EA
SBSE	BI	Branch on Significance Error	If [SI (SE)] = 1, then [P] ← EA
SCM	DO	Scientific Compare	SI (G), SI (L) ← [SA#] :: [EA]
SCZD	SO	Scientific Compare to Zero – 2 words	SI (G), SI (L) ← [EA] :: Zero
SCZQ	SO	Scientific Compare to Zero – 4 words	SI (G), SI (L) ← [EA] :: Zero
SDV	DO	Scientific Divide	[SA#] ← [SA#] / [EA]
SLD	DO	Scientific Load	[SA#] ← [EA]
SML	DO	Scientific Multiply	[SA#] ← [SA#] * [EA]
SNGD	SO	Scientific Negate – 2 words	[EA (s)] ← $\overline{[EA\ (s)]}$
SNGQ	SO	Scientific Negate	[EA (s)] ← [EA (s)]
SSB	SO	Scientific Subtract	[SA#] ← [SA#] – [EA]
SST	DO	Scientific Store	[EA] ← [SA#]
SSW	DO	Scientific Swap	[SA#] ⟷ [EA]

where f = Fraction (mantissa) excluding sign
SA = Scientific Accumulator

NOTE:
These instructions are software simulated except on Models 43, 47, 53, and 57 with the SIP option.

SECTION 4

COMMERCIAL INSTRUCTIONS (ALPHABETICAL)

Mnemonic[1]	Type	Description	Operation
ACM	A	Alphanumeric Compare	[DD1] :: [DD2] → CI(G,L)
ALR	A	Alphanumeric Move	[DD1] → [DD2]
AME	E	Alphanumeric Move and Edit	[DD1] edited → [DD2]; [DD3] specifies Micro-ops
CBD	N	Convert Binary to Decimal	[DD1] converted → [DD2]
CBE	B	Branch if Equal	If CI (G and L) = 0, then [P] ← EA
CBG	B	Branch if Greater	If CI (G) = 1, then [P] ← EA
CBGE	B	Branch if Greater Than or Equal	If CI (L) = 0, then [P] ← EA
CBL	B	Branch if Less	If CI (L) = 1, then [P] ← EA
CBLE	B	Branch if Less Than or Equal	If CI (G) = 0, then [P] ← EA
CBNE	B	Branch if Not Equal	If CI (G or L) = 1, then [P] ← EA
CBNOV	B	Branch if No Overflow	If CI (OV) = 0, then [P] ← EA
CBNSF	B	Branch if No Sign Fault	If CI (SF) = 0, then [P] ← EA
CBNTR	B	Branch on No Truncation	If CI (TR) = 0, then [P] ← EA
CBOV	B	Branch on Overflow	If CI (OV) = 1, then [P] ← EA
CBSF	B	Branch on Sign Fault	If CI (SF) = 1, then [P] ← EA
CBTR	B	Branch on Truncation	If CI (TR) = 1, then [P] ← EA
CDB	N	Convert Decimal to Binary	[DD1] converted → [DD2]
CSNCB	B	Synchronize and Branch	Prevents CP from going to next instruction until previous commercial instruction is completed; then performs unconditional branch
CSYNC	B	Synchronize	Prevents CP from going to next instruction until previous commercial instruction is completed
DAD	N	Decimal Add	[DD2] + [DD1] → [DD2]
DCM	N	Decimal Compare	[DD1] :: [DD2] → IND
DDV	N	Decimal Divide	[DD2]/[DD1] → [DD3]; R → [DD2]
DLS	E	Decimal Left Shift	Shift [DD1] left "d" positions[2]
DMC	N	Decimal Move and Convert	[DD1] converted → [DD2]
DME	E	Decimal Move and Edit	[DD1] Edited → [DD2]; [DD3] specifies Micro-ops
DML	N	Decimal Multiply	[DD2] * [DD1] → [DD2]
DRS	E	Decimal Right Shift	Shift [DD1] right "d" positions[2]

Mnemonic[1]	Type	Description	Operation
DSB	N	Decimal Subtract	[DD2] – [DD1] → [DD2]
DSH	N	Decimal Shift	Shift [DD1] left "d" positions Shift [DD1] right "d" positions
MAT	A	Alphanumeric Move and Translate	[DD1] translate → [DD2]; [DD3] specifies 256-byte Translate Table
SRCH[3]	A	Alphanumeric Search	[DD3] is searched using [DD1] and [DD2] for some purposes
VRFY[3]	A	Alphanumeric Verify	[DD3] is verified using [DD1] and [DD2] for some purposes

where:

DD1, 2 and 3 = Data Description 1, 2, or 3
N = Numeric Type
A = Alphanumeric Type
E = Edit Type
B = Branch Type

[1] These instructions are software simulated except on Models 47 and 57.

[2] DLS and DRS are software instructions that generate the DSH code and the appropriate value of the shift control word. Refer to footnote 1 on page 5-2, and to the *Level 6 Assembler Manual,* Order No. CB07, for a complete description.

[3] Requires Model 47 or Model 57.

SECTION 5

INSTRUCTIONS (NUMERICAL)

H1	H2	H3	H4	Mnemonic
Generic (GE)				
0	0	0	0	HLT
0	0	0	1	MCL
0	0	0	2	BRK
0	0	0	3	RTT
0	0	0	4	RTCN
0	0	0	5	RTCF
0	0	0	6	WDTN
0	0	0	7	WDTF
0	0	0	8	MMM
0	0	0	A	ASD
0	0	0	B	VLD
0	0	0	C	LRDB
0	0	0	D	SRDB
0	0	1	0	LDT*
0	0	1	0	STT*
0	0	1	0	ACQ*
0	0	1	0	RLQ*
0	0	1	1	CNFG
0	0	6	0	DQA
0	0	6	1	QOT
0	0	6	2	DQH
0	0	6	3	QOH

*Function determined by second word of instruction. See Systems Handbook, CC71

H1	H2	H3	H4	Mnemonic
Branch on Indicators (BI)				
0	2	0+x	–	BL
0	2	8+x	–	BGE
0	3	0+x	–	BG
0	3	8+x	–	BLE
0	4	0+x	–	BOV
0	4	8+x	–	BNOV
0	5	0+x	–	BBT
0	5	8+x	–	BBF
0	6	0+x	–	BCT
0	6	8+x	–	BCF
0	7	0+x	–	BIOT
0	7	8+x	–	BIOF
0	8	0+x	–	BAL
0	8	8+x	–	BAGE
0	9	0+x	–	BE
0	9	8+x	–	BNE
0	A	0+x	–	BAG
0	A	8+x	–	BALE
0	B	0+x	–	BSU
0	B	8+x	–	BSE
0	F	0+x	–	NOP
0	F	8+x	–	B

Commercial Branches

1	3	0+x	–	CBOV
1	3	8+x	–	CBNOV
2	3	0+x	–	CBTR
2	3	8+x	–	CBNTR
3	3	0+x	–	CBSF
3	3	8+x	–	CBNSF
4	3	0+x	–	CSYNC
4	3	8+x	–	CSNCB
5	3	0+x	–	CBNE
5	3	8+x	–	CBE
6	3	0+x	–	CBG
6	3	8+x	–	CBLE
7	3	0+x	–	CBL
7	3	8+x	–	CBGE

Scientific Branches

0+r	4	0+x	–	SBLZ
4	4	0+x	–	SBL
5	4	0+x	–	SBPE
6	4	0+x	–	SBSE
7	4	0+x	–	SBEU
0+r	4	8+x	–	SBGEZ
4	4	8+x	–	SBGE
5	4	8+x	–	SBNPE
6	4	8+x	–	SBNSE
7	4	8+x	–	SBNEU
0+r	5	0+x	–	SBEZ
4	5	0+x	–	SBE
0+r	5	8+x	–	SBNEZ
4	5	8+x	–	SBNE
0+r	6	0+x	–	SBGZ
4	6	0+x	–	SBG
0+r	6	8+x	–	SBLEZ
4	6	8+x	–	SBLE

H1	H2	H3	H4	Mnemonic
Branch on Registers (BR)				
0+r	7	0+x	–	BDEC
0+r	7	8+x	–	BINC
0+r	8	0+x	–	BLZ
0+r	8	8+x	–	BGEZ
0+r	9	0+x	–	BEZ
0+r	9	8+x	–	BNEZ
0+r	A	0+x	–	BGZ
0+r	A	8+x	–	BLEZ
0+r	B	0+x	–	BEVN
0+r	B	8+x	–	BODD
Short Value Immediate (SI)				
0+r	C	–	–	LDV
0+r	D	–	–	CMV
0+r	E	–	–	ADV
0+r	F	–	–	MLV
Input/Output (I/O)				
8	0	0+x	–	IO
8	1	0+x	–	IOH
8	1	8+x	–	IOLD
Single Operand (SO)				
8	2	0+x	–	NEG
8	2	8+x	–	LB
8	3	8+x	–	JMP
8	4	0+x	–	AID
8	4	8+x	–	SID
8	6	0+x	–	CPL
8	7	0+x	–	CL
8	7	8+x	–	CLH
8	8	0+x	–	LBF
8	8	8+x	–	DEC
8	9	0+x	–	LBT
8	9	8+x	–	CMZ
8	A	0+x	–	LBS
8	A	8+x	–	INC
8	B	0+x	–	LBC
8	B	8+x	–	ENT
8	C	0+x	–	STS
8	C	8+x	–	LDI
8	D	0+x	–	SDI
8	D	8+x	–	CMN
8	E	0+x	–	LEV
8	E	8+x	–	CAD
8	F	0+x	–	SAVE
8	F	8+x	–	RSTR

H1	H2	H3	H4	Mnemonic
Double Operand (DO)				
8+r	0	0+x	–	MTM
8+r	0	8+x	–	LDH
8+r	1	8+x	–	CMH
8+r	2	0+x	–	SUB
8+r	2	8+x	–	LLH
8+r	3	0+x	–	DIV
8+r	3	8+x	–	LNJ
8+r	4	0+x	–	OR
8+r	4	8+x	–	ORH
8+r	5	0+x	–	AND
8+r	5	8+x	–	ANH
8+r	6	0+x	–	XOR
8+r	6	8+x	–	XOH
8+r	7	0+x	–	STM
8+r	7	8+x	–	STH
8+r	8	0+x	–	LDR
8+r	9	0+x	–	CMR
8+r	A	0+x	–	ADD
8+r	A	8+x	–	SRM
8+r	B	0+x	–	MUL
8+r	B	8+x	–	LAB
8+r	C	8+x	–	LDB
8+r	D	8+x	–	CMB
8+r	E	0+x	–	SWR
8+r	E	8+x	–	SWB
8+r	F	0+x	–	STR
8+r	F	8+x	–	STB
Scientific				
C	8	8+x	–	SCZD
C+r	8	8+x	–	SCM
8+r	8	8+x	–	SLD
C	9	8+x	–	SNGD
C+r	9	8+x	–	SSB
8+r	9	8+x	–	SAD
C	C	0+x	–	SCZQ
C+r	C	0+x	–	SDV
8+r	C	0+x	–	SML
C	D	0+x	–	SNGQ
C+r	D	0+x	–	SSW
8+r	D	0+x	–	SST

H1	H2	H3	H4		Mnemonic
Commercial					
0	0	2	0	–	VRFY
0	0	2	1	–	ALR
0	0	2	2	–	ACM
0	0	2	3	–	MAT
0	0	2	4	–	AME
0	0	2	5	–	DMC
0	0	2	6	–	DME
0	0	2	7	–	CBD
0	0	2	8	–	SRCH
0	0	2	9	–	DML
0	0	2	A	–	CDB
0	0	2	B	–	DDV
0	0	2	C	–	DAD
0	0	2	D	–	DSB
0	0	2	E	–	DSH[1]
0	0	2	F	–	DCM

where:

r = Register number contained in bits 1 through 3 or 2 through 3

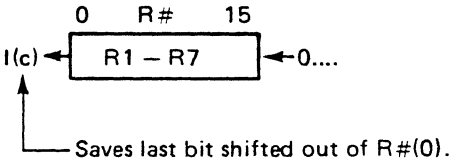
x = Value of bits 9 through 11

[1] For the DSH instruction, shift control direction is specified by the internal shift control word 2 (SCW2) bit 0. If SCW2 bit 0 = 0, shift is left; if = 1, shift is right. For the instruction format in which direction is specified, refer to the *Level 6 Assembler Manual,* Order No. CB07. Two additional software instructions are available: DLS (Decimal Left Shift) and DRS (Decimal Right Shift) and are also discussed in the same manual. When these instructions are used, the internal code of the DSH instruction (002E) is generated along with the appropriate value in the SCW2.

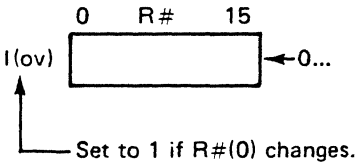
SECTION 6

SHIFT INSTRUCTIONS

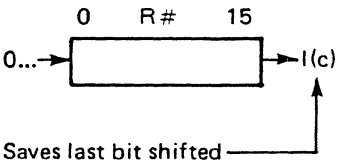
SOL
r00#



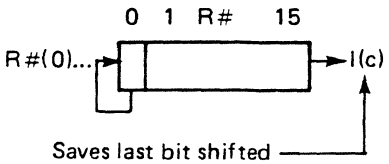
SAL
r02#



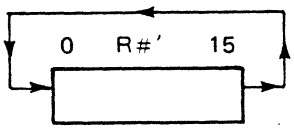
SOR
r04#



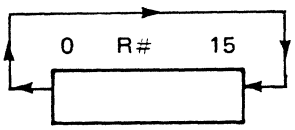
SAR
r06#



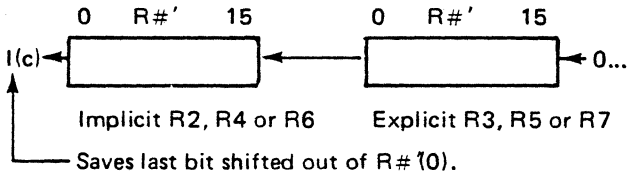
SCR
r05 #



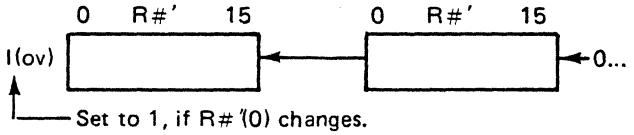
SCL
r01 #



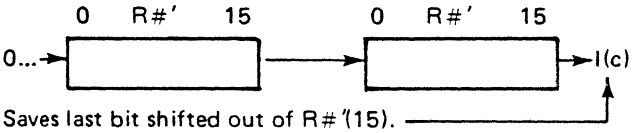
DOL
r08#



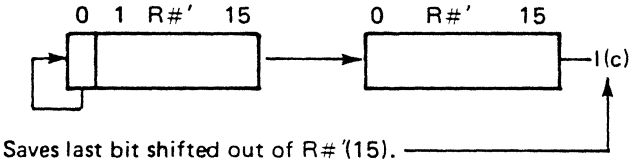
DAL
r0A#



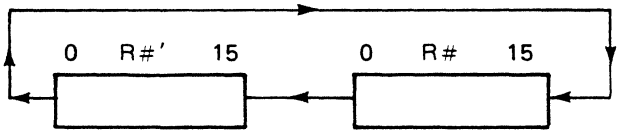
DOR
r0C#



DAR
r0E#

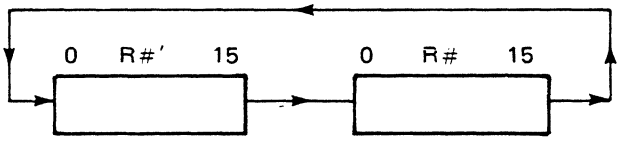


DCL
r03#



Implicit R2, R4 or R6 Explicit R3, R5 or R7

DCR
r07#

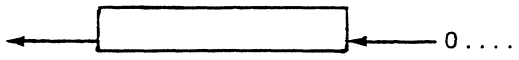


SHIFT INSTRUCTIONS

I(c)	c bit of 1 reg. contains most recent bit discarded
I(ov)	ov bit of 1 reg. set if sign changed, else cleared
r	R1 thru R7, or, R3, R5 or R7
#	shift distance 1-15 or 1-31, 0 is special case

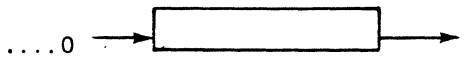
Commercial Shift Instructions

(DSH)
DLS



Set ov if a non-zero character
is shifted out.

(DSH)
DRS



Round least significant digit if rounding
is specified.

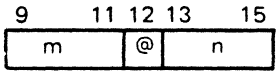
SECTION 7

ADDRESS SYLLABLE

Address Syllable Definitions

Bk	B register number 1, 2, or 3
Bn	B register number n
DSP	16-bit displacement (–32,768 through +32,767) that follows the word containing the address syllable — for P+DSP and *(P+DSP), DSP is added to the address of the word containing DSP
IMA	Immediate address
IMO	Immediate operand
IV	Interrupt vector
P	Location of word containing displacement
Rn	R register number n
*	Indirect operator
↑	Increment symbol; incrementation occurs after the effective address is obtained but before execution of the instruction
↓	Decrement symbol; decrementation occurs before the effective address is obtained

Commercial Address Syllable



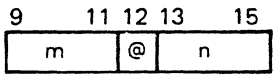
m – Address modifier

@ – Direct/indirect address indicator (when m = 0 through 4); otherwise, secondary address modifier

n – Register number (when 1 through 7)

	n = 0		n = 1-7	
m	@ = 0	@ = 1	@ = 0	@ = 1
0	–	P+DSP	Bn+DSP	*[Bn+DSP]
1	–	P+DSP+R1	Bn+DSP+R1	*[Bn+DSP]+R1
2	Use Remote Data Descriptors	P+DSP+R2	Bn+DSP+R2	*[Bn+DSP]+R2
3		P+DSP+R3	Bn+DSP+R3	*[Bn+DSP]+R3
4		*[P+DSP]	Bn+DSP+R4	*[Bn+DSP]+R4
5		RFU	Bn+DSP+R5	*[Bn+DSP]+R5
6		RFU	Bn+DSP+R6	*[Bn+DSP]+R6
7	–	IMO	Bn+DSP+R7	*[Bn+DSP]+R7

Non-Commercial Instructions



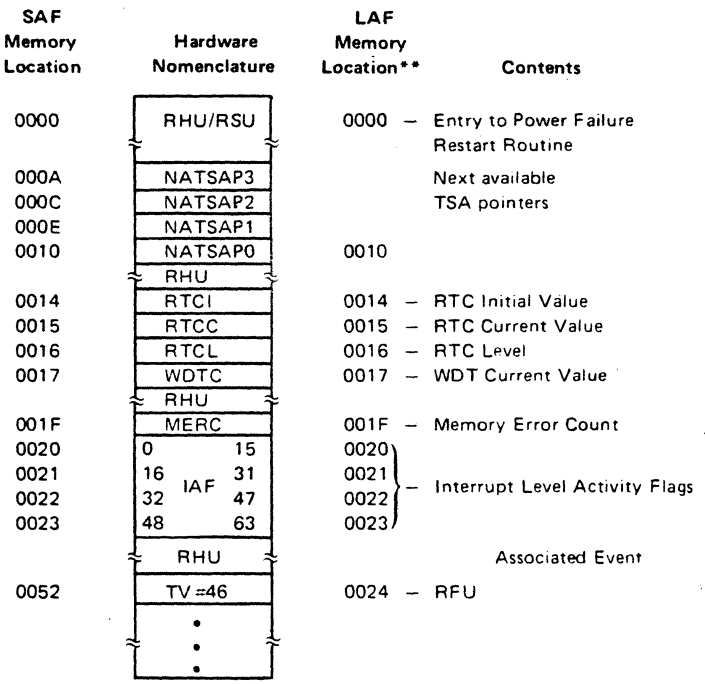
m — Address modifier
@ — Direct/indirect address indicator (when m = 0 through 4)
Otherwise, secondary address modifier
n — Register number (when 1 through 7)

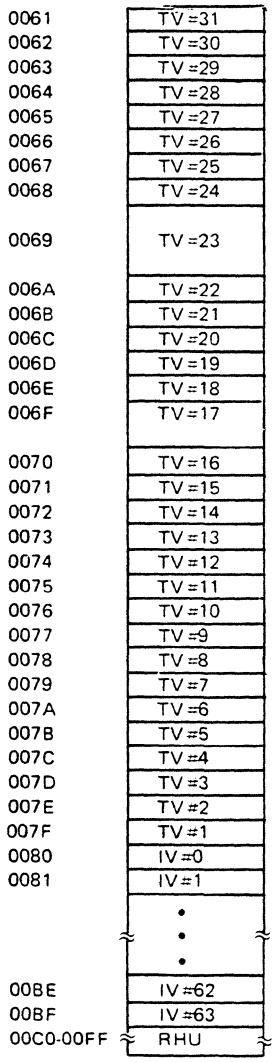
In the table below, the underlined items indicate the nature of the address obtained by the corresponding values of the address syllable. Indented below each item is the format of the related source language.

m	n = 0		n = 1 – 7			
	@ = 0	@ = 1	@ = 0	@ = 1		
0	IMA <label	*IMA *<label	Bn $Bn	*Bn *$Bn		
1	IMA+R1 <label.$R1	*IMA+R1 *<label.$R1	Bn+R1 $Bn.$R1	*Bn+R1 *$Bn.$R1		
2	IMA+R2 <label.$R2	*IMA+R2 *<label.$R2	Bn+R2 $Bn.$R2	*Bn+R2 *$Bn.$R2		
3	IMA+R3 <label.$R3	*IMA+R3 *<label.$R3	Bn+R3 $Bn.$R3	*Bn+R3 *$Bn.$R3		
4	P+DSP label	*(P+DSP) *label	Bn+DSP $Bn.value	*[Bn+DSP] $Bn.value		
5	reserved	reserved	Register =$Bn or =$Rn	n=1,2,3 Bn+↓R1 $Bk.–$R1	n=4 r e s e r v e d	n=5,6,7 B[n-4]+R1↑ $Bk.+$R1
6	reserved	reserved	↓Bn "Push" –$Bn	Bn+↓R2 $Bk.–$R2		B[n-4]+R2↑ $Bk.+$R2
7	IMO =value or =label	IV+DSP	Bn↑ "pop" +$Bn	Bn+↓R3 $Bk.–$R3		B[n-4]+R3↑ $Bk.+$R3

SECTION 8

HARDWARE-DEDICATED MEMORY





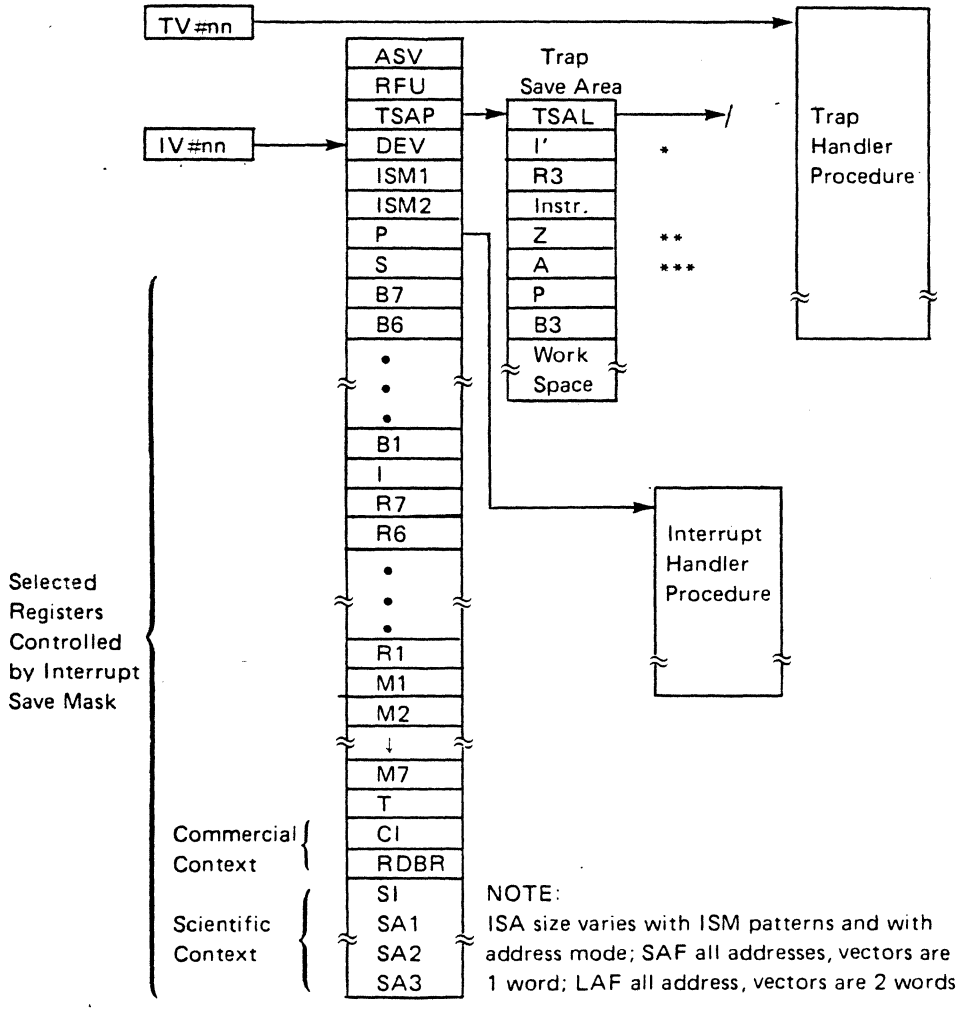
0061	TV=31	0042 – SIP QLT FAULT
0062	TV=30	0044 – CIP QLT FAULT
0063	TV=29	0046 – Commercial Overflow*
0064	TV=28	0048 – Commercial Truncation*
0065	TV=27	004A – Commercial Illegal Character
0066	TV=26	004C – Commercial Illegal Specification
0067	TV=25	004E – Commercial Divide by Zero
0068	TV=24	0050 – Memory or Megabus Error seen by SIP or CIP
0069	TV=23	0052 – Unavailable Resource referenced by SIP or CIP
006A	TV=22	0054 – Scientific Precision Error*
006B	TV=21	0056 – Scientific Significance Error*
006C	TV=20	0058 – Scientific Program Error
006D	TV=19	005A – Scientific Exponent Underflow*
006E	TV=18	005C – RFU
006F	TV=17	005E – Uncorrectable Memory or Megabus Error
0070	TV=16	0060 – Program Error
0071	TV=15	0062 – Unavailable Resource
0072	TV=14	0064 – Protection Violation
0073	TV=13	0066 – Privilege Violation
0074	TV=12	0068 – Remote, remote data descriptor
0075	TV=11	006A – RFU
0076	TV=10	006C – Stack Overflow
0077	TV=9	006E – Stack Underflow
0078	TV=8	0070 – Scientific Exponent Overflow
0079	TV=7	0072 – Scientific Divide by Zero
007A	TV=6	0074 – Integer Register Overflow*
007B	TV=5	0076 – Unimplemented Instruction
007C	TV=4	0078 – RSU
007D	TV=3	007A – Uninstalled Scientific Instruction
007E	TV=2	007C – Trace*/Breakpoint Trap
007F	TV=1	007E – Monitor Call Trap
0080	IV=0	0080 – Interrupt Vector, Level 0
0081	IV=1	0082 – Interrupt Vector, Level 1
00BE	IV=62	00FC – Interrupt Vector, Level 62
00BF	IV=63	00FE – Interrupt Vector, Level 63
00C0-00FF	RHU	NONE

*Maskable Trap Conditions

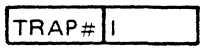
**All LAF addresses and vectors are contained in two memory words.

SECTION 9

TRAP VECTOR AND INTERRUPT VECTOR LINKAGE

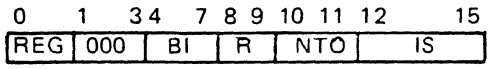


*I' Format



Trap# = 40_{16} – TV#
I = Copy of I Register

**Z Format



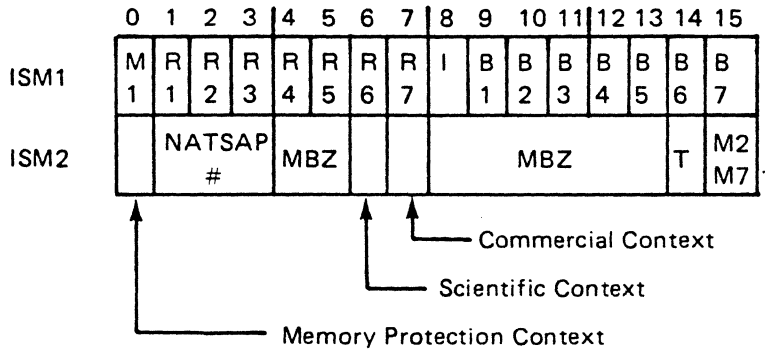
REG – 'A' word validity
1 = A word is invalid
0 = A word is valid

BI – bit/byte index field
For bit instruction, BI = 4 low-order bits of index register
For byte instruction, BI = X000 where X is the low-order bit of the index register

R – Ring Number

IS – Instruction Size

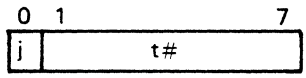
***A Format – address associated with Trap, see Systems Handbook, CC71



SECTION 10

REGISTERS

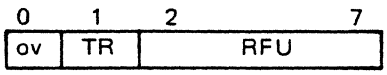
	Name	Format
Address Registers	Data Registers (R1 – 7)	0 … 15
	Base Registers (B1 – B7)	0 … 15(SAF) or 19(LAF)
	Program Counter (P)	0 … 15(SAF) or 19(LAF)
	Stack Address Register (T)	0 … 15(SAF) or 19(LAF)
	Remote Descriptor Base Register (RDBR)	0 … 15(SAF) or 19(LAF)
	CPU Mode Register (M1)	0 1 … 7



j – Trace trap enable for jumps and branches
0 = trace trap disabled; 1 = enabled

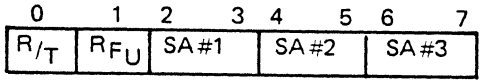
t# – Overflow trap enable controls for registers R1 – R7, respectively
0 = trap disabled; 1 = enabled

Commercial Trap Enable Register (M3)



ov – Overflow Trap Enable
TR – Truncation Trap Enable

SIP Operating Mode Register (M4)

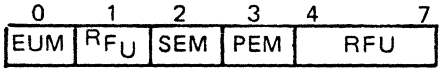


R/T – Round/Truncate Mode
0 = Truncate; 1 = Round

SA#– Scientific accumulator number

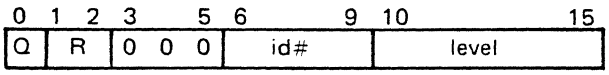
	Memory data length (words)	Accumulator data length (words)
00	2	2
01	2	4
10	4	2
11	4	4

SIP Trap Enable Register M5



EUM – Exponent Underflow Trap Enable
SEM – Significance Error Trap Enable
PEM – Precision Error Trap Enable

System Status/Security Register (S)



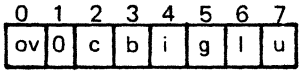
R – Ring Number (privilege state)
IX = privilege rings; OX = user rings

id# – Processor identity (channel number)

level – Interrupt priority level – 0 (high) through 63 (low)

Q – QLT Fault

CPU Indicator Register (I)



ov – "Overflow" indicator

c – "Carry" indicator

b – "Bit test" indicator

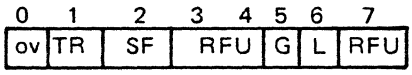
i – "Input/output" indicator

g – "Greater than" indicator

l – "Less than" indicator

u – "Unlike signs" indicator

Commercial Indicator Register (CI)



ov – Overflow occurred during decimal instruction

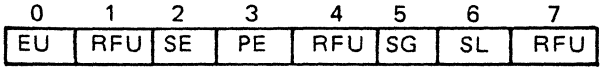
TR – Alphanumeric result is truncated

SF – Sign fault (negative operand is stored in unsigned field)

G – Greater than

L – Less than

SIP Indicator Register (SI)



EU – Exponent underflow

SE – Significance error

PE – Precision error

SG – Greater than

SL – Less than